# International Journal of ELECTROMAGNETIC COMPATIBILITY THE INTERNATIONAL JOURNAL OF ELECTROMAGNETIC COMPATIBILITY TO THE INTERNATIONAL DESCRIPTIONAL DESCRIPTI





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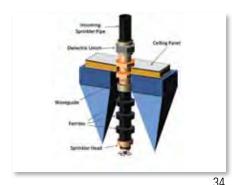


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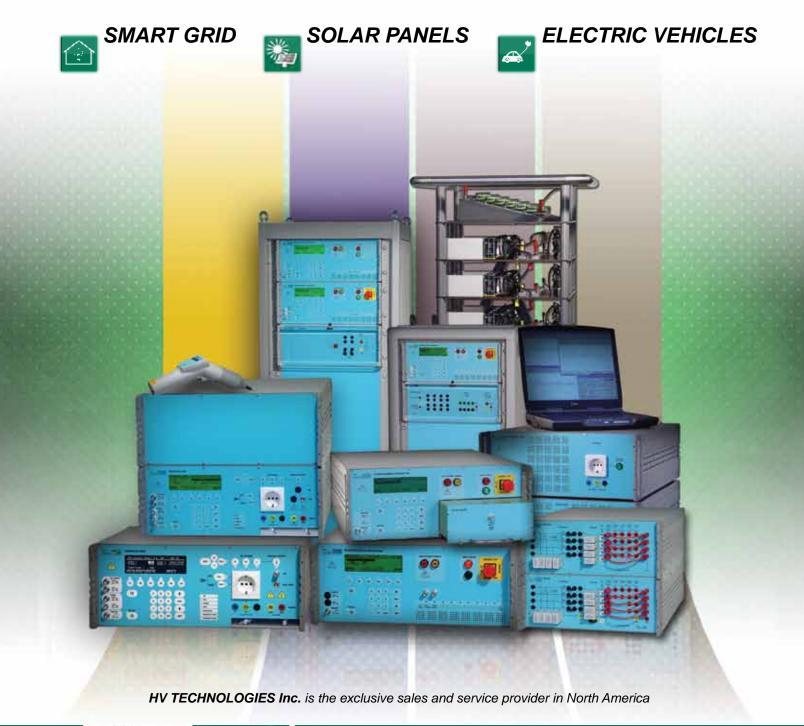


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### Letter from Editor





#### A NEW LOOK AND FEEL FOR THE EMC BUYERS' GUIDE

**VERY YEAR, INTERFERENCE TECHNOLOGY** publishes an EMC Buyers' Guide — our most up-to-date look at the providers of more than ■ 200 EMC-related products and services. This

year, we are introducing changes to both the print and online editions of our directories that will make the process a more interactive and dynamic experience for users, and help streamline the process for busy engineers.

First, you will notice some changes within the pages of this magazine. To help readers pinpoint their areas of interest and delve more deeply into favored topics, we have divided the magazine into six main sections: Test Instrumentation, Testing, Filters & Ferrites, Cables & Connectors, Shielding and Surge & Transients. The sections are marked by colored tabs and within those pages you will find a targeted products and services index and technical articles that address a specific EMC topic.

In the second half of the magazine, you will find reference tools, including a calendar of EMC-related events, information on standards published or updated within the last 12 months, information on professional societies, our Products & Services Index in its entirety, and a listing of companies involved in the EMC field.

With the electronic version of the new Interference Technology EMC Buyers' Guide, users will not only be able to find the product and services they seek and the companies that provide them, but, in many instances, they will also find videos, datasheets, white papers and other materials from the companies that provide more comprehensive data on those products and services.

Companies will be able to take ownership of their listings and update information at any time, which means that users are guaranteed to find the most updated information available each time they browse the guide.

These changes should help engineers identify the best solutions for the problem they are trying to solve more quickly and easily than ever before.

Once you have a chance to sample the new print and electronic directories, we'd like to hear what you think so we can adapt accordingly. Please email your comments to me at slong@interferencetechnology.com.

Sarah Long

Editor

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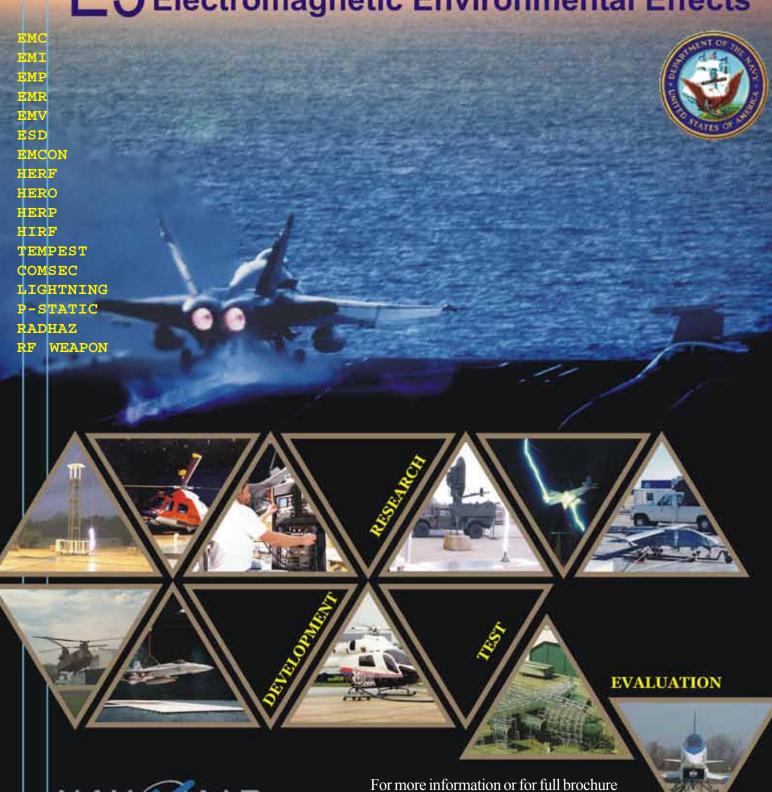
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### **TEST INSTRUMENTATION**

#### **Products & Services Index**

INTERFERENCE TECHNOLOGY'S 2012 Test Instrumentation Products & Services Index contains approximately 50 different categories to help you find the test instrumentation equipment, components, and services you need. Full details of all the suppliers listed within each category can be found in the Company Directory, starting on page 151. The EMC Products & Services Index is presented in its entirety, starting on page 142.

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| Model<br>Number | Freq<br>Range<br>(MHz) | Min Pwr<br>Out<br>(Watts) | Min Sat<br>Gain<br>(dB) |
|-----------------|------------------------|---------------------------|-------------------------|
| M/TCCX          | /SCCX Sei              | ries • .01-22             | 0 MHz                   |
| SCCX300         | .01-220                | 300                       | 55                      |
| SCCX500         | .01-220                | 500                       | 57                      |
| M404            | .01-220                | 500                       | 57                      |
| M406            | .01-220                | 1000                      | 60                      |
| TCCX2000        | .01-220                | 2000                      | 63                      |
| TCCX2200        | .01-220                | 2200                      | 63                      |
| TCCX2500        | .01-220                | 2500                      | 64                      |
| CMX/S           | MX Series              | • .01-1000                | MHz                     |
| SMX301          | .01-1000               | 300/100                   | 55/50                   |
| SMX302          | .01-1000               | 300/200                   | 55/53                   |
| SMX303          | .01-1000               | 300/300                   | 55/55                   |
| SMX501          | .01-1000               | 500/100                   | 57/50                   |
| SMX502          | .01-1000               | 500/200                   | 57/53                   |
| SMX503          | .01-1000               | 500/300                   | 57/55                   |
| CMX10001        | .01-1000               | 1000/100                  | 60/50                   |
| CMX100010       | .01-1000               | 1000/1000                 | 60/60                   |



### Microwave Solid State and TWT Amplifiers

| Model<br>Number | Freq<br>Range<br>(GHz) | Min Pwr<br>Out<br>(Watts) | Gain      |
|-----------------|------------------------|---------------------------|-----------|
| T-200 Series    | s • 200-300            | Watts CW 1                | -21.5 GHz |
| T251-250        | 1-2.5                  | 250                       | 54        |
| T82-250         | 2-8                    | 250                       | 54        |
| T188-250        | 7.5-18                 | 250                       | 54        |
| T2118-250       | 18.0-21.7              | 250                       | 54        |
| T-500 Se        | ries <i>• 500</i> W    | atts CW 1-                | 18 GHz    |
| T251-500        | 1-2.5                  | 500                       | 57        |
| T7525-500       | 2.5-7.5                | 500                       | 57        |
| T188-500        | 7.5-18                 | 500                       | 57        |
| MMT Ser         | ies • <i>5-150</i>     | Watts, 18                 | -40 GHz   |
| T2618-40        | 18-26.5                | 40                        | 46        |
| T4026-40        | 26.5-40                | 40                        | 46        |
| S/T-50 Ser      | ies <i>· 40-60</i>     | Watts CW                  | 1-18 GHz  |
| S21-50          | 1-2                    | 50                        | 47        |
| T82-50          | 2-8                    | 50                        | 47        |
| T188-50         | 8-18                   | 50                        | 47        |



#### Solid State Amplifiers

| Model<br>Number | Freq<br>Range<br>(MHz) | Min Pwr<br>Out<br>(Watts) | Min Sat<br>Gain<br>(dB) |
|-----------------|------------------------|---------------------------|-------------------------|
| SMC             | C Series • 2           | 200-1000 N                | ИHz                     |
| SMCC350         | 200-1000               | 350                       | 55                      |
| SMCC600         | 200-1000               | 600                       | 58                      |
| SMCC1000        | 200-1000               | 1000                      | 60                      |
| SMCC2000        | 200-1000               | 2000                      | 63                      |
| SMC             | Series •               | 80-1000 M                 | lHz                     |
| SMC250          | 80-1000                | 250                       | 54                      |
| SMC500          | 80-1000                | 500                       | 57                      |
| SMC1000         | 80-1000                | 1000                      | 60                      |
| SMX-C           | MX Series              | • .01-1000                | ) MHz                   |
| SMX100          | .01-1000               | 100                       | 50                      |
| SMX200          | .01-1000               | 200                       | 53                      |
| SMX500          | .01-1000               | 500                       | 57                      |
| SVC-SI          | MV Series              | · 100-1000                | ) MHz                   |
| SVC500          | 100-500                | 500                       | 57                      |
| SMV500          | 500-1000               | 500                       | 57                      |

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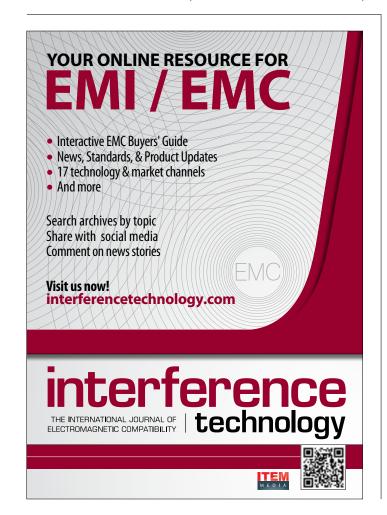
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### The HF Current Probe: Theory and Application

#### **KENNETH WYATT**

Wyatt Technical Services Woodland Park, Colorado, USA

his article describes one of the most valuable tools in the EMC engineers "bag of tricks" - the high-frequency current probe. Current probes are invaluable for measuring high-frequency common-mode (or "antenna") currents flowing on wires or cables. Experience has proven that poorly terminated (bonded or filtered) cables are the number-one cause for radiated emissions failures at a test facility. By measuring the common-mode (CM) currents (sometimes referred to as "antenna" currents) on these cables it's possible to troubleshoot and apply fixes to a product right there in your development lab. You can also predict, to a good degree of accuracy, whether a given cable current will pass or fail in the measurement chamber. This will save you tons of time trying to apply fixes at the test facility while the clock is ticking away your test time. I'll also show you several ways to create doit-yourself (DIY) probes that are quick to make and very useful in a pinch.

#### **COMMON-MODE CURRENTS**

Let's consider CM currents and how they are generated, because it is not intuitive as to how current may travel the same direction through both the signal and signalreturn wires in a cable or PC board. Referring to Figure 1, note that due to finite

impedance in any grounding system (including circuit board signal/power return planes), there will be a voltage difference between any two points within that return plane. This is denoted by  $V_{GND1}$  and  $V_{GND2}$ in the figure. This difference in potential will drive CM currents through common cabling or circuit traces between circuits or sub-systems. In addition, unbalanced geometries - for example, different lengths or path routings for high-speed differential pairs - can create voltage sources that drive associated CM currents. Finally, routing a high-speed clock trace across a split in the return plane or referencing it to multiple planes, can also be a source of CM current. Because the current phasors in Figure 1 are additive, the resulting radiated phasor may be quite large compared to those generated by differential-mode (DM), or signal currents, which are opposite in direction, and so tend to cancel. Therefore, CM emissions tend to be more of an issue than DM emissions.

#### **CURRENT PROBES: THEORY OF** OPERATION

The RF current probe is an "insertedprimary" type of radio frequency current transformer. When the probe is clamped over the conductor or cable in which current is to be measured, the conductor forms the primary winding. The clamp-on feature of this probe enables easy placement around any conductor or cable. This is essentially a broadband high-frequency transformer. High-frequency currents can

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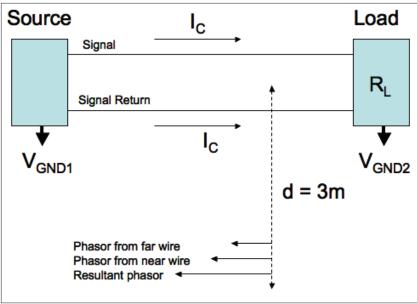


Figure 1. Common-mode currents in a circuit loop. The source is a digital signal (with harmonics) and we'll assume a resistive load. Because the phasor current in the far wire is in the same direction as the phasor current in the near wire, the resultant phasor is relatively large compared to that produced by differential-mode current phasors. In this case, lowering the harmonic content (by slowing the digital rise/fall-times) or diverting/blocking the CM current is very important in limiting radiated emissions.

be measured in cables without physically disturbing the circuit.

Since the current probe is intended for "clamp-on" operation, the primary shown in Figure 2 is actually the electrical conductor in which CM currents are to be measured. This primary is considered as one turn since it is assumed that the CM currents flow through the conductor and return to the source via a return conductor such as a frame, common ground plane, or earth. On some current probe models the secondary output terminals are resistively loaded internally to provide substantially constant transfer impedance over a wider frequency range.

#### **COMMERCIAL CURRENT PROBES**

While commercial current probes are pricey, the advantage is that they can open up and snap around a cable, rather than having to be threaded onto the cable to be measured. See Figure 3. They are also a lot more rugged and can take a lot of abuse as compared to the "do-it-yourself" (DIY) versions below. Finally, they are also accurately characterized, allowing very precise measurements of cable currents.

#### **DIY CURRENT PROBES**

In a pinch, you can make your own current probe. Examples of several DIY probes are shown in Figures 4 and 5. I typically try to find a ferrite toroid or clamp-on core that offers good high-frequency characteristics in the 10 to 1000 MHz range. Winding a few (not too critical) turns and terminating with a coax connector is all you need. Keeping the turns as far apart as possible (as in Figure 4) will reduce inter-winding capacitance and yield better results at the higher frequencies. This is one of the largest drawbacks in performance of the clamp-on ferrites (as in Figure 5).

#### TRANSFER IMPEDANCE

The CM current (Ic) in microamps in the conductor under test is determined from the reading of the current probe output (V) in microvolts divided by the current probe transfer impedance (ZT).

$$IC = V/ZT$$
Or, in dB

conductor and noting the voltage (V) developed across a 50-Ohm load. Then,

$$\mathbf{Z}\mathbf{T} = \mathbf{V}/\mathbf{I}\mathbf{C}$$
 (in standard units) (3) Or

$$ZT(dB\Omega) = V(dBuV) - Ic(dBuA)$$
(4)

The Fischer F-33-1 probe is a commonly used troubleshooting tool and has a flat frequency response from 2 to 250 MHz (Figure 6). The transfer impedance is about  $5\Omega$  (approximately +14 dB $\Omega$  on the graph), therefore, a 1 uA current will produce a 5 uV output voltage from the current probe.

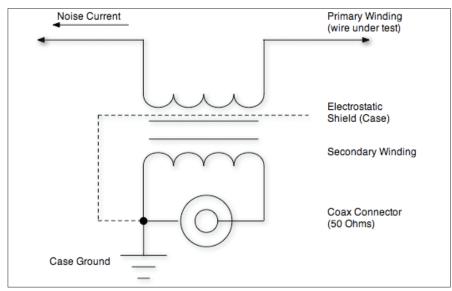


Figure 2. The basic current probe (high-frequency current transformer).



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#### PROBE CALIBRATION

The accurate calibration of RF current probes is a complex process. Characterization is a more correct term to use than calibration. The probe must be properly characterized to reflect how the user uses the probe. Probe manufacturers usually sell a calibration fixture that attempts to maintain a  $50\Omega$  impedance. A  $50\Omega$  load is connected to the output port and a calibrated RF generator (or network analyzer) is connected to the input port. The probe to be characterized is clamped around the fixture and the frequency is swept while measuring the probe output.

My test setup was a little more rudimentary (Figure 7), but for troubleshooting purposes, it's good enough. I used a short piece of stiff wire across the output port with a  $50\Omega$ resistive load in series. I then adjusted the generator for zero dBm - a convenient amount. This is equivalent to an output voltage of 224 mV (or 73 dBuA of current) into  $50\Omega$ . The actual generator output doesn't matter, so long as the resulting probe voltage is large enough to be seen readily

> in the receiver or spectrum analyzer. I monitored the probe output with a Thurlby Thander TTi PSA2701T handheld spectrum analyzer.

Knowing the current through the wire in dBuA and the probe output in dBuV, the transfer impedance may be plotted graphically by subtracting: V(dBuV) - Ic(dBuA) (expressed in dB). In this case,  $Z_T(dB\Omega)$ = V(dBuV) - 73. While this may be useful for educational purposes, I wouldn't be too inclined to use the DIY probes to predict "pass/fail", as described further down. However, because they compare favorably to the commercial probes as far as output voltage, I believe (and have proven in practice) that they are completely suited for troubleshooting. You only need to know whether an EMC design fix made the cable current better or worse.

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#### PREDICTING PASS/FAIL

It is possible to predict whether a particular cable will pass or fail radiated emissions by measuring the CM current at the offending frequency, reading off the transfer impedance of the probe, Zt ( $dB\Omega$ ) in Figure 6, and solving for Ic (using Equation 2 above). Plugging Ic(Amps) into Equation 5 will calculate the E-field level in V/m. The length of the cable is L(m) and the offending harmonic frequency is f(Hz). Use a test distance, d, of either 3 or 10m to predict the outcome at those test distances.

$$|\hat{E}_{C,max}| = 1.257 \times 10^{-6} \frac{|\hat{I}_C| fL}{d}$$
 (5)

Once you've determined a particular cable has CM currents that may cause a RE failure, you should to examine the connector where the cable is attached to the product



Figure 3. Examples of commercial current probes.



Figure 4. Examples of DIY current probes based on a large toroid core. These photos were taken prior to installing the E-field shield which consists of a layer of copper tape over the windings, leaving a small gap around the inside of the toroid. 14 turns of Teflon-insulated wire wound around a Würth Electronik #74270097 ferrite core (4W620 material) was used, which is useful from 10 to 1000 MHz.



Figure 5. Examples of DIY current probes based on clamp-on ferrite chokes. I used a couple sample Steward (now a unit of Laird Technologies) chokes – a round one (model 28A3851-0A2) and a square one (model 28A2024-0A2). They each had 7 turns of Teflon-insulated wire wound around one-half and glued down on the inside to hold the windings. I later epoxied a PC boardstyle BNC connector to the outside, making sure there was enough epoxy to hold the outer turns together. Type 28 material was used, which is useful from 10 to 1000 MHz.

enclosure. Very often, I find poor or non-existent bonding between the connector shield and enclosure shield. These points must be bonded well to permit the CM currents to flow back to their source within the product, avoiding associated cable radiation. Please refer to my previous articles on troubleshooting radiated emissions for more information (references below).

#### REAL-WORLD TROUBLESHOOTING EXAMPLE

As previously mentioned, one of the most common sources of radiated emissions is due to poorly bonded connectors mounted on shielded product enclosures. This occurs especially if the connectors are circuit board mounted and penetrate loosely through the shielded enclosure. Poorly bonded connectors allow internally generated CM currents to leak out and flow on the outside of I/O, mouse or keyboard cables. This will also allow ESD discharges inside the product - more bad news. If these currents are allowed out of the enclosure, the attached cables will act as radiating antennas - often resonating around 300 MHz, due to their typical 1m length.

This was the case for a new digitizing oscilloscope prototype I worked on recently. The I/O connectors were all soldered onto the PC board and the board was fastened to the rear half of the enclosure. The connectors simply poked up through cutouts in the rear metal shield.

While using a current probe to measure the CM current flowing on the outside of the USB cable under test, I simply jammed the screwdriver blade of my Swiss Army knife between the connector bonding fingers and metal chassis enclosure and was able to drop the overall cable currents by 10 to 15 dB.

The solution was to fabricate a custom shim with spring-fingers that would slip over all the connectors creating a firm bond between the connector ground shell and inside of the shielded enclosure. More and more low-cost products are relying on PC board mounted I/O connec-

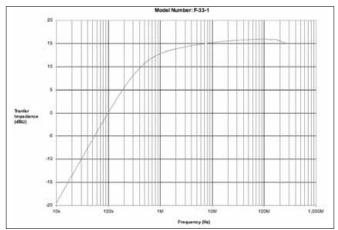


Figure 6. Transfer impedance (ZT) graph of an F-33-1 current probe (courtesy of Fischer Custom Communications). The x-axis is frequency, while the y-axis is dB $\Omega$ . Use this to calculate the value of IC (Equation 2), given the measured voltage at the probe terminals  $(V_{_{dBuV}})$  and ZT.



**Figure 7.** I used a short wire and  $50\Omega$  load (two parallel  $100\Omega$ resistors) across the generator output for probe characterization. Obviously, there are shortcomings at higher frequencies, due to the inductance of the wire. In fact, the system impedance starts to go capacitive at 100 MHz and it's difficult to keep a fixed 224 mV across the load resistor with frequency.

tors as a cost-cutting measure. Any time you see this, be prepared to carefully examine the bonding between the connector ground shell and the shielded enclosure.

#### TROUBLESHOOTING TIPS USING CURRENT **PROBES**

Here are a few troubleshooting tips using current probes.



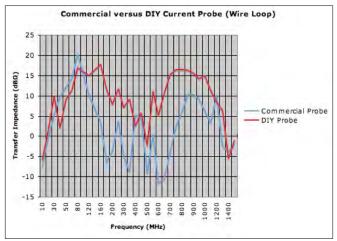


Figure 8 Transfer impedance (ZT) graph of a commercial current probe versus the DIY toroidal probe. The x-axis is frequency, while the y-axis is  $dB\Omega$ . Note that the commercial probe is only designed and characterized to 250 MHz, so the data above that, while interesting, is probably not valid. The DIY probe, as well, performs poorly above 200 MHz and frankly, the wire loop used to introduce a "calibrated" current (while as short as possible) affects the measurement, as well.

- 1. When evaluating the harmonics on a cable by using a current probe, if sliding the probe back and forth changes the harmonic levels, part of the coupling may be near-field, rather than conducted.
- 2. When using a pair of current probes; one on each of two cables, if the harmonics are the same in each, the source is in the middle. If one cable has stronger harmonics, then you'll want to work on that side first. See Figure 12 below.
- 3. Measuring the currents on two suspect legs of a dipole should read the same. Placing the two suspect legs through the same current probe should cause a big decrease due to current cancellation. See Figure 12 below.
- 4. When measuring video cable currents and large cable movements cause big changes in amplitude, the coupling is likely inductive - otherwise, it's more likely conductive.
- 5. If you suspect inductive coupling, the phase at the victim will be 180-degrees from the source. This may be observed on an oscilloscope with H-field probes or current probes. Try syncing the scope trigger at the source using a scope probe.

My colleague, Doug Smith, has many more examples on how to use current probes for measuring cable and PC board resonances, injecting pulses for troubleshooting, interpreting the relative phase of common-mode currents and troubleshooting ESD issues. Refer to the references below.

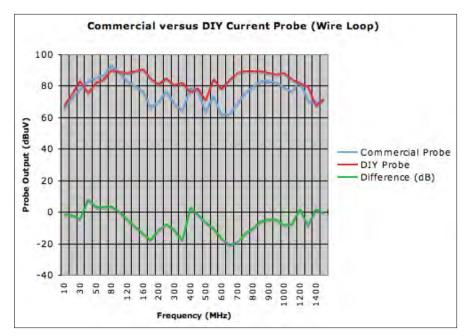
#### **SUMMARY**

Use of a current probe is vital during the troubleshooting process. Poorly bonded cable connectors can be readily identified and fixed. The radiated E-field from a product I/O cable may be calculated by measuring the high-frequency common-mode currents flowing in the cable. All this may be performed right at the designer's

workbench and without the expense of a third-party test facility or shielded chamber.

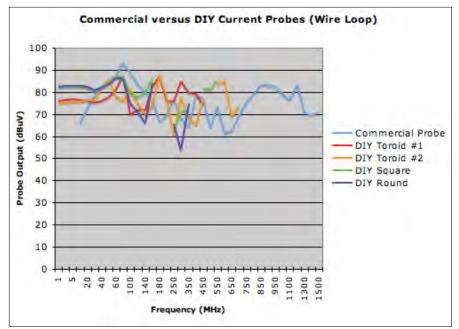
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**Figure 9.** Probe output voltage  $(V_{out})$  graph of a commercial current probe versus the DIY toroidal probe. The x-axis is frequency, while the y-axis is dBuV. This shows that the probes are very comparable in output voltage versus frequency. For troubleshooting purposes, absolute accuracy is not required - just consistency in measurements. All one really needs to know is, "did the fix I implemented make the CM current go up or down?" The DIY probe works well for this.





**Figure 10.** Probe output voltage ( $V_{out}$ ) graph of a commercial current probe versus two DIY toroidal probes and two different clamp-on probes. The x-axis is frequency, while the y-axis is dBuV. This shows that all these probes are very comparable in output voltage versus frequency and therefore, useful for troubleshooting purposes. Just don't try using the DIY probes to determine "pass or fail" predictions. Commercial probes are better-suited for that.

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#### Test setup:

Current probe on USB cable. Connection between connector ground shell and chassis enclosure made with screwdriver blade.

# Looking from 500 to 1000 MHz

Before

Some harmonics dropped by 10-15 dB!

After

#### Figure 11. Cables should be tested individually. Here, I have a current probe clamped around the cable under test and am monitoring the harmonics with a simple hand-held spectrum analyzer. As I ground the connector shell to the chassis with the Swiss Army screwdriver blade, the harmonics were reduced 10-15 dB!

#### **REFERENCES - SUPPLIERS**

- Fischer Custom Communications (FCC), Phone: (310) 303-3300, Email: sales@ fischercc.com, Web: www.fischercc.com. They provide a very wide range of HF current probes - their specialty.
- [24] Laird Technologies, Web: http:// www.lairdtech.com/Products/EMI-Solutions/. They offer a complete line of ferrite cores and chokes.
- [25] Pearson Electronics, Phone: (650) 494-6444, Email: sales@pearsonelectronics. com, Web: www.pearsonelectronics.com. They have a good selection of probes.

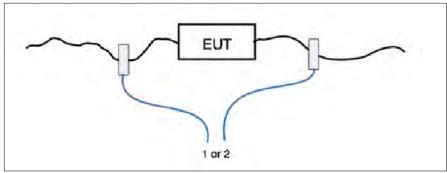


Figure 12. When measuring two cables from a system and the harmonic currents are approximately the same (point 1 is the same as point 2), the source is at the center (the EUT) and the two cables are acting as a dipole antenna. You may notice a peak in harmonic strength at the half-have length of the two cables combined. If the harmonic currents are larger in one side or the other, then you'll want to troubleshoot just that cable.

- Rhode & Schwartz USA, Phone: (888) 837-8772, Email: info@rohde-schwarz.com, Web: www.rohde-schwartz.us. They have a very limited selection.
- Solar Electronics, Phone: (800) 952-5302, Email: sales@solar-emc.com, Web: www.solar-emc.com. They have a limited selection.
- [28] Teseq USA, Phone: (732) 417-0501, Email: usasales@teseq.com, Web: www.

- teseq.us. They have a very limited selection.
- Thurlby Thander Instruments, Phone: +44-1480-412451, Email: sales@tti-test. com, Web: http://www.tti-test.com/contacttti.htm. They offer a low-cost handheld spectrum analyzer for under \$2,000 USD.
- Würth Electronics Midcom, (605) 886-4385, midcom@we-online.com, www. we-online.com. I used one of their large ferrite cores for my DIY current probe.

KENNETH WYATT, SR. EMC Engineer, Wyatt Technical Services LLC, holds degrees in biology and electronic engineering and has worked as a senior EMC engineer for Hewlett-Packard and Agilent Technologies for 21 years. He also worked as a product development engineer for 10 years at various aerospace firms on projects ranging from DC-DC power converters to RF and microwave systems for shipboard and space systems. A prolific author and presenter, he has written or presented topics including RF amplifier design, RF network analysis software, EMC design of products and EMC troubleshooting techniques. He has been published in magazines such as, RF Design, EMC Design & Test, Electronic Design, InCompliance, Interference Technology, Microwave Journal, HP Journal and several others.

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| Model<br>Number | Frequency<br>Range<br>(GHz) | Rated<br>Power<br>(Watts)<br>Min. | P1dB<br>Power<br>(Watts)<br>Min. | Gain<br>(dB)<br>Min. |
|-----------------|-----------------------------|-----------------------------------|----------------------------------|----------------------|
| S31-5           | 0.8-3.0                     | 5                                 | 5                                | 37                   |
| S31-10          | 0.8-3.0                     | 10                                | 8                                | 40                   |
| S31-20          | 0.8-3.0                     | 20                                | 15                               | 43                   |
| S31-25          | 0.8-3.0                     | 25                                | 20                               | 44                   |
| S31-40          | 0.8-3.0                     | 40                                | 30                               | 46                   |
| S31-50          | 0.8-3.0                     | 50                                | 40                               | 47                   |
| S31-75          | 0.8-3.0                     | 75                                | 60                               | 49                   |
| S31-100         | 0.8-3.0                     | 100                               | 80                               | 50                   |
| S31-150         | 0.8-3.0                     | 150                               | 130                              | 52                   |
| S31-200         | 0.8-3.0                     | 200                               | 150                              | 53                   |
| S31-250         | 0.8-3.0                     | 250                               | 200                              | 54                   |
| S31-300         | 0.8-3.0                     | 300                               | 250                              | 55                   |
| S31-400         | 0.8-3.0                     | 400                               | 350                              | 56                   |
| S31-500         | 0.8-3.0                     | 500                               | 450                              | 57                   |

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| Model<br>Number | Frequency<br>Range | Rated<br>Power<br>(Watts)<br>Min. | P1dB<br>Power<br>(Watts)<br>Min. | Gain<br>(dB)<br>Min. |
|-----------------|--------------------|-----------------------------------|----------------------------------|----------------------|
| SCDX10          | 10KHz-400MHz       | 10                                | 10                               | 40                   |
| SCDX25          | 10KHz-400MHz       | 25                                | 25                               | 44                   |
| SCDX50          | 10KHz-400MHz       | 50                                | 50                               | 47                   |
| SCDX100         | 10KHz-400MHz       | 100                               | 80                               | 50                   |
| SCDX150         | 10KHz-400MHz       | 150                               | 100                              | 52                   |
| SCDX200         | 10KHz-400MHz       | 200                               | 160                              | 53                   |
| SCDX250         | 10KHz-400MHz       | 250                               | 200                              | 54                   |
| SCDX350         | 10KHz-400MHz       | 350                               | 280                              | 56                   |
| SCDX500         | 10KHz-400MHz       | 500                               | 300                              | 57                   |







#### **INSTRUMENTS FOR INDUSTRY**

### The Urgent Need to Integrate EMC and Product Safety into Engineering **Curriculum of Technical Universities**

#### **ANTHONY A. DIBIASE**

Spec-Hardened Systems Rochester, New York USA

here is an evolution in the study of electromagnetic field effects on electrical and electronic products and systems. It is progressing from engineering art to an engineering science. The complexity and sophistication of newer technology products has added to an increased need for more consideration of EMC and Product Safety issues. These factors have increased the requirement for technical universities to implement studies of electromagnetic fields and Product Safety into their engineering programs. EMC and Product Safety factors are essential elements in product designs and their required regulatory certification requirements.

#### INTRODUCTION

The lack of adequate EMC and Product Safety design and development education at the university level is contributing to an erosion of the United States (US) technical and export capabilities. At the present time this field of study is not a standard requirement in the engineering programs of universities. A comprehensive knowledge in the disciplines of electrical, mechanical, chemical, and computer science are required as a prerequisite base for performing design and certification tasks related to EMC and Product Safety.

The study requirements for EMC and Product Safety engineering programs have a very good fit with existing electrical engineering programs since the required curriculum prerequisite courses already exist within the engineering programs. Engineers whose responsibilities include the design and development of electrical and electronic products and systems must meet the product's functional, interoperability, self-compatibility, and their regulatory certification requirements. They must have the educational and experience background to effectively perform these tasks.

#### **EDUCATIONAL RESOURCES** PRESENTLY AVAILABLE

At the present in the US there are a limited number of resources available to engineering personnel for obtaining education in the areas of EMC and Product Safety studies. There is a varied amount of university level involvement in EMC and Product Safety training being conducted currently in the US. Among those that have provided or are providing such training in related studies are listed below.

- Clemson University (Vehicle Electronics Laboratory -CVEL) - The Clemson University automotive engineering program awards degrees for a curriculum that includes EMC studies. These studies include courses in the development of EMC computer program modeling. The university has been involved in EMC research projects for over 20 years.
  - University of Missouri of Science

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# Interference THE INTERNATIONAL JOURNAL OF ELECTROMAGNETIC COMPATIBILITY TO STATE OF THE INTERNATIONAL JOURNAL OF ELECTROMAGNETIC COMPATIBILITY TO STATE OF THE INTERNATIONAL JOURNAL OF ELECTROMAGNETIC COMPATIBILITY TO STATE OF THE INTERNATIONAL JOURNAL OF ELECTROMAGNETIC COMPATIBILITY TO STATE OF THE INTERNATIONAL JOURNAL OF ELECTROMAGNETIC COMPATIBILITY TO STATE OF THE INTERNATIONAL JOURNAL OF ELECTROMAGNETIC COMPATIBILITY TO STATE OF THE INTERNATIONAL JOURNAL OF ELECTROMAGNETIC COMPATIBILITY TO STATE OF THE INTERNATIONAL JOURNAL OF ELECTROMAGNETIC COMPATIBILITY TO STATE OF THE INTERNATIONAL JOURNAL OF ELECTROMAGNETIC COMPATIBILITY TO STATE OF THE INTERNATIONAL JOURNAL OF ELECTROMAGNETIC COMPATIBILITY TO STATE OF THE INTERNATIONAL JOURNAL OF ELECTROMAGNETIC COMPATIBILITY TO STATE OF THE INTERNATIONAL JOURNAL OF ELECTROMAGNETIC COMPATIBILITY TO STATE OF THE INTERNATIONAL JOURNAL OF ELECTROMAGNETIC COMPATIBILITY TO STATE OF THE INTERNATIONAL OF ELECTROMAGNETIC COMPATIBILITY TO STATE OF THE INTER





and Technology at Rolla – The university has recently opened a new EMC research center in partnership with a major corporation involving an aviation research project.

- University of Michigan The university is working in conjunction with The Society of Automotive Engineers of Eastern Michigan, a Chapter of the IEEE's EMC Society. The university is involved in cosponsoring seminars that are related to EMC considerations in automotive systems.
- University of Wisconsin at Milwaukee College of Engineering – Has been sponsoring seminars related to EMC topics.
- George Washington University Center for Professional Development - The university has presented educational seminars on EMC related subjects.
- The University of California at Los Angeles (UCLA) – Has a program that awards certificates in EMC studies.
- Oklahoma State University Presents short courses covering EMC topics and testing considerations.

Universities with engineering programs should consider taking advantage of the IEEE EMC Society's University Grant Program. This program provides funding to those universities to aid them in introducing EMC training into their engineering curriculum. Universities can apply for these grants though the society's grant program and a number of universities have already done so.

Other venues for EMC and Product Safety education are available though various seminars and training programs presented by different related corporate services and consulting organizations.

There are universities though out the U.S. which have EMC related activities as part of their educational and research programs. There is a considerable amount of activity occurring in the realm of university research projects that is sponsored by the U.S. government agencies. Among these research projects is one that involves a research study to develop counter measures against improvised explosive devices (IED's) that are used against our military. Other projects in this category that are being worked on are electromagnetic weapons that include electromagnetic pulse and microwave weapon systems. Also, there are university research projects that aimed at assessing the effects of electromagnetic fields on the safety of humans and animals. In another category there are university EMC related research efforts being conducted for industry via university industry partnerships. The study requirements for EMC Engineering programs has a very good fit with existing electrical engineering programs since the required curriculum prerequisite courses already exist in that engineering program.

#### WHERE A FORMAL EDUCATION IS REQUIRED

There are many EMC and Product Safety challenges facing engineers responsible for the design and development of modern day electrical and electronic products and systems. Meeting regulatory certification regulatory compliance is one of them. As an example regulatory compliance requirements are becoming ever more demanding and difficult to meet. The European Union (EU) CE Mark EMC testing requirements are a good example of this fact. The following EMC conformity requirements are applicable for regulatory certification of various electrical and electronic products and systems.

- Electrostatic Discharge (ESD)
- Power Quality Effects factors (PQF)
- Electrical Fast Transient Effects (EFT)
- Radiated Emissions Limits (RE)
- Conducted Emissions Limits (CE)
- Radiated Immunity Limits (RI)
- Conducted Immunity Limits (CI)
- Magnetic Field Effects (H-Field)

The design engineer must be proficient in applying the required mitigating techniques required allowing his product or system to be compatible with these requirements. Some of the Electromagnetic Emissions (EMI) mitigating methods that can be used are, the application of shielding, filtering, optimizing of the grounding design, and applying the correct set of EMC design guideline rules.

Small and medium companies, for the most part, do not have the engineering personnel available who have the knowledge base to perform the required EMC tasks due to their lack of education and experience needed to perform these tasks. The use of consultants is most often the chosen course of action. The added costs related to use of consulting services limits the ability of these companies to be cost competitive in their efforts to export their products globally.

#### **GLOBAL ECONOMIC FACTORS**

While the US is currently in a slow growth economic period other county such as The People's Republic of China, India, Brazil and Russia have economies that are growing at a much faster rate (between 5 and 9 %). This leads to the fact that US manufacturers must look increasingly to exporting their products in order to maintain their profitability. Impeding their ability to be competitive in the international market place is the lack of an adequate pool of educated and experienced EMC and Product Safety Engineers.

More often then not EMC and Product Safety design issues are dealt with in the later stages of the product's design cycle when they are more difficult to fix and are accompanied by greater costs and schedule delays. As companies off shore more and more of their product design, development, and certification activities the result is a diminishing of US's economic capabilities.

EMC and Product Safety requirements are also important considerations for products sold in the US's domestic market. This is true since the Federal Communications Commission (FCC) enforces radiated emissions limit requirements on most electrical and electronic products. They also have strict EMC certification requirements on telecommunication equipment. The Federal Drug

Admiration (FDA) applies several International Electrotechnical Commission (IEC) standards requirements on US medical products. As for Products safety certifications there is always the issue of product legal liability considerations to be deal with and the loss of product reputation.

#### CONCLUSIONS

While there are various sources of EMC and Product Safety educational programs available to engineers, the requirement for a comprehensive formal educational program at the university level is urgently needed. In the years to come, EMC engineering will continue to evolve from an engineering art to an engineering science. Therefore, the need for the understanding of the theoretical and the practical application of EMC principles becomes more essential. It needs to become an integral part of the electrical engineering curriculum.

In the future as device frequencies exceed the 40 GHz level it will present a greater challenge to EMC engineers. Therefore, the need for formally trained and experienced EMC engineers will become more of necessity then an option. At the present time the prevailing view is that EMC engineering entails working with a very complex and intuitively drive science and that only through years of experience can it be mastered in an effective manner. The fast pace of technological advancements and the rapid

development of a complex global economy does not allow the luxury of gaining the required years of EMC experience. A formal education must be provided to engineering students to provide them with the required knowledge foundation to work effectively in the engineering field of EMC.

ANTHONY DIBIASE is the president of Spec-Hardened Systems an EMC and Product Safety consulting firm. He is a graduate of The Rochester Institute of Technology and holds a BSEE degree. He has presented several seminars, training programs, and written articles on the topics of EMC and Product Safety. He can be contacted by e-mail at SHSESC@aol.com.

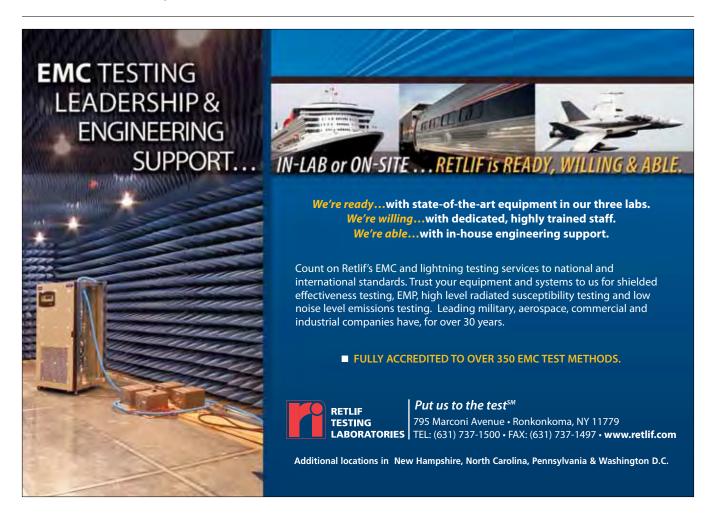
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#### Christmas Music in the Chamber

How a sprinkler system brought radio noise to a chamber and the techniques used to find and remove it

#### **CANDACE SURIANO JOHN SURIANO**

Auburn Hills, Michigan, USA

nechoic and semianechoic or ALSE (Absorber Lined Shielded Enclosure) chambers are supposed to prevent radio signals and other radiated noise in the environment from being detected inside the chamber. A chamber that lets in ambient radiation is not useful for emissions testing. This article covers how a sprinkler system brought Christmas radio noise to a chamber and the techniques we used to find and remove the noise. In this case the spirit of Christmas was a little too much for the EMC engineers to bear. This is how we brought some Christmas cheer back to their last-minute end-of-year testing.

It was Christmas time: the FM radio station broadcasting nearby to our friends' chamber was showing up like the Sears tower in the test ambient. The test engineers that ran the ALSE cleaned the fingers around the door to try to get rid of the radio signal but there was no change in the noise picked up by the biconical antenna. After some experiments they determined that the noise was mostly vertically polarized. Our friends called us and asked us to come help them. We came with an MP3 player with an FM tuner, a spectrum analyzer, an amp and probes.

A handheld radio with a digital tuner is often the best tool for picking up spurious signals in the AM (535-1700 kHz) and FM (88-108MHz) bands. Many times we have

found the source of a radio signal by tracing it with a handheld radio. For example, if you are looking for broadband noise, an AM radio can be used. Tune the radio to the AM band where there is no station that can be heard. Broadband noise will come .in easily on the AM radio. This is a great way to trace wires in a wall. In this case, though, the problem was FM radio stations so we thought we might just be able to pick them up in the chamber with the handheld radio.

The chamber's door was hanging slightly off vertical and was not properly seated by about a fourth of an inch at the top. We

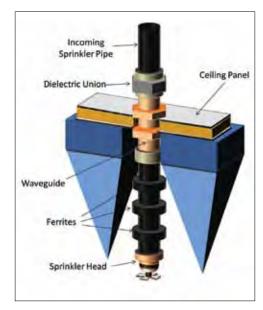


Figure 1. Construction of sprinkler at anechoic chamber ceiling.

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Figure 2. Condition of sprinkler condition at top of chamber. (a) Corrosion at one of the waveguides on top of the chamber. (b) The same waveguide after cleaning. Brass wool can be seen between the waveguide nut and the chamber surface.

Figure 3. Condition of panel joint at top of chamber. (a) Corrosion on the top of the chamber due to pooled water. The corrosion extends to one of the panel joints. (b) Copper tape was used to bridge between the joint and the chamber panel after corrosion was cleaned away. Corrosion under the joint could not be cleaned.

first covered the edges of the door with aluminum foil that contacted with the door edge and the chamber. We had them run an ambient scan and there was no change in the noise that reached the biconical antenna. The FM music showed up on the peak and the average line traces.

We moved our search into the chamber. We brought the spectrum analyzer, amp, probes and FM radio into the chamber. We tried locating the noise source with the FM radio. A check with the FM radio receiver did not reveal anything because the signal was too weak to detect. Unfortunately in retrospect, the MP3 player was doomed to failure for lack of a more substantial antenna. Perhaps we would have had more success with a boom box with an extendable monopole. So we gave up on the radio and tried to use the probes.

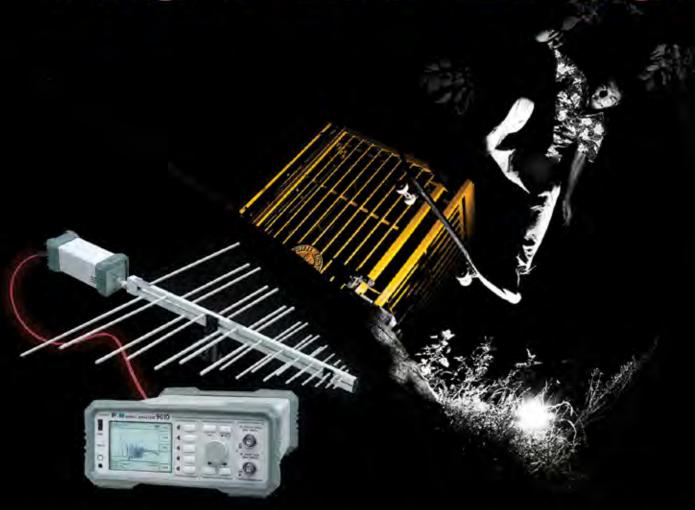
We let the spectrum analyzer, amp and probes warm up after sitting outside in our car trunk. Electronics are sensitive to temperature and it is wise to allow them to come to room temperature before using them. We tried

to pick up the signal with the commercial near field probe but the strength was too low even with the amplifier to be useful. We were hoping to use the probes to find some section of the door, cables, or other ingress/egress points that might be leaking. Finally we had to resort to using an actual EMI receiver in conjunction with our amp. We climbed high on ladder next to some of the nine sprinkler heads and low next to the corners and the door. We were not able to check all the corners because of the equipment that was in the room, including the difficulty of manipulating a tall ladder near cones. We were not able to find the FM signal with the door closed. The probes and amp' even with the EMI receiver were not sensitive enough to find the FM signal.

We next replaced the probes with a coaxial cable having alligator clip leads to make a short dipole antenna. Even though its length was not optimized it was able to pick up the signal. In this case we were hoping that the since our crude dipole "probe" was small it might be able to

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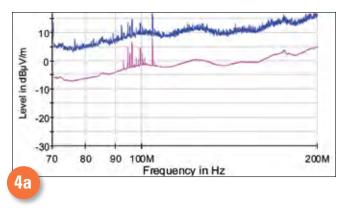
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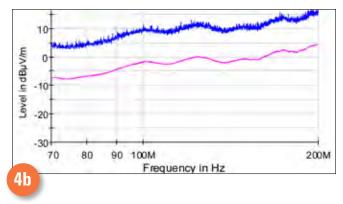


Figure 4. Ambient Measurements. (a) Ambient measurement in the FM band before the sprinklers were fixed (blue is Peak and pink is Average detection); (b) Ambient measurement in the FM band after sprinklers were fixed.

resolve the location of the leak. However, there was too much variation in the signal resulting from the proximity of the wires to the person holding the cable and from the flopping of the wires to be able to make any conclusions.

Finally we had to resort to using the biconical antenna with the amplifier connected to the EMI receiver inside the room. A biconical antenna is usually useful between 20 and 300MHz, designed to pick up the FM radio stations that were plaguing it. Leaving the antenna on the tripod in the vertical orientation and locating it at vari-

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ous spots in the room it became very evident that the signal was coming mostly in through the center sprinkler head which was located directly above the normal test location of the antenna. Every sprinkler head had three very large ferrite rings. We tried moving all the ferrites on the center sprinkler head to one spot on the pipe and the noise became stronger. The two other sprinklers on the sides of the center sprinkler head had weaker FM signals. We wiggled the center sprinkler increasing the conductivity and the FM Christmas music disappeared. We were enthusiastic; it looked like there was a problem with a connection on the top of the chamber that we could easily solve by improving the electrical contact. The many components of a typical chamber sprinkler feed are shown in Figure 1. The brass waveguide provides the necessary electrical grounding of the sprinkler pipe to the chamber, allows for water flow to the sprinkler head, and blocks noise from coming through the hole that must be cut to allow passage of the pipe into the room. If the waveguide is not electrically contacting the chamber walls, then the sprinkler pipe can conduct radio stations into the room.

Up on top of the chamber it was easy to see the root cause of the problem. Chamber sprinklers are a disaster waiting to happen. The fire marshal requires that the system must be tested every year. During the testing sometimes the pipe connections may leak. This can spell catastrophe for an ALSE if the water leaks. This sprinkler system had leaked at some time in the past. The leakage was on the chamber roof at a connection to one of waveguides or its associated dielectric union but no one had known it. The water pooled all the way over to the center sprinkler and corroded the metal on the chamber ceiling panel beneath the brass nut that tightens the waveguide to the panel. Imagine what kind of monetary loss would have been involved if a larger leak had occurred and the panel joints became corroded. It is a good practice to periodically inspect the top of the chamber for sprinkler leaks or even for leaks from the roof. In one instance we are familiar with, a roof leak destroyed several panels on a reverberation chamber ceiling before it was noticed. In

this case, though, the oxidation/rust in the connection had shown up as Christmas radio music in the chamber. The roof was a mess. There was much rust in diverse places. We took pictures of the damage as shown in Figures 2(a) and 3(a). Engineers should always keep good records so they can pass on these lessons or at least so they have lots of cool stories to tell.

By loosening the nuts on the two affected waveguides on top of the chamber it was possible to clean out the corrosion using a wire brush. It took more than one attempt to get them clean. After the roof was cleaned and the nuts re-tightened, the signals were checked again. The FM radio noise in the chamber was worse than before. We requested bronze wool to establish a better electrical connection. Placing the wool between the nut and the chamber roof panel was the solution. One of the cleaned and repaired waveguides is shown in Figure 2(b). Corrosion was also present at one of the ceiling panel joints. Since we could not take the joint apart to clean underneath it, we decided to clean the panel next to the joint and place conductive tape to form a bridge between the joint and the panel as shown in Figure 3(b). The Christmas radio signal we saw on the EMI receiver disappeared! A new trace run on the chamber (see Figure 4) confirmed the absence of the Christmas radio noise and reinstated the chamber engineers' Christmas spirit.

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## CISPR 32: New International Standard on Electromagnetic Emissions from Multimedia Equipment

#### **DAN HOOLIHAN**

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n late 2011, The International Standards Commission's (IEC's) Special Committee on Electromagnetic Interference (CISPR) passed a Final Draft International Standard (FDIS) which had been under development for a number of years. The FDIS was actually developed by CISPR's Subcommittee I - Electromagnetic Compatibility of Information Technology Equipment, Multimedia Equipment and Receivers. The Standard is called "CISPR 32" and it is titled: Electromagnetic Compatibility of Multimedia Equipment - Emission Requirements. This article outlines the contents of the New Standard and describes some of its specific criteria.

#### **OUTLINE OF THE STANDARD**

The layout of the standard follows the normal paragraph/clause orientation of most International Standards. That is: Scope, Normative References, Classification of Equipment, Requirements, Measurements, Equipment Documentation, Applicability, Test Report, Compliance with this Publication, and Measurement Uncertainty.

#### SCOPE

CISPR 32 applies to Multimedia Equipment (MME) having a rated Alternating Current or Direct Current supply voltage not exceeding 600 Volts. The standard is

written for equipment that will be tested in an EMC Testing Laboratory.

It does contain the following two objectives:

- 1. To establish requirements which provide an adequate level of protection of the radio spectrum, allowing radio services to operate as intended in the frequency range 9 kHz to 400 GHz.
- 2. To specify procedures to ensure the reproducibility of measurements and the repeatability of results from one testing laboratory to another.

#### NORMATIVE REFERENCES

The Normative References mentioned in CISPR 32 include: CISPR 16-1-1: 2010, CISPR 16-1-2:2003, CISPR 16-1-4:2010, CISPR 16-2-1:2008, CISPR 16-2-3:2010, CISPR 16-4-2:2011, CISPR/TR 16-4-3:2004, IEC 60050-161:1990, IEC 61000-4-6:2008, ISO/IEC 17025:2005, IEEE 802.3, and ANSI C63.5:2006.

#### TERMS, DEFINITIONS AND ABBRE-VIATIONS

Some key definitions in the standard include:

3.1.6 - Audio Equipment - Equipment which has a primary function of either (or a combination of) generation, input, storage, play, retrieval, transmission, reception, amplification, processing, switching or control of audio signals

3.1.7 - Broadcast Receiver Equipment - Equipment containing a tuner that is intended for the reception of broadcast

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#### 3.1.15 - Entertainment Lighting Control Equipment

- Equipment generating or processing electrical signals for controlling the intensity, color, nature or direction of the light from a luminaire, where the intention is to create artistic effects in theatrical, televisual or musical productions and visual presentations

#### 3.1.20 - Information Technology Equipment (ITE)

- Equipment having a primary function of either (or a combination of) entry, storage, display, retrieval, transmission, processing, switching, or control of data and/or telecommunication messages and which may be equipped with one or more ports typically for information transfer
- 3.1.29 Video Equipment Equipment which has a primary function of either (or a combination of) generation, input, storage, display, play, retrieval, transmission, reception, amplification, processing, switching, or control of video signals.
- 3.1.23 MultiMedia Equipment (MME) Equipment that is Audio Equipment, Broadcast Receiver Equipment, Entertainment Lighting Control Equipment, Information Technology Equipment, and Video Equipment

There are 67 abbreviations listed that are used in the Standard.

#### **CLASSIFICATION OF EQUIPMENT**

The standard defines two classes of equipment associated with two types of end-user environment.

Class B requirements are intended to offer adequate protection to broadcast services within the residential environment. Equipment intended primarily for use in a residential environment shall meet the Class B limits.

Note that all Broadcast receiver equipment is considered to be Class B equipment.

Class A requirements are for all non-Class B equipment; Class A equipment shall comply with the more relaxed Class A limits.

#### REQUIREMENTS

The requirements are covered in Annex A of the standard.

#### **MEASUREMENTS**

This part of the standard defines the measurement facilities and measurement instrumentation specific to the investigation of electromagnetic emissions from MultiMedia Equipment. The philosophy of the standard is that, unless otherwise specified, the basic international standards (for example, the CISPR 16 series of documents) shall be used for all measurement details.

The procedures to be used for measurement of emissions include: (1) the type of Equipment Under Test (EUT), (2) the type of port, (3) the types of cables used, (4) the frequency range, and (5) the mode of operation. Where a port is specified for use with both shielded and unshielded cables, the port shall be tested with both cable types.

The difference between two types of systems is covered in this clause. EUTs are either (1) a host system or (2) a modular system.

When the EUT is a host, it will be configured with modules so that the resulting system is representative of typical use.

When the EUT is a modular system; it can be comprised of different types of modules; (1) External (infra-red remote control), (2) Internal (computer hard-disk), (3) Plug-In (memory stick), and (4) Mounted (sound or video card). Modules intended to be marketed and/or sold separately from a host shall be assessed with at least ONE representative host system. The ports of any module tested shall be terminated in accordance with Annex D of the standard.

Measurements shall be performed using appropriate tables, annexes, and guidelines from the Standard. Prescan measurements shall be used to determine the cable arrangement giving the maximum emission level.

#### **EQUIPMENT DOCUMENTATION**

The standard requires that documentation shall contain details of any special measures required to be taken by the user of the EUT to assure compliance with the standard requirements.

| Highest internal frequency (F <sub>x</sub> ) | Highest measured frequency                |
|--|---|
| F <sub>x</sub> ≤ 108 MHz                     | 1 GHz                                     |
| 108 MHz < F <sub>x</sub> ≤ 500 MHz           | 2 GHz                                     |
| 500 MHz < F <sub>x</sub> ≤ 1 GHz             | 5 GHz                                     |
| F <sub>x</sub> > 1 GHz                       | $5 \times F_{x}$ up to a maximum of 6 GHz |

NOTE 1 For FM and TV broadcast receivers, Fx is determined from the highest frequency generated or used excluding the local oscillator and tuned frequencies.

NOTE 2  $F_x$  is defined in 3.1.19.

Table 1. Required highest frequency for radiated measurements in the standard is shown.

Class A equipment must have the following warning statement in the user instructions:

WARNING: This equipment is compliant with Class A of CISPR 32. In a residential environment, this equipment may cause radio interference.

#### **APPLICABILITY**

If a manufacturer determines, from the electrical characteristics and intended usage of the EUT, that one or more measurements are unnecessary; the decision and justification for the decision shall be recorded in the test report.

#### **TEST REPORT**

The requirements for a test report that documents the results of testing to CISPR 32 are consistent with Clause 5.10 of ISO/IEC 17025. Reproducibility of the measurements is a key element of the test report and, where appropriate, photographs of the measurement configuration shall be included in the report.

The test report shall state: (1) the mode of operation, (2) how the EUT's ports were exercised (using Annex B as a guide), and (3) the product compliance status relative to Class A or Class B limits.

The measurement results of at least the six highest emissions from the type of port being assessed relative to the limit shall be recorded in the report unless they are 10 dB or more below the limit. The results shall include the following information for each emission: (1) the port assessed, (2) for AC power line measurements, the line under test, (3) frequency and amplitude of the emission, (4) margin with respect to the specified limit, (5) the limit at the frequency of the emission, and (6) the detector used.

Additional information that shall be included in the report includes:

- (1) the frequency of the highest internal frequency source unless radiated emissions are measured up to 6
- (2) the calculated instrumentation measurement uncertainty for each measurement type unless U<sub>CISPR</sub> is not defined for the relevant measurement type
- (3) the category of the cable simulated by the Asymmetric Artificial Network (AAN), where emissions from wired network ports are measured using an AAN
- (4) the measurement distance for radiated emission measurements as defined in appropriate tables in the standard. If a non-standard measurement distance is used, the report shall include a description of how the limits were calculated.

#### **COMPLIANCE WITH THIS PUBLICATION**

Compliance with CISPR 32 requires that the EUT has emissions either below Class A (more relaxed)limits or Class B (more stringent) limits. An Equipment Under Test that satisfies the requirements in Annex A of the standard is determined to fulfill the requirements in the entire frequency range from 9 kHz to 400 GHz.

| Table Frequency range |             | Measurement   |                             | Class A limits dB(μV/m)     |
|-----------------------|-------------|---------------|-----------------------------|-----------------------------|
| Ciause                | MHz         | Distance<br>m | Detector type/<br>bandwidth | OATS/SAC<br>(see Table A.1) |
| A2.1                  | 30 - 230    | 1.52          | 10 Quasi Peak /             | 40                          |
|                       | 230 - 1 000 | 10            |                             | 47                          |
| A2.2                  | 30 - 230    | -/            | 120 kHz                     | 50                          |
|                       | 230 - 1 000 | 3             |                             | 57                          |

Table A.2. Requirements for radiated emissions at frequencies up to 1GHz for Class A equipment.

| Table clause | Frequency range | Measurement   |                             | Class A limits dB(μV/m)   |
|--------------|-----------------|---------------|-----------------------------|---------------------------|
| Ciausu       | MHz             | Distance<br>m | Detector type/<br>bandwidth | FSOATS<br>(see Table A.1) |
| A3.1         | 1 000 - 3 000   | 7             | Average /                   | 56                        |
|              | 3 000 - 6 000   |               | 1 MHz                       | 60                        |
| A3.2         | 1 000 - 3 000   | 3             | Peak /                      | 76                        |
|              | 3 000 - 6 000   |               | 1 MHz                       | 80                        |

Apply A3.1 and A3.2 across the frequency range from 1 000 MHz to the highest required frequency of measurement derived from Table 1.

Table A.3. Requirements for radiated emissions at frequencies above 1GHz for Class A equipment.

Where CISPR 32 gives options for testing particular requirements with a choice of test methods, compliance can be shown by applying any one of the test methods using the appropriate limit.

Determination of compliance with CISPR 32 shall be based solely on contributions from the Equipment Under Test. Also, compliance can be shown by measuring the EUT's emission when operating its functions simultaneously, individually in turn, or any combination thereof.

#### MEASUREMENT UNCERTAINTY

Calculation of the measurement instrumentation uncertainty is done in accordance with CISPR 16-4-2:2011 -Specification for radio disturbance and immunity measuring apparatus and methods - Part 4-2: Uncertainties, Statistics and Limit Modeling - Measurement Instrumentation Uncertainty.

However, measurement uncertainty shall not be taken into account in the determination of compliance.

#### ANNEX A - REQUIREMENTS (NORMATIVE)

The requirements for equipment covered under CISPR 32 are given in Tables A.1 through A.12 in Annex A of the newest CISPR document.

Compliance with the radiated emission requirements may only be proven at measurement distances for which compliant-facility or site-validation results exist for the measurement location being used for the radiated emission test.

The requirements for Class A equipment are shown in Tables A.2 and A.3 from the standard, as shown below. Note that Class A equipment may be measured at a 3 or 10-meter horizontal measurement distance at frequencies below 1 GHz.

The requirements for Class B equipment are shown in Tables A.3 and A.5 from CISPR 32.

The requirements for Class B equipment for conducted emissions on the Alternating Current power lines are shown in Table A.9, as below, and graphically displayed in the amplitude versus frequency plot following the Table.

#### ANNEX B - EXERCISING THE EUT DURING MEA-SUREMENT AND TEST SIGNAL SPECIFICATIONS (NORMATIVE)

This Annex of the CISPR 32 standard specifies the methods for exercising the EUT during the emission measurements. The EUT shall be operated in the selected mode(s) while the ports are exercised in accordance with this annex.

Clause B.2 is one of the more controversial parts of the standard since the standard (as specified in Table B.1) will require labs to test the video displays with both (1) standard TV color bar signals and (2) scrolling H characters. This will double the length of the test.

| Table  | Frequency range | Measurement   |                             | Class B limits dB(μV/m)     |  |
|--------|-----------------|---------------|-----------------------------|-----------------------------|--|
| clause | MHz             | Distance<br>m | Detector type/<br>bandwidth | OATS/SAC<br>(see Table A.1) |  |
| A4.1   | 30 - 230        | 10            | Quasi Peak /                | 30                          |  |
|        | 230 - 1 000     |               |                             | 37                          |  |
| A4.2   | 30 – 230        | 3             | 120 kHz                     | 40                          |  |
|        | 230 - 1 000     |               |                             | 47                          |  |

Table A.4. Requirements for radiated emissions at frequencies up to 1GHz for Class B equipment.

| Table clause | Frequency range | Me            | asurement                   | Class B limits dB(µV/m)   |
|--------------|-----------------|---------------|-----------------------------|---------------------------|
| Ciause       | MHz             | Distance<br>m | Detector type/<br>bandwidth | FSOATS<br>(see Table A.1) |
| A5.1         | 1 000 – 3 000   |               | Average/                    | 50                        |
|              | 3 000 - 6 000   |               | 1 MHz                       | 54                        |
| A5.2         | 1 000 – 3 000   | 3             | Peak/                       | 70                        |
|              | 3 000 - 6 000   |               | 1 MHz                       | 74                        |

NOTE Apply A5.1 and A5.2 across the frequency range from 1 000 MHz to the highest required frequency of measurement derived from Table 1.

Table A.5. Requirements for radiated emissions at frequencies above 1GHz for Class B equipment.

| . AC mair    | ns power ports (3.1.1) |                                    |                              |                          |
|--------------|------------------------|------------------------------------|------------------------------|--------------------------|
| Table clause | Frequency range<br>MHz | Coupling device<br>(see Table A.7) | Detector<br>type / bandwidth | Class B limits<br>dB(µV) |
| A9.1         | 0,15 - 0,5             |                                    |                              | 66 - 56                  |
|              | 0,5 - 5                | AMN                                | Quasi Peak / 9 kHz           | 56                       |
|              | 5 – 30                 |                                    |                              | 60                       |
| A9.2         | 0,15 - 0,5             |                                    |                              | 56 - 46                  |
|              | 0,5 - 5                | AMN                                | Average / 9 kHz              | 46                       |
|              | 5 – 30                 |                                    |                              | 50                       |

Table A.9. Requirements for conducted emissions from the AC mains power ports of Class B equipment.

#### ANNEX C - MEASUREMENT PROCEDURES, IN-STRUMENTATION, AND SUPPORTING INFORMA-TION - NORMATIVE

This Annex provides additional information, measurement procedure, and requirements to supplement the normative references defined in Annex A.

Annex C is divided into 3 main clauses:

- (1) Instrumentation and supporting information
- (2) General measurement procedures
- (3) MME-related measurement procedures

#### ANNEX D - ARRANGEMENT OF EUT, LOCAL ASSO-CIATED EQUIPMENT, AND ASSOCIATED CABLING - NORMATIVE

This Annex in CISPR 32 contains a Table D.1 which covers spacing and distances with associated tolerances for a variety of elements for both conducted and radiated emissions.

### ANNEX E - PRESCAN MEASUREMENTS - PRESCAN MEASUREMENTS - INFORMATIVE

The purposes of a prescan are to determine the frequencies at which an EUT produces the highest level of emissions,

and to help select the configurations to be used in the formal measurements. Prescan measurements may be performed with spectrum analyzers without pre-selection provided that precautions are used to ensure that the instrument is not overloaded.

### ANNEX F - TEST REPORT CONTENTS SUMMARY - INFORMATIVE

Guidance for compiling a test report can be found in ISO/IEC 17025:2005 - General Requirements for the Competence of Testing and Calibration Laboratories. The appropriate clause in 17025 is 5.10 - Reporting the Results. Table F.1 in CISPR 32 summarizes the information to be included in the test report for a CISPR 32 test.

# ANNEX G - SUPPORT INFORMATION FOR THE MEASUREMENT PROCEDURES DEFINED IN C.4.1.1 - INFORMATIVE

Annex G has a series of schematic diagrams to assist measurement procedures defined in Annex C of the standard. It includes diagrams for asymmetric artificial networks with various screened and unscreened pairs of wires.

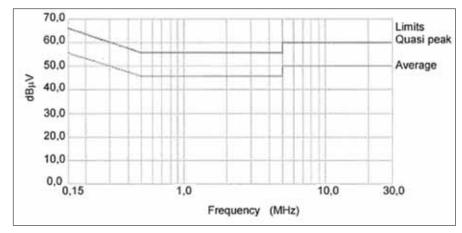


Figure A.1. Graphical representation of the limits for the AC mains power port defined in Table A.9.

#### **BIBLIOGRAPHY**

The new CISPR 32 standard concludes with an extensive Bibliography of standards and other associated documents.

Daniel Hoolihan is a past president of the IEEE EMC Society. He has been a member of the Board of Directors since 1987 and has held numerous leadership positions in the society. Hoolihan is also active on the ANSI Accredited Standards Committee on EMC, C63 as Chairman. He was co-founder of Amador Corporation (1984-1995). He can be reached at DanHoolihanEMC@aol.com.

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## Antenna To Antenna Coupling On An Aircraft: Mitigation Techniques

#### DAVID A. WESTON

EMC Consulting, Inc. Merrickville, Ontario, Canada

he number of RF systems available for use in mission specific aircraft has grown dramatically over the last few decades, with numerous systems operating across very wide bandwidths (some covering almost the entire 1MHz to 40GHz range).

Compatibility issues have become almost a certainty on all but the simplest of aircraft installations, and numerous mitigation techniques have been developed to address these issues. These compatibility issues include:

- 1. Passive Intermodulation (PIM) incident power on these structures.
- 2. IF interference, where the transmitter is at the receiver IF frequency.
- 3. Harmonic interference, where a harmonic of the transmitter is at the intended receive frequency.
- 4. Cross modulation interference, where a high level transmission close to the receiver frequency is not sufficiently attenuated by the receiver input filter (if any). Here compression, intermodulation and spurious responses can occur in the receiver.
- 5. Adjacent channel interference from a transmitter close enough to lie within either the receiver IF bandwidth or the receiver bandwidth.
- 6. Broadband noise from a transmitter which is in band for a receiver.

This paper explains some of the mitigation techniques that can be used to improve intersystem compatibility on an aircraft installation.

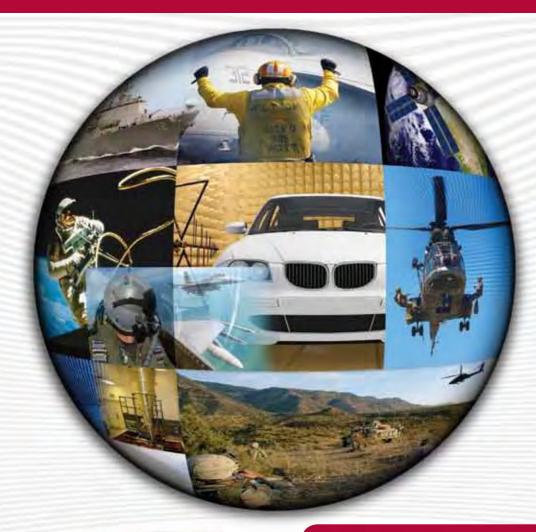
#### PRELIMINARY EMC PREVENTION

Improving intersystem compatibility begins at the initial design stage. When choosing on-board systems, careful consideration should be given to the transmit and receive frequencies of the desired equipment as well as the output power levels, sensitivity levels, blanking capabilities, and intended usage.

A table of all systems and relevant information should be prepared, and this table can be used to determine potential conflicts and the possibility of Simultaneous Operations (SIMOPS). It is important to consider intended usage as some conflicts are quite acceptable. For example the emergency locator transmitter (ELT) transmits in the same range as regular communication radios, however the ELT will only be used in the case of a downed aircraft, and under those circumstances many of the other systems will not be required to operate.

For systems that are required to operate in the same or similar bandwidths, the primary preventative measure is antenna placement. Conflicting system antennas can be mounted at opposite ends of the aircraft or in some cases at the top and bottom of the aircraft. This reduction in coupling increases the isolation between the antennas. The coupling around an

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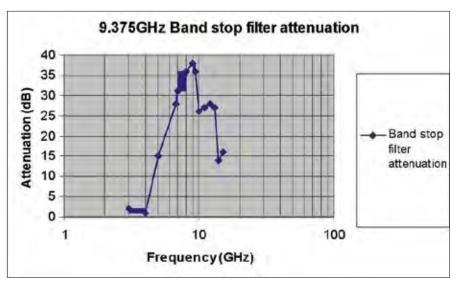


Figure 1. Band stop filter centered at 9.375 GHz.

aircraft is typically a composite of reflections from the Wings and Engine Nacelle as well as the coupling due to the creeping wave around the fuselage. Various techniques, including measurement and computer modeling, are available to determine the coupling between antennas mounted at various locations around an aircraft. These techniques are described in more detail in references 1

and 2 and in practical terms allows an EMC engineer to decide if it is worthwhile to re-position two co-located antennas to the top and bottom of a fuselage or wing or increase the distance between them.

Effective reduction in coupling may be achieved for horizontally polarized transmitting antennas which operate over a narrow frequency range and which couple to either a vertically or horizontally polarized receiving antennas in close proximity. The location of the two antennas may be chosen so that the direct wave and the wave reflected from the surface of the aircraft tend to cancel. This cancellation may be more effective than locating antennas on opposite

sides of the fuselage at low frequency.

Many pieces of equipment also include blanking capabilities. For example, a transmitter may provide a DC output signal when transmitting, and this DC output can be used to disconnect receiving signal paths of local sensitive equipment. Similarly some equipment includes blanking input connections which disconnect the received

> RF signal when a DC level is present at the blanking input.



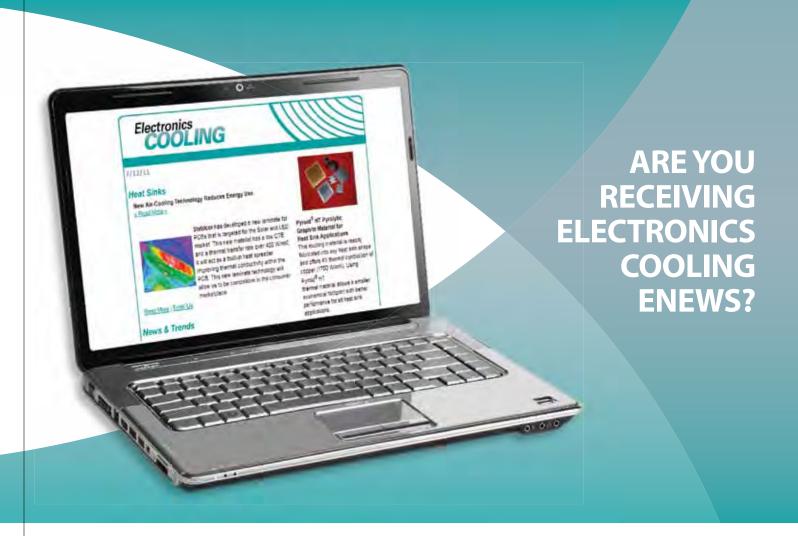
Absorber can also be placed on surfaces, such as the wings, engine, vertical stabilizer and tail plane to reduce reflection as well as for damping surface waves. The absorber may be flexible silicone rubber lossy sheet which is weather proof and can glued to surfaces.

These are typically effective at microwave frequencies, such as used by radar, with some frequency tuned and others effective over a broad band of frequencies. Also a thin ceramic ferrite absorber is available effective from 10MHz to 1GHz. One manufacturer is Cuming Corporation.

#### **FILTERS**

The use of low pass, band pass and band stop filters at the input of receivers can be effective at reducing compression, generation of spurious response, and desensitization of the receiver. High power filters are commercially available for use at the output of transmitters and these are





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Figure 2. The enclosure used for band stop, band pass, low pass filters and the limiter.

used to reduce harmonics and broad band noise from the transmitter.

For transceivers it is possible to design an input filter which can transmit the output power safely and without excessive attenuation.

As an example a weather radar transceiver or a SLAR system operating at 9.375 GHz may cause interference to adjacent receivers, and these receivers can be protected using a band stop filter centered at 9.375 GHz. The insertion loss for this fil-

| Upper band pass<br>frequency<br>(MHZ) | Attenuation at upper band pass frequency | Out of band<br>frequency (MHz)<br>and Attenuation<br>(dB) | 1030MHz Out of<br>band frequency<br>Attenuation (dB) |  |
|---------------------------------------|--|---|--|--|
| 2                                     | 1.2                                      | 100MHz 90dB   | 1030MHz 38dB   |  |
| 30                                    | 1.5                                      | 100MHz 45dB   | 1030MHz 55dB   |  |
| 200                                   | 1.5                                      | 500MHz 50dB   | 1030MHz 45dB   |  |
| 406                                   | 1.5                                      | 800MHz 50dB   | 1030MHz 38dB   |  |

**Table 1.** Performance of typical low pass filters.

ter is negligible at frequencies below 2GHz. The attenuation characteristics of this filter is shown in figure 1. EMC Consulting have designed, built a band stop filter tunable from 700MHz to 1.1GHz with 30dB of attenuation at the center frequency. With the center frequency of this filter adjusted to 1GHz the insertion loss for the filter is less than 0.5dB up to 300MHz and 2dB up to 400MHz. All of the filters described in this report will fit into the small enclosure shown in figure 2 and have been constructed and tested with either BNC

or TNC connectors. This size is ideal for connecting directly at the input of the receiver.

Low or high pass filters can be used where one transmitter frequency comes close to, but does not overlap a receiver. For example a receiver operating in the 1 to 30MHz range would benefit from a low pass filter which attenuates above 30MHz when used in close proximity to a transmitter operating in the 30 MHz to 88MHz range.

Low pass filters are also effective when the interfering signal is at a significantly higher frequency than the in band receiver frequencies. The performance of a range of these filters is shown in table 1 and for the 200MHz in the plot of figure 3.

Filters with sharper roll off above the upper frequency are available commercially but are typically larger then the enclosure seen in figure 2.

#### LIMITER

Limiters can be used in conjunction with other mitigation techniques or alone. If a high level signal is being received at the input to a receiver either in band or out of band a limiter can be used to reduce the input level to an acceptable level without interfering with the desired received signal, unless the two are tuned to exactly the same frequency.

For example, a receiver which is sensitive to -50 dBm but which compresses when an out of band signal exceeding 0 dBm is applied may compress when placed in close proximity to a high power transmitter. The introduction of a 0 dBm limiter would reduce the high power received levels to a manageable level while allowing the intentional



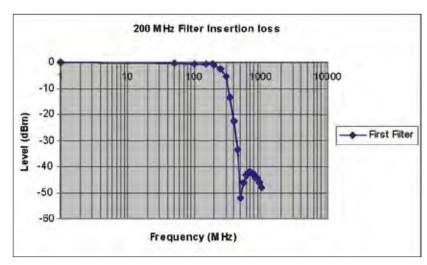


Figure 3. Insertion loss of 200MHz low pass filter.

received levels to pass without compression. The insertion loss for a typical limiter is -2dB from 50 - 500MHz with a useful frequency range of 5 to 3000MHz. EMC consulting has manufactured a PCB on which the limiter was mounted and placed in the enclosure shown in figure 2. The input voltage is 28V and the limiter is protected against all of the EMC power line conducted susceptibility and power characteristics specified in DO-160 or MILSTD-461 by additional components mounted on the

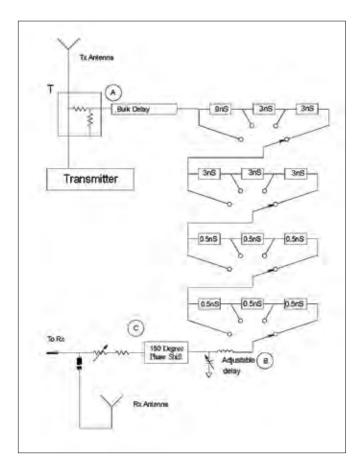


Figure 4. Delay, phase shift, and summation circuit block diagram.

PCB. The operating temperature range of the limiter and associated components is -54°C to 85°C.

#### RF SWITCH AND BLANKING

When transmitters have blanking outputs and receivers blanking inputs then these may be connected to blank the receiver when the transmitter is operational. Some additional components may be required to make the control signal levels compatible. Also when the RF output of the transmitter remains powered up broadband noise is still transmitted. If the transmitter has a blanking output but a receiver does not have a blanking input an RF switch may be used at the receiver input. One such switch is the Mini-circuits ZFSWA-2- 46 which

can be used from DC-4.6GHz. It has maximum 0.8dB attenuation from DC-200MHz, 1.3dB up to 1GHz and 2.6dB from 1- 4.6GHz. It requires two signal inputs to switch from "off" to "on", -8V on one and 0V on the other or vice versa. It is possible to use a simple sine wave oscillator connected to the +28V power, transformer, rectifier and linear regulator to obtain the -8V and the circuit can be protected against all of the DO-160 or MIL-STD 461 power line conducted susceptibility test levels. The maximum input level for this switch is +24dBm and the video leakage (the control level feedthrough conducted out of the RF output) is 30mV pk-pk.

#### **DELAY AND PHASE SHIFT CANCELLATION**

The concept of in band cancellation is introduced in section 10.2.2.2 of reference 3. When the transmit and receive frequency bands overlap then filters are clearly not applicable.

When the interferer received level is extremely high and may result in damage to the receiver the limiter may be used. However even with the limiter in circuit the level after limiting may be high enough to result in receiver de-sensitization, cross modulation or spurious generation.

To cancel or reduce the interferer level a propagation delay, 180 degree phase shift and summation circuit has been developed. This is shown in the block diagram figure 4. The output of the transmitter is tapped off with no reduction in power level between the transmitter and antenna. This can be achieved anywhere on the transmit cable from the transmitter end to the transmit antenna end. The ideal location depends on the total propagation delay of the transmit cable, the coupling path in air between the antennas and the receiver cable, as described later.

The output of the transmitter is attenuated and matched to the impedance of the cable which connects to the circuit at point A. The interferer signal is then passed through a bulk delay. The bulk delay can be in the tens of microseconds the only limit is the attenuation inherent in

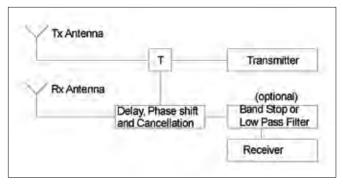


Figure 5. Delay, phase shift, and summation circuit with filter.

the delay elements and the physical size of the enclosure. In practice delays up to 500nS are adequate. For the final selection of the total delay thin film delay lines can be connected in or out of circuit and a fine tuning performed with a variable capacitor and an inductor. With 0.5nS, and 3nS thin film delay circuits the selectable delay can be from 0.5nS to 18nS in 0.5nS increments and the tuned delay can be adjusted over 0.5nS. The total transmitter to circuit cable delay, bulk, and variable delays are chosen to be exactly equal to the transmitter to receiver total path propagation delay. This means that the input signal to the circuit from the receiving antenna and the signal at location B in the circuit are in phase. The signal at point

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B then undergoes a 180 phase shift which is virtually frequency independent.

The signal at point C is then adjusted in level and summed with the receiver input signal.

This achieves an almost complete cancellation at a specific frequency. At either side of this frequency the amplitude at the output of the delay circuit is different from the receiving antenna level. This is because the attenuation with frequency of the transmitter to receiver path is different from the phase shifter cancellation circuit. As the intentional signal from the receiving antenna is routed through the circuit the attenuation of the signal is 1.8dB. Figure 5 shows the path between transmitter and receiver. An input filter is shown in figure 5 but is not necessary.

The transmit path propagation delay can be determined approximately by transmitting a pulse amplitude modulated RF from a signal generator, using the modulation pulse to trigger an oscilloscope, and measuring the delay. An external modulator or RF switch may be used if the generator does not allow pulse modulation. The fine tuning of the delays in the circuit can be accomplished by again using a pulse amplitude modulated signal and comparing the output of the circuit to the input of the receiver. The two channels of the scope used to measure the two signals must have no delay between them (chopped display may be required).

The circuit was adjusted and tested from 1MHz to 30MHz, with the maximum attenuation adjusted at 30MHz. The attenuation achieved is shown in table 2. With the circuit adjusted for 108MHz the attenuation from 60MHz to 108MHz is shown in table 3.

At a single frequency such as 152MHz the cancellation can result in an attenuation of 28dB.

The delay circuits within the phase shift and summation circuit have some temperature coefficient as does the permittivity of the transmit and receive cables and

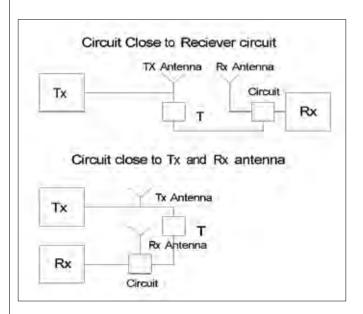


Figure 6. Delay, phase shift, and summation circuit configurations.

| Frequency (MHz) | Attenuation of transmitter signal (dB) |
|-----------------|--|
| 1               | 19                                     |
| 2               | 19                                     |
| 5               | 20                                     |
| 10              | 35                                     |
| 15              | 26                                     |
| 20              | 33                                     |
| 25              | 35                                     |
| 30              | >48                                    |

Table 2. Cancellation attenuation 1MHz to 30 MHz.

| Frequency (MHz) | Attenuation of transmitter signal (dB) |
|-----------------|--|
| 60              | 26                                     |
| 70              | 26                                     |
| 80              | 33                                     |
| 90              | 26                                     |
| 100             | 35                                     |
| 108             | 49                                     |

Table 3. Cancellation attenuation from 60MHz to 108 MHz.

this changes the delay. However the measured change in attenuation of the delay and cancellation circuit was only 1.5dB from 4°C to 47°C.

The location of the T and the circuit depend on the location of the transmitter, receiver, transmit antenna and receive antenna. The goal would be to reduce the amount of cable delay and therefore the amount of bulk delay required in the circuit. Two possible configurations are shown in figure 6.

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DAVID A. WESTON is principle EMC engineer at EMC Consulting, Inc., Merrickville, Ontario, Canada. A member of IEEE and NARTE, Weston has worked full time in EMC for the last 30 years. He is author of the book, "Electromagnetic Compatibility: Principles and Applications" as well as numerous papers and reports, many of which are available at emcconsulting.com. He studied at Croydon Technical College from 1960 to 1965.

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|       |              |       |      |      |
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| 5227  | 80-1000MHz   | 500W  | 5U   |      |
| 5228  | 80-1000MHz   | 1000W | 11U  |      |
|       |              |       |      |      |
| 5135  | 800-2000MHz  | 300W  | 5U   |      |
| 5136  | 800-2000MHz  | 500W  | 5U   |      |
|       |              |       |      |      |
| 5163  | 800-4200MHz  | 50W   | 3U   |      |
| 5164  | 800-4200MHz  | 80W   | 5U   |      |
| 5165  | 800-4200MHz  | 250W  | 8U   |      |
|       |              |       |      |      |
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|       |              |       |      |      |

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## Shortcomings of Simple EMC Filters

#### **ANTONI JAN NALBORCZYK**

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versimplification of EMC filter selection to reduce size and cost can often be a false economy as anticipated performance may not be achieved.

#### INTRODUCTION

EMC design principles are best considered at the equipment design stage, where good mechanical design including component layout and cable routing can help reduce EMC problems at source. Even with good EMC practice, it is invariably necessary to provide a certain amount of filtering. Cost and size considerations will usually encourage the use of a simple filter design. This can sometimes be a false economy as simple designs may not always give expected results. This can have serious compliance implications if EMC specifications have to be met. Some of the commonly encountered problem areas and their solutions are discussed in this article.

#### **PROBLEMS & SOLUTIONS**

When using suppression capacitors either on their own or in filters, it is most important to keep lead lengths as short as possible. An ideal capacitor of capacitance value C would have a linear impedance characteristic Z expressed by  $Z=1/2\pi fC$ , where f is the measurement frequency.

However, a real two-terminal capacitor

will resonate at a frequency determined by its capacitance and the inductance L of its leads. The resonant frequency is given by f=1 /  $2\pi \sqrt{LC}$ . Below the resonant frequency, the capacitor impedance follows the ideal response, but, above the resonant frequency, the capacitor suppression performance reduces dramatically. Increasing the lead length reduces the resonant frequency and causes a loss in performance of the capacitor.

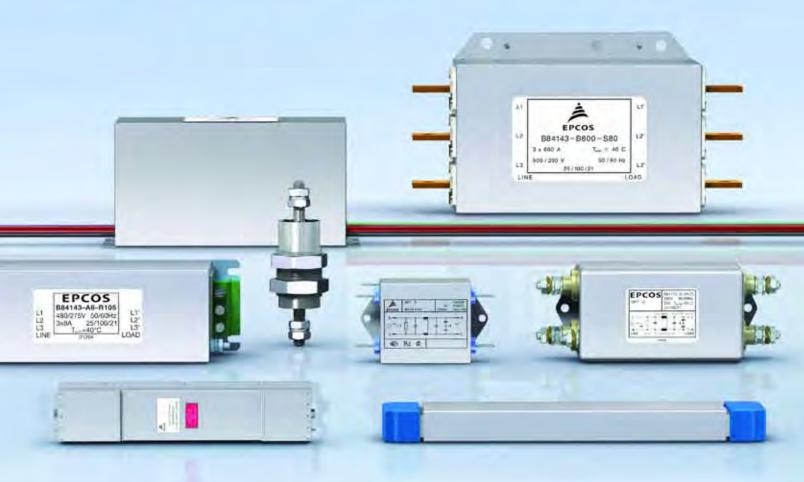
This can be seen in Figure 1, which compares the impedance of a 1µF capacitor with 20mm and 100mm leads. The leads of a two-terminal capacitor will typically have an inductance of about 7nH per 10mm lead length, which gives a resonant frequency of about 800kHz for a 1µF capacitor with 20mm leads. The shaded area on the graph indicates the loss in performance caused by increasing the lead length from 20mm to 100mm.

Above its resonant frequency, the twoterminal capacitor behaves as an inductor with the inductance L of its lead wires. Its impedance then becomes  $Z=2\pi fL$ . If suppression performance is needed above the resonant frequency in line-to-earth applications, then a feedthrough capacitor must be used. Apart from a few minor resonances related to the dimensions of the capacitor element, the feedthrough capacitor has a performance close to the ideal.

Figure 2 shows the physical differences between two-terminal capacitors and feedthrough capacitors. Figure 3 compares

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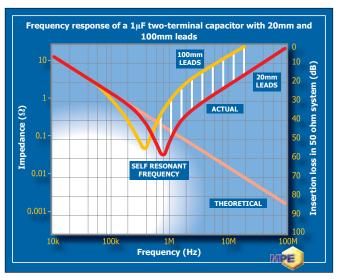


Figure 1. Frequency response of a 1µF two-terminal capacitor with 20mm and 100mm leads.

the performance of a 1µF feedthrough capacitor with a 1μF two-terminal capacitor. The shaded area shows the significant filtering performance not attainable from a two-terminal capacitor, which can be achieved by using a feedthrough capacitor of the same value.

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Figure 2. Typical feedthrough capacitors compared with twoterminal capacitors.

in filters can only be obtained if the filter incorporates feedthrough capacitors. As an example, Figure 4 shows the insertion loss performance of a simple DC pi filter built with feedthrough capacitors, compared to the same filter built with two-terminal capacitors. The shaded area indicates the extra performance obtained by using feedthrough capacitors in the filter design. Note that this graph is displaying insertion loss as opposed to imped-



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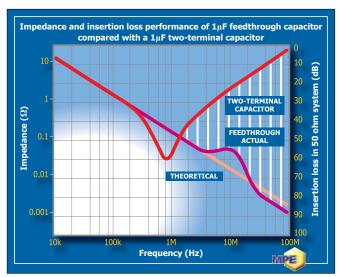


Figure 3. Impedance and insertion loss performance of a 1μF feedthrough capacitor compared with a  $1\mu F$  two-terminal capacitor.

ance on previous graphs so is plotted in the more usual direction for insertion loss.

Many older EMC specifications specify equipment emissions and susceptibility requirements only up to 30MHz, and usually a filter containing two-terminal capacitors will be adequate to comply with these specification requirements. Newer specifications are now

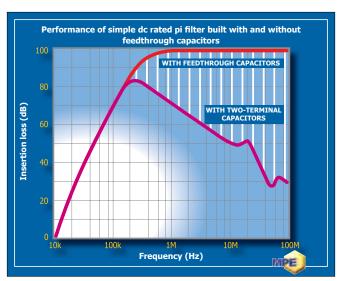


Figure 4. Performance of simple DC rated pi filter built with and without feedthrough capacitors.

demanding EMC compliance up to 1GHz or beyond. This is to provide some protection against the effects of increased high-frequency noise pollution generated by faster processors, mobile phones, faster power control switches and so on.

The user should be aware that, even if his equipment has a CE mark to demonstrate compliance with existing



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FMAB: For industrial applications such as frequency converters and inverters, 12-50A, 125/250 VAC, screw terminals



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**FMBD NEO:** Terminals for 3 phases, neutral conductor and ground, intended for use in 4 wire systems, 8-200A, 300/520 VAC, screw clamp terminals



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EMC specifications, he could still experience problems. Unless his equipment is fitted with a suitable highfrequency filter containing feedthrough capacitors, it is unlikely to be protected against incident high-frequency interference above 30MHz. He could still therefore be responsible for problems caused by his equipment malfunctioning as a result of susceptibility to high-frequency interference.

Even when using feedthrough capacitors, performance can be compromised if the filter or capacitor is not mounted correctly to suitably screen the input from the output terminals. Bypass coupling owing to radiation and pick-up on interconnecting wires is more pronounced at higher frequencies, so greater care is needed to avoid this. The filter should ideally be mounted on or through a bulkhead to completely isolate input from output cables. Alternatively, screened cables should be used on one or both sides of the filter to prevent coupling. Figure 5 shows the effect of not mounting such a filter on a bulkhead or using screened cables. The shaded area shows the loss in high-frequency performance when the filter is not mounted or screened correctly.

#### **ELECTROMAGNETIC INTERFERENCE**

Electromagnetic Interference (EMI) occurs in two modes, asymmetric between line and earth, and symmetric be-

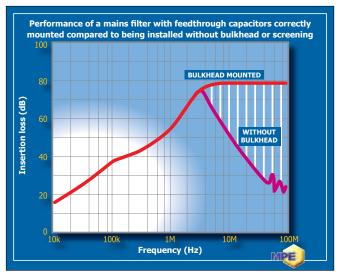


Figure 5. Performance of a mains filter with feedthrough capacitors correctly mounted compared to being installed without bulkhead or screening.

tween lines. Suppression components fitted to remove one mode of interference may have little or no effect on the other mode, which requires a separate set of components connected differently. When choosing a filter circuit, it is important to know whether only one, or both modes of interference require suppression, so that a filter contain-





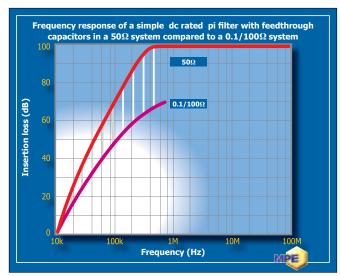


Figure 6A. Frequency response of a simple DC rated pi filter with feedthrough capacitors in a  $50\Omega$  system compared to a  $0.1/100\Omega$  system.

ing the necessary circuit components can be selected. In simple terms, asymmetric filter performance requires common mode inductors and capacitors from lines to earth, whereas symmetric mode performance requires single-line inductors and capacitors between lines.

Where single-line inductors are used in filters, they will saturate as load current increases, and performance

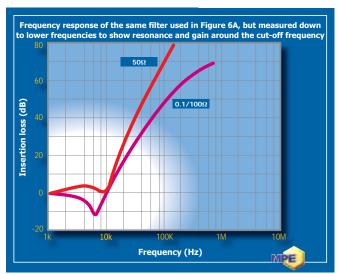


Figure 6B. Frequency response of the same filter used in Figure 6A, but measured down to lower frequencies to show resonance and gain around the cut-off frequency.

will be lost. The user should always check to see that performance figures quoted relate to full load conditions, as performance at full load current can be a lot worse than no load performance.

In most filtering applications, some asymmetric performance is normally required across the frequency



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spectrum up to 1GHz. Symmetric performance, where needed, is usually only required below about 10MHz. Some symmetric performance is often provided by board level components.

The insertion loss performance of filters and suppression components is always quoted in a  $50\Omega$  system. This has traditionally been considered to represent the characteristic impedance of power lines at radio frequencies. With the widespread use of switching power supplies and power controllers, a much lower source impedance is now more typical. In such cases, a different performance will normally be provided by the capacitor or filter compared to the  $50\Omega$  performance shown in the catalogue or datasheet. For most simple filter circuits used in these applications, the actual performance obtained will be worse than expected.

Figure 6A shows an example of the performance of a simple pi filter in a  $50\Omega$  system compared with that measured in an impedance of  $0.1/100\Omega$  ( $0.1\Omega$  source and  $100\Omega$  load impedance) which might be more typical for a switched mode power supply application. The shaded area shows the significant loss in performance produced in the practical system compared to the quoted  $50\Omega$  figures. Although the graph shows a filter with feedthrough capacitors as an example, a filter using two-terminal capacitors would show a similar reduction in performance

in the different impedance system. To obtain the required performance in the practical system, it is necessary to tailor the filter circuit to obtain a maximum impedance mismatch between filter and system impedance. This usually means using a filter with an inductive input to face a low impedance noise source.

Another issue of which many users are unaware is that filters can actually produce a gain at certain frequencies due to the mismatch in the impedance between the filter and the source and load impedances. This gain usually occurs at around the cut-off frequency of the filter and is often not apparent or not present when the filter is measured in a  $50\Omega$  system. However, in a more practical situation where the source and load impedance are not  $50\Omega$ , then the gain can be significant at around 10dB or more.

As an example of this, Figure 6B shows a measurement of the same filter as used in Figure 6A but measured down to lower frequencies to show this effect. It can be seen that, in a  $50\Omega$  system, there is a resonance around the cut-off frequency of 10kHz but no gain. However, the same filter measured in a  $0.1/100\Omega$  system does show a gain of around 12dB at 7kHz.

It must be stated that, although this gain is real, its magnitude and frequency will depend on the actual source and load impedances of the practical circuit, as well as the component values used in the filter circuit. If there is no

> EMI noise present at the frequency of the gain, then there will be no gain, so the phenomenon should be of no concern. This will usually be the case in practice, as the filter will normally be designed for filtering higher frequency noise. However, there could be applications where there is an issue, and the user should be aware of this possibility.

#### STANDARD RANGES

There are many types of simple circuit filters available from numerous manufacturers, but most of them could be subject to some or all of the problems described above when used in certain applications. Becoming increasingly important are standard ranges of feedthrough capacitors, and filters incorporating feedthrough capacitors, which are designed to address some or all of the above problem areas. Some of the standard ranges of filters now available not only incorporate feedthrough capacitors but also have filter circuits designed to give the best response with low source impedance. Some manufacturers' catalogues now also quote performance in both  $50\Omega$  and  $0.1/100\Omega$ systems, which is more helpful.





Figure 7. Standard range of equipment filters incorporating feedthrough capacitors.



Figure 8. Standard filter for switched mode power supplies incorporating feedthrough capacitors and offering good performance in a 0.1/100 $\Omega$  system.

Figure 7 shows an example of standard filters incorporating feedthrough capacitors, and which have bulkhead mounting to provide optimum high-frequency performance.

Figure 8 shows an example of a standard filter designed for switched mode power supply applications to offer good



Figure 9. Standard ranges of feedthrough capacitors.

performance in a  $0.1/100\Omega$  system.

As an alternative, Figure 9 shows an example of a standard range of feedthrough capacitors, which will offer excellent, cost-effective, high-frequency performance where full filter performance is not needed.

#### **SUMMARY**

This discussion has identified a few pitfalls, which can cause the anticipated filter or capacitor performance not to be achieved in practice. If a standard catalogue filter is to be used, then the user should ensure that the selected filter design addresses any problem areas above relevant to the application.

This may involve the selection of a slightly more specialised filter. For critical applications, the best approach is to obtain advice on the selection of the best filter circuit to use from a specialist filter company with established practical experience in filtering for EMC. The supplier should be familiar with the type of problems discussed here and therefore be able to provide rapid and accurate advice on the most cost-effective solution for a given application.

JAN NALBORCZYK graduated from Birmingham University, UK, with a BSc degree in Physics in 1973. He has worked for MPE Ltd since 1979 and is currently Technical Director of the company, which is based in Liverpool, UK. Email: jnalborczyk@mpe.co.uk

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## Eliminating the Need for Exclusions Zones in Nuclear Power Stations

#### PHILIP F. KEEBLER

EMC Group, Electric Power Research Institute Knoxville, Tennessee, USA

tilities operating nuclear power plants have been dealing with electromagnetic interference (EMI) problems for over two decades. Many early problems that affected the operation of instrumentation and control (I&C) equipment in plants stemmed from the use of wireless transmission devices (WTDs) (e.g., radio walkie-talkies, cellular phones, etc) inside the plant in the vicinity of system cabinets and cable trays carrying bundles of cables. A simple and partially effective method of reducing EMI events caused by WTDs has been to mark off exclusions zones around system cabinets and areas where I&C equipment is installed. The use of these zones has presented some problems for existing plants. For example, some plants have had to expand the area of some zones that became ineffective upon the use of new WTDs that evidently presented an increased risk to the operation and EMI protection of I&C equipment. The sizes of some expanded zones are larger than 2,000 square feet. In addition, some zones encroach upon human traffic areas used by plant personnel to move from area to area within a plant.

Exclusion zones have also been recognized as a problem in the design of new plants. Some plant planners and designers have elected not to use exclusion zones realizing that even a well-planned pro-

gram designed to limit the use of WTDs in these zones simply presents too high of a risk in causing an EMI event. Success of the exclusion zone strategy depends upon limiting the use of WTDs in those zones. Plant engineers and technicians must be able to use their WTDs in areas close to I&C equipment during maintenance and troubleshooting and possibly even in situations where cabinet doors must be open. Moreover, controlling the inventory of WTDs, especially radio walkie-talkies, will also present problems for plant staff. If radios are categorized by power level, then a plant worker may need a low-power radio when none are available. In this situation, a high-power radio may be the only option available during an emergency situation in the plant.

This article is Part 1 of 2 addressing the issue of exclusion zones in existing plants. Past EPRI research has provided useful guidance in EMC helping to avoid EMI events given the state of plant EM environments in the last 17 years. However, with increasing use of digital I&C equipment in existing plants, the planned widespread use of this equipment in new plants, and the increasing demand to use WTDs in nuclear plants, changing EM environments require the development of new and more effective approaches to manage EMC and the risks associated with EMI events in the plants of today and tomorrow.

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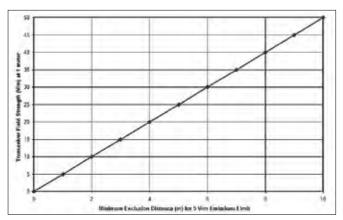


Figure 1. Recommended minimum exclusion distance (in meters) as a function of transceiver field strength (V/m) at 1 meter. (EPRI TR-102323 (1997) Revision 1).

#### BACKGROUND - HISTORY OF EXCLUSION ZONES IN PREVIOUS EPRI REPORTS

Nuclear power plants require a very high degree of protection from EMI. To achieve this, previous guidelines<sup>1</sup> published in a series by the Electric Power Research Institute (EPRI) used a methodology of performing plant electromagnetic (EM) surveys and from that data establishing recommended emissions and immunity levels, tests and EM management strategies. EPRI TR-102323 Revision 1 states in its abstract:

Nuclear power plants undertaking digital upgrades have been required to conduct expensive, site-specific electromagnetic surveys to demonstrate that electromagnetic interference (EMI) will not affect the operation of sensitive electronic equipment. This study was prompted by utilities desiring a more complete understanding of the EMI problem and to provide technically sound alternatives. .... Based on the emissions levels and expected types and levels of interference in nuclear power plants, guidelines for equipment susceptibility tests were developed. ... the levels are conservative based on the analyzed data. The working group defined specifications to obtain additional emissions data to validate these guidelines, develop a basis for equipment emissions testing, bound highest observed emissions from nuclear plants and eliminate the need for site surveys. .... The report includes minimum EMI limiting practices and guidance on equipment and plant emission levels.

One of the major changes made from the original report by the first revision (Rev. 1) was "an increase of the margin between the allowable plant emissions limit and the susceptibility limit from 6 dB to 8 dB". However, a

 $^1$  Guidelines for Electromagnetic Interference Testing in Power Plants: Revision 1 to TR-102323-R1, EPRI, Palo Alto, CA: January 1997.

Guidelines for Electromagnetic Interference Testing of Power Plant Equipment: Revision 2 to TR-102323, EPRI, Palo Alto, CA: November 2000.

Guidelines for Electromagnetic Interference Testing of Power Plant Equipment: Revision 3 to TR-102323, EPRI, Palo Alto, CA, and the U.S. Department of Energy, Washington, D.C.: 2004. 1003697.

technical basis is not given in the report for the change. A discussion of the 8 dB buffer is provided in Chapter 7 of that report stating:

The limit for plant emissions was chosen to be 8 dB below the recommended equipment susceptibility testing level ... This limit is selected only to provide a reference point by which the utility engineer may determine if the emissions data from his plant are adequately bounded by the recommended susceptibility testing levels, thus allowing application of the generic susceptibility limits in this report. The plant emissions limit was chosen to be 8 dB below the recommended susceptibility levels to provide additional conservatism in when determining if the recommendations in this report can be applied to a particular facility.

While the reports utilize a strategy of studying plant emissions, and from that and other information, developing a EM protection plan, even in the conclusions of Rev. 1 in that report, the danger of relying too heavily on plant EM survey data is noted.

Operating experience from group members has shown that the nuclear power industry EMI/RFI problems are primarily due to infrequent transient interference and not steady-state EMI. Transient interference is well understood and documented in various industry standards. The industry standards do not require site emissions testing (mapping), but instead define equipment susceptibility testing levels based upon expected maximum plant EMI/ RFI levels. Steady-state emissions recorded over a short period of time are unlikely to capture a transient event. The only EMI/RFI emitters that could affect digital equipment operation are portable transceivers. It is reasonable to conclude that steady-state mapping is not useful for identifying threats to digital systems.

Based on an understanding of sources of EMI in nuclear power plants, generic emissions measurements were performed to characterize both steady-state and transient EMI. Procedures were developed to describe the highest observed environment for key safety systems.

What is evident is that while previous versions of the

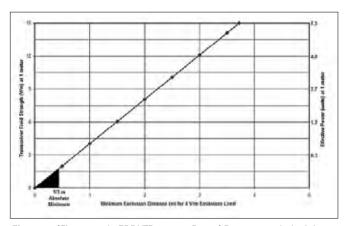


Figure 2. (Figure 6-1 in EPRI TR-102323 Rev. 2) Recommended minimum exclusion distance (in meters) as a function of transceiver field strength (V/m) at 1 meter. (EPRI TR-102323 (2000) Revision 2).



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report gave a central role to data obtained in plant EM surveys, they also recognized the dangers of relying on that data exclusively. In particular, the fact that most interference events occur due to infrequent, transient events was recognized. Guidance solely centered around the statement, "The only EMI/RFI emitters that could affect digital equipment operation are portable transceivers." must be revised to address the risks posed by the broader availability and use of intelligent WTDs that are appearing in existing plants as well as the ones that will be used in new plants. While certainly portable transceivers are a well identified risk, EMI events caused by the use of today's modern cellular telephones and other WTDs in the vicinity of I&C equipment present real risks that must be addressed in any plan defining the management of EMC for nuclear plants.

After surveying the data available on plant EM environment, both steady-state and transient, a strategy is recommended for assuring the required level of interference protection. Emissions and immunity levels and tests

> are recommended for equipment. In order to assure that the immunity levels are not exceeded, the previous versions of the EPRI TR-102323 report recommended the use of exclusion zones to keep electromagnetic and RF sources away from I&C systems. In Chapter 6 of Rev. 1, the following section discusses the method of providing protection from portable transceivers.



#### Controlling Emissions Sources

#### Portable Transceivers (Walkie -Talkies)

1. Proper administrative control of portable transceivers is necessary to protect EMI/RFI sensitive equipment. To provide at least 8 dB margin between the transceiver emissions limit (4 V/m) and the recommended equipment susceptibility limit (10 V/m), a minimum transmitter exclusion distance must be maintained. The transceiver field intensity can be estimated knowing the device power level and assuming the highest antenna gain factor of one according to the equation:

$$V_d = \frac{(30 P)^{0.5}}{d}$$

Eq. 4.1 from EPRI TR-102323 Revision 1 where P is the effective radiated power of the transceiver in watts; d is the distance in meters from the transceiver and Vd is the field strength in volts/meter.

A portable transceiver with an effective radiated power of 3 watts generates a field strength of 9.5 V/m at a distance of 1 meter; 4.75 V/m at 2 meters and 0.95 V/m at 10 meters. The field strength falls of linearly with distance. Alternatively, the



Figure 3. An example of an innovative product (electronic book reader) that has an integrated cell phone transmitter.

transceiver field strength can be measured at 1 meter by testing in accordance with Electronic Industry Standard (EIA), EIA-329, Part II for Mobile Radios (20).

To determine the minimum transceiver exclusion distance:

- 1. Calculate the transceiver field strength for a distance, d of 1 meter using Equation 6.1.
- Referring to Figure 1 (Figure 6-1 in EPRI TR-102323 Rev. 1), determine the minimum transceiver exclusion distance corresponding to the calculated transceiver field strength at 1 meter.

The minimum exclusion distance is required to ensure a margin of at least 8 dB between the transceiver emissions and sensitive equipment susceptibility testing levels. It is acceptable to increase the minimum transceiver distance or to even restrict their use in rooms where EMI/RFI sensitive equipment is located. The group recognizes the need to use these devices and has developed this guidance to support their use where transceivers and EMI/RFI sensitive equipment must operate in a shared environment.

As can be seen by the section title, "Portable Transceivers (Walkie-Talkies)," at the time the report was written the primary concern was walkie-talkies. The report next goes on to discuss arc welding and gives guidance on how to control emissions from that source. The report assumes that the types of portable wireless devices are limited, generally hardware based radios, serving primarily a single function, for practical purposes the only concern was walkie-talkies. For these transceivers, exclusion zones were an effective strategy. Since that time and increasingly, wireless is being utilized in a rapidly growing variety of ways.

Devices increasingly are using digital techniques, controlled by software, in contrast to the traditional hardware-based radios. The trend is more toward multifunction devices that are equipped to transmit on multiple bands using a variety of protocols. Witness the very popular eBook readers, which often are equipped with a cell phone interface, capable of operating on any of several frequency bands, using a variety of RF protocols and in addition have a WiFi radio.

Increasingly, these devices aggressively use power control to maximize battery life. This means that the very same device may operate any of its several radios at different frequencies, using a different protocol and with a wide variation in its transmit power. MIMO (multiple-input, multiple-output) is widely used, allowing some devices to simultaneously transmit on multiple frequencies over any of several antennas. One highly successful smart phone has three different antennas built into its edge.

By the Rev. 2 of the EPRI TR-102323 report, the graph (shown in Figure 2 below) was modified to indicate a 4 V/m maximum emission limit, reduced from the 5 V/m defined in Rev. 1. In addition, a 1/3 meter absolute minimum protection distance was added. The total distance scale was reduced from 10 meters to 4 meters. In addition, a second scale was added to the vertical axis showing the effective radiated power as well as the field strength. While the guidance and verbiage remains relatively the same, these differences indicate a growing need for additional EMC protection while also the difficulty of enforcing a exclusion zone over larger areas.

The Rev. 3 version of EPRI TR-102323 (2004) keeps the graph unchanged but refines the equation by adding a gain factor:



$$V_d = \frac{(30 P)^{0.5}}{d}$$

Eq. 4.1 from EPRI TR-102323 Revision 3

While the changes in Rev. 2 and 3 of the EPRI TR-102323 report show a growing sophistication with both threat presented by portable transceivers and the difficulties of effectively implementing and enforcing an exclusion zone strategy, the view of portable transceivers remains relatively constant, with walkie-talkies remaining in the section title for all three revisions.

However, exclusion zones have in some cases failed to provide the required protection and are becoming increasingly burdensome to establish and enforce. This was the consensus, lead by one lead I&C engineer from a major US utility in the south who is currently designing advanced nuclear plants (with one under construction) at the December 2008 EPRI Nuclear EMI Working Group Meeting held in Washington, DC.

Interference incidents which have occurred give evidence to the failure of the exclusion zone strategy to provide the desired level of EMC protection for I&C systems in existing nuclear plants. There are many documented cases of malfunction and upset of I&C systems in existing plants caused by operation of a portable wireless transmission device (not always a walkie-talkie) too close to a

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standard system cabinet with its doors closed.

At times, the failure is caused a source of EM energy was not recognized as such where an exclusion zone was not involved. One example occurred when the starter for a high intensity discharge (HID) lighting system (magnetically-ballasted) emitted an EM pulse when it attempted to strike a burned out lamp. Because the lamp was burned out, the starter repeatedly attempted to ignite it, emitting a continuing stream of EM pulses as a result. These emissions caused false detections to be registered in a radiation monitor located in another room in the plant. Radiated EM pulses from failed lamps were converted into a band of conducted emissions coupled into the signal loop of the radiation monitoring system. This caused frequent false alarms in the control room.

Another reason for the failure of exclusion zones is that with the increasing use of wireless technology, enforcement of exclusion zones is increasingly problematic. As wireless technologies are adopted and become a more significant part of the work equipment for various personnel, like maintenance workers and security personnel, conflicts are created when enforcement of the exclusion zone would deprive a worker of the tools they rely on to perform their job. This kind of conflict is likely to become increasingly prevalent as wireless technologies are used for an ever increasing variety of functions. Moreover, in today's culture of increased security required to protect nuclear plants and instantly respond to any potential threat, security and plant personnel, any restriction on the use of portable wireless devices will only limit the effectiveness of these personnel to protect the staff and the plant from a possible catastrophic situation. Security personnel must be focused on protecting the plant and staff without having to worry about tripping a critical safety-related I&C system.

The job of an I&C engineer and other plant personnel on the plant floor frequently involves the use of portable wireless devices when the doors of system cabinets are open. Communications are needed with other personnel out in the plant to maintain and troubleshoot I&C systems. Without these communications, standard procedures needed to bring I&C systems back up on line could not be performed.

Additionally, one concern of planners for advanced plants is that use of the exclusion zone strategy will lead to the 'approved use' and 'not approved use' of the inventory of portable wireless devices in the plant. If wireless device began to be segregated based on approval from whether or not they are likely to cause an EMI problem, additional confusion will result when plant personnel strive to manage this divided inventory. One engineering planner was worried that all 'approved' wireless devices would be in use by plant personnel when one was needed. This would result in the selection of a 'non-approved' device for use on the plant floor even though it might be against a plant's policy.

Today, plants are now approving the use of some cell

phones and wireless telephones while not approving others. The decision to 'approve' or 'not approve' is sometimes based on misleading information, incorrect test results, incomplete test procedures, or data for the wireless device that may lead plant personnel to suspecting that a device may or may not cause an EMI problem.

Fortunately, exclusion zones are one of three methods for protecting equipment from electromagnetic interference (EMI). Those methods are:

- Keep unwanted energy out of sensitive I&C equipment by separating the emitting equipment from sensitive equipment. This is the exclusion zone strategy.
- Protect sensitive equipment from the unwanted energy by using additional shielding or filtering either at the system cabinet level or inside the cabinet but external to the sensitive equipment.
- Design sensitive equipment to be inherently immune to the effects of unwanted energy.

In Rev. 3 and earlier versions of EPRI TR-102323. Guidelines for Electromagnetic Interference Testing of Power Plant Equipment, an exclusion zone strategy for dealing with portable transceivers, guided by a simple logic, implemented the first of these strategies.

#### ADVANTAGES & LIMITATIONS OF EXCLUSION **ZONES**

Exclusion zones have significant advantages in existing nuclear plants early on when there were fewer portable wireless devices. However, they have also presented a number of sound limitations, which will continue to be used with digital I&C upgrades in existing plants and rolled over to design advanced plants unless a different strategy is taken. Among the advantages of exclusions zones are:

- They are directly controlled by each individual plant.
- They can be customized to the specific needs and conditions in each plant or area of a plant.
- Exclusion zones do not require specialized training or equipment.
- They are not dependent on equipment vendors, outside labs or other external entities.
- They can focus on specific classes of equipment that are problematic.
- Exclusion zones do not increase the cost of equipment or require specialized equipment installation practices.

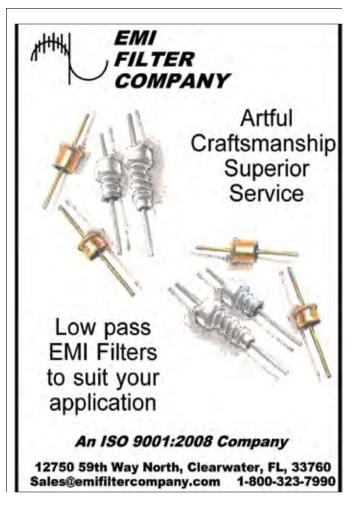
One of the very real advantages of exclusion zones is that they are directly under the control of each individual plant. A plant is not dependent on an outside entity, such an equipment vendor or test lab. If the exclusion zone fails, it is because the plant where the failure occurred did not enforce it adequately. An exclusion zone can also fail in a sense if its bounded area is too small or if its dimensions are not adequate to provide EMC protection for the expected inventory of portable wireless devices used in a specific plant. Thus, the responsibility to maintain quality

control and enforce the exclusion zone rests with the plant, which will suffer the consequences if there is a failure.

A further advantage of exclusion zones is that they can be customized for each individual plant or for specific areas in a plant. For example, if a plant has one area in which the equipment is highly immune to interference, it may not need an exclusion zone in that area at all. However, another plant, using different equipment that is more interference susceptible may require a significant level of protection for a corresponding area. Also, a plant may adjust exclusion zones from time to time, such as relaxing them during maintenance activities, when an area is off-line, or when an I&C system is upgraded to a system thought to be more immune to electromagnetic energy. Exclusion zones offer a high degree of flexibility for local conditions.

Exclusion zones also do not require specialized training or equipment. RF testing is expensive and requires a high degree of expertise to do well. These factors increase the cost of testing and also increase the chance that testing may fall short of what is required. It is not uncommon for testing to be performed with inadequate equipment, by a non-accredited test lab or by personnel who are not appropriately trained and experienced. The use of exclusion zones avoids these issues.

Another advantage of exclusion zones is also an im-



portant weakness. If only portable transceivers, especially walkie-talkies are the problem, then an exclusion zone can keep those devices away from I&C systems. This avoids requiring I&C systems take on the cost and complexity of providing significantly higher levels of immunity. If walkie-talkies are the problem, then keeping them away is an effective and efficient solution. How this becomes a weakness will be discussed later, under the disadvantages.

Exclusion zones also have the advantage that they do not increase equipment or installation costs. Requiring levels of RF immunity beyond what vendors are accustomed to will inevitably raise the price of the equipment. The typical pattern is that when vendors are required to meet new requirements they apply quick but inefficient solutions like add-on filtering and shielding not specifically designed for that equipment. Typically, they resort to expensive shielding and filtering. One reason for this is that they seldom have the expertise on staff to develop alternative solutions. It also occurs because they want to avoid the cost of equipment redesign and find a solution that simply protects their existing and typically vulnerable circuitry or equipment.

Over time vendors usually learn how to design equipment that has inherent RF immunity. This kind of solution typically adds little or even no cost to the equipment, but requires considerably more design expertise. This requisite expertise on their staff and are driven to provide immunity and lower prices by competitive pressures. Design changes may also be introduced to enhance EMC protection after the vendor is made aware of an EMI problem, especially one that ended up costing them money back to the customer. The result is that in the long run requiring higher levels of RF immunity does not inherently raise the cost of the equipment much, but in the short term it typically does. These advantages of exclusion zones are significant and

approach is usually introduced as vendors acquire the

explain why this strategy was adopted in earlier versions of EPRI TR-102323. It must also be noted that exclusion zones are very amenable to use in a hybrid strategy. Indeed, the EPRI TR-102323 report does not rely exclusively on exclusion zones, but recommends them as part of a EMI control strategy that includes testing for emissions and immunity. From this viewpoint, the question is not whether exclusion zones should be used or not, but rather is their use, coordinated with other components of a total control strategy optimal for the current and future EM environment that plants will operate in.

The disadvantages of exclusions zones are also significant and well understood by those who are responsible for implementing and enforcing them. These include:

- It can be difficult or even impossible to implement exclusion zones.
- Enforcement of exclusions zones is increasingly difficult and even impossible.
- They are the direct responsibility of each individual plant costing time and resources.
- Exclusions zones can take on different shapes and areas even across plants that use similar designs; there are enough differences in exclusions zones across these plants to create enough differences in the design and implementation of system-wide policies designed to limit the use of wireless transmission devices.
- Exclusion zones often come in conflict with the legitimate need to use wireless enabled technologies to perform necessary job functions.
- Exclusion zones are a product of oversimplifying the problem and as a result are a flawed solution.
- Exclusion zones must use general rules that are often overly conservative.
- Exclusion zones often cannot be fully implemented around I&C systems because of physical barriers (e.g., rails, steps, other equipment) in the way.
- Exclusion zones can extend into areas that must remain clear and walk way areas that must support the heavy traffic of plant personnel.
- Exclusion zones are designed to protect I&C equipment from EM energy emanating from a known inventory of wireless transmission devices (typically portable walkie-talkies). Plants strive to control the use of wireless transmission devices, especially cell phones, owned by contractors and visitors. If these devices are allowed in a plant, then specific exclusion zones may not

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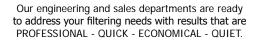
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adequately protect I&C equipment.

Exclusion zones can be difficult or even impossible to implement. They require control of a substantial area around sensitive equipment. However, at times the required protection area is difficult or impossible to control. An example is an I&C system installed near a wall adjacent to an area where it is permissible to use wireless transmission devices, or an external wall, adjoining a parking lot. What radios will be in vehicles entering the parking lot is difficult to control, if it is possible to control them at all with any certainty. Especially when the required protection distance grows to be 3 to 10 meters, it expands beyond the typical room and takes in a significant area. Some exclusion zones take up a very large area of plant floor.

The explosive growth in the use of wireless makes enforcement of exclusion zones increasingly problematic. Wireless devices are now incorporating intelligent decision-making technologies and code making more effective use of unused spectrum. The cell phone illustrated in Figure 3 is an example. Wireless is used in a wider and wider variety of products and applications. It is increasingly difficult to even identify what is a wireless device. Even medical implants are including wireless transceivers, albeit to date those are operating at lower power. How do you enforce an exclusion zone if the transceiver is in an implant inside the body of a plant worker?

When exclusion zones are used, every plant must assign personnel and expend time and effort to implement and enforce them. When a plant elects to use a new wireless technology capable of reaching power levels higher than technologies previously used, new calculations must be made to determine the layout of new exclusion zones. It is not one zone that must be revised but many. (Why should plant personnel strive to keep exclusion zones updated when other more effective strategies can be applied?) This is an ongoing cost, using resources that typically are needed elsewhere. Further, enforcement of exclusion zones is an ongoing responsibility that has potentially significant consequences if there is ever a failure. Enforcement must be ongoing and vigilant to assure that there is never a failure. Assuring such continued vigilance typically requires overly conservative and redundant monitoring to assure continual and effective compliance.

Another problem with exclusion zones is that they regularly create conflicts between the need to protect sensitive I&C systems and the need to use wireless services. The increasing use of wireless for an ever expanding variety of purposes promises to make this kind of problem increasingly common. A worker uses and comes to rely on wireless tools to perform their job but then is told he or she cannot use the tools that have become necessary for their job in the exclusion zone, where they may be required to go to perform maintenance, maintain security or some other job function. These kinds of conflicts occur and create what appear to many as rules without reason.

These kinds of conflicts are exacerbated because exclusions zones must be implemented as general rules, without regard for the differences in wireless services. If, for example cell phones are discovered to cause an EMI problem in a nuclear plant then all cell phones, in all frequency bands and at all power levels must be excluded. However, personnel will often discover that their cell phone creates no interference, making the exclusion zone seem arbitrary and needless. This may lead some plants to issue 'blanket approval' for the use of all cell phones—a strategy that presents undefined risks to the operation of I&C equipment.

The fact is that originally cell phones operated in the 800 MHz band, using RF power of up to two (2) watts. Today, most cell phones still use the 800 MHz band but are also equipped to operate in the 1,900 MHz band, where the maximum power is one (1) watt. Further, the 700 MHz band frequencies have already been auctioned, although equipment has not been deployed there yet. The Advanced Wireless Services (AWS) band is scheduled to be auctioned, adding frequencies up to 2,100 MHz. Other mobile services are moving forward in the 2,300 MHz and 3,500 MHz bands. The future will see an increasing variety of mobile services, using different frequencies and power levels. Exclusion zones must treat them all equally, not only because most people cannot tell one device from another, but increasingly devices can operate on multiple bands and which band they use is determined dynamically by the network.



A further complication is that cell phones and many other wireless services use very aggressive power control. They only use as much RF power as is necessary to sustain their communications link. Cell phones will vary their RF power by up to 15 dB, a factor of more than 30. The same cell phone in one location, where it has good signal conditions to the network, will operate at \%0th the power as the same cell phone in another location with poor signal conditions. Exclusion zones must assume the worst and control these devices as if they are operating at maximum power. Indeed, the plant has no control over how much RF power they will use, and it is changing dynamically. So, how is the plant supposed to know if a cell phone provider changes the operation of its network? This could result in changing how the RF power levels are managed. The only option with the exclusion zone strategy is then to be conservative in order to assure the required level of protection.

The use of exclusion zones in existing nuclear plants comes from an analysis that finds portable transceivers, particularly walkie-talkies, to be the only EM threat, so simply keeping them away from I&C systems is an effective and efficient solution. But are portable transceivers the only problem? More specifically are portable transceivers a significantly worse source of EM fields than other sources? If they are, then exclusion zones are an effective remedy.

However, there are many sources of EM fields, both natural and man-made. Can a relatively low level of immunity in I&C systems provide adequate protection against most sources and then by using exclusion zones the more powerful fields from portable transceivers are effectively dealt with? In fact, exclusion zones only give the delusion of protection.

In particular, there are low-frequency, high-impact events that present a rare but important risk category. Two examples of low-frequency events that produce very high levels of EM are Electromagnetic Pulse (EMP) and terroristic use of EM fields. While these events are rare, they are real risks. If they do occur, should nuclear plants be protected against them? Having I&C systems with sufficient immunity to protect against portable transceivers also will increase their ability to withstand EM fields coming from other sources.

#### IN GENERAL PLANT ENVIRONMENTS

Exclusion zones have been used as an EMC control measure in a variety of plant environments, even those outside of the nuclear power industry. It can be an effective method for controlling EMI. A critical element in the use of an exclusion zone is the degree to which the zone can be controlled. The more reliably an environment can be controlled, the higher the effectiveness of the exclusion zone strategy. As the ability to control the environment is compromised, the effectiveness of the exclusion zone strategy also degrades. So, a fundamental requirement for an exclusion zone strategy to be effective is the ability to

control the environment around sensitive equipment. The exclusion zone strategy is not recommended when the area around sensitive equipment cannot be reliably controlled.

Two specific times of plant operation when exclusion zones collapse are when the plant is under unscheduled shutdown and when the plant is under scheduled shutdown. Under unscheduled shutdown, the number one goal of every single plant personnel is to work towards getting the problem resolved and the plant back online. When power is not being generated, money is lost and lots of it. Plant workers simply work without interruption and barriers to aid in getting the plant up and running again. During this time, extremely heavy radio usage takes place. However, not all systems are fully offline. This is absolutely the case in nuclear power plants. Thus, a good number of I&C systems will need to remain online to preserve certain safety functions. Some of these systems may employ the use of exclusion zones.

Under scheduled shutdown, the plant and its personnel are given a fixed number of days to perform the scheduled work (typically refueling). Plant personnel are rewarded for getting the work done and the plant back online early. During this time, certain I&C systems must be functional in order to get the work done correctly and on time. Some of these systems may employ the use of exclusion zones.

The exclusion zone strategy also comes under pressure when competing legitimate interests come into conflict. For the purposes of EMC, an exclusion zone might be desirable. However, there might be very legitimate reasons why wireless equipment should be brought into close proximity to equipment inside an exclusion zone. Maintenance personnel are more effective if they can use their cell phones or walkie-talkies to verify equipment functionality or get needed technical support from another plant engineer. Many exclusion zones are so large that troubleshooting some I&C systems requires the use of three personnel: one at the system cabinet to observe indicators and make measurements, one in the middle of the exclusion zone acting as a 'repeater' to deliver the message to personnel outside the exclusion zone so the information can be radioed to personnel in the control room or another area of the plant. Other examples are created when space is limited and different equipment must be put into close proximity, due to its functionality. There are a wide variety of reasons that can arise and put pressure on the use of exclusion zones.

A simple reason exclusion zones are problematic is that real estate inside a plant is in high demand and is generally expensive. Having a lot of unused space in any environment is generally inefficient. Spreading equipment out requires more building space, costing money. Often, the space simply is not available. However, even when space is available, it comes at a cost, usually a high cost. Mapping out an exclusion zone for a specific I&C system may permanently mark that area as unusable for any other function.

For these reasons, the use of exclusion zones is increas-

ingly rejected. Planners engaging in digital upgrades in existing plants and in specifying digital equipment for advanced nuclear plants do not want to see exclusion zones in their plants. Other methods of EMC control are found more effective. Shielding, filtering or improved immunity, but implemented at the right level, are increasingly the preferred methods for EMC control.

#### IN ADVANCED NUCLEAR PLANT **ENVIRONMENTS**

The disadvantages of exclusion zones become increasingly relevant when considering the environments of advanced nuclear power plants. Looking to the future, the use of wireless for communications, data transmission and sensor networks is a growing reality. The ability to exclude these services from areas were I&C systems operate is not only increasingly problematic but also undesirable. Indeed, some I&C systems will greatly benefit from wireless connectivity, for example, to distributed sensor networks. The ability to enforce an exclusion zone will be a growing problem as wireless is integrated into an ever increasing variety of equipment types. Therefore, a different method for providing the required level of protection is required.

#### CONCLUSION

This article, Part 1 of 2 on the topic of exclusion zones and their strategies in nuclear power plants, presented a history of the development and use of exclusion zones originally defined by EPRI research in the area of EMC for nuclear power plants. Early strategies served their purpose in a time when wireless devices were few. Moving towards a more effective strategy for protecting digital I&C equipment from radiated threats in plant environments requires an understanding of the advantages and disadvantages of exclusions zones as presented in this article. Effective and dynamic protection of digital I&C equipment against radiated threats must be an inherent part of I&C systems allowing plant engineers to focus on plant safety, operation, maintenance, and upgrades without the challenges presented by the use of exclusion zones. Nuclear power plants are facing more challenges, and those that can be resolved providing a higher degree of safety and reduced risk will help utilities maintain safe plants that are profitable. Part 2 of this article will address Elements of the Exclusion Zone Strategy with a focus on peeling back the layers of immunity for I&C systems to establish whole-system immunity.

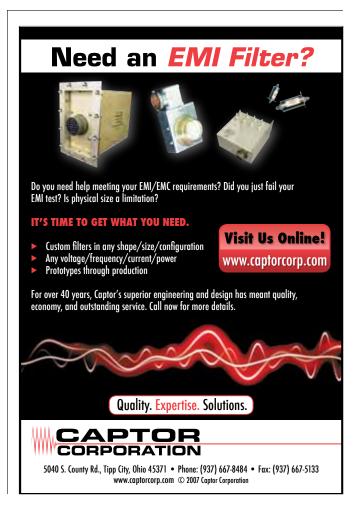
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PHILIP F. KEEBLER manages the Lighting and Electromagnetic Compatibility (EMC) Group at EPRI where EMC site surveys are conducted, end-use devices are tested for EMC, EMC audits are conducted and EMI solutions are identified. Keebler has conducted System Compatibility research on personal computers, lighting, medical equipment, and Internet data center equipment. The lighting tasks were associated with characterizing electronic fluorescent and magnetic HID ballasts, electronic fluorescent and HID ballast interference, electronic fluorescent and HID ballast failures, and electronic fluorescent and HID lamp failures. Keebler has drafted test protocols and performance criteria for SCRP tasks relating to PQ and EMC. He served as editor developing a new EMC standard for power line filters, IEEE 1560.

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## Simple Method for Predicting a Cable Shielding Factor, **Based on Transfer Impedance**

#### MICHEL MARDIGUIAN

**EMC Consultant** St. Remy les Chevreuse, France

or a shielded cable, an approximate relationship valid from few kHz up to the first cable resonance can be derived from its Transfer Impedance (Zt ) allowing to predict the cable shielding factor. This Cable Shielding factor, as a figure of merit, is often preferred by engineers dealing with product specifications and early design. Being not necessarily EMC specialists, they can relate it directly to the overall shielding performance required for a system boxes or cabinets.

This article comes up with very simple, practical formulas, that directly express the cable shielding factor Kr, given its Zt and frequency.

#### INTRODUCTION

Expressing the effectiveness of a cable shield has been a recurrent concern among the EMC Community, and more generally for the whole Electronic industry. This comes from a legitimate need to predict, measure, compare and improve the efficiency for a wide variety of shielded cables like coaxial cables or shielded pairs and bundles, having themselves various types of screens: braids, foils, spiral, corrugated, woven etc.

However, when it comes to decide what would be a convenient, trustworthy characteristic for a cable shield, several

methods are in competition: Shielding Effectiveness (SE,dB), Surface Transfer ( Zt, Ohm/m) or Screen Reduction Factor (Kr, dB).

Although Transfer Impedance Zt is a widely used and dependable parameter, SE or Reduction Factor Kr as a figure of merit are often preferred by engineers dealing with product specifications and overall design, because they can relate it directly to the whole shielding performance required for the system. It would be a nonsense to require 60dB of shielding for a system boxes or cabinets if the associated cables and their connecting hardware provide only 30dB, and vice-versa.

a) Shielding Effectiveness, as defined for any shielding barrier is given by:

SE (dB) = 20 log [E (or H) without]shield] / [ E ( or H) with shield]

By illuminating the tested sample with a strong electromagnetic field, this approach is coherent with Shielding Effectiveness definition for a box, a cabinet or any enclosure, with SE being a dimensionless number. Since it would be unpractical to access the remaining E (or H) field inside a cable shield, meaning between the sheath and the core, it is the effect of this incident field that is measured instead, for instance the core-to-shield voltage.

However, there are several drawbacks to this method:

It requires a full range of expensive instrumentation: generator, power



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- amplifier, antennas, shielded/ anechoic room (or stirred mode reverberating chamber) etc ...
- It carries the typical uncertainties of radiated measurements (mean value for ordinary radiated EMI test uncertainty being 6dB)
- It is very sensitive to the tested cable set-up: height above ground, termination loads and type of excitation in near field conditions. For instance, a transmit antenna at 1m from the test sample will create near field conditions for all frequencies below 50MHz. If the antenna is of the dipole family, the near-field will be predominantly Electrical, i.e. a high-impedance field and the SE results will look excellent. If the transmit antenna is a magnetic loop, the field will be a low-impedance H field, and the SE results will be much less impressive.
- b) Transfer Impedance (Zt), in contrast to SE, is a purely conducted measurement method, with accurate results, typically within 10% (1dB) uncertainty. But Zt, being in Ohm/meter has a dimension and cannot be directly figured as a shield performance.
- c) Shield Reduction Factor, Kr reconciles the two methods, by using the best of Zt - the benefit of a conducted measurement, and of SE: the commodity of a direct figure in dB.



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#### **DEFINITION OF THE SHIELD REDUCTION FACTOR**

We can define Shield Reduction factor (Kr) as the ratio of the Differential Mode Voltage (Vd) appearing, core-to shield at the receiving end of the cable, to the Common Mode Voltage (Vcm) applied in series into the loop (Fig-

$$Kr (dB) = 20 \log (Vd / Vcm)$$
 (1)

This figure could also be regarded as the Mode Conversion Ratio between the external circuit (the loop) and the internal one (the core-to-shield line).

Slightly different versions of this definition are sometimes used like:

 $Kr (dB) = 20 Log (Vd_2 / Vd_1)$ Where,

Vd, : differential voltage at the receive end when the shield is not there (disconnected)

Vd<sub>2</sub>: differential voltage at the receive end with the shield normally grounded, both ends.

This latter definition would be more rigorous, somewhat reminiscent of the Insertion Loss used in EMC terminology, i.e. it compares what one would get without and with the shield, for a same excitation voltage ( see Fig. 1, B). This eliminates the contribution of the core wire resistance and self-inductance, since they influence identically Vd, and Vd<sub>2</sub>.

#### CALCULATED VALUES OF Kr FOR SIMPLE CASES, FOR LENGTH $l < \lambda/2$

Let express Vd, using the classical Zt model, assuming that the near end of the cable is shorted (core -to-shield):

$$Vd = Zt \times l \times I_{shield}$$

where l: length of the shielded cable

Expressing the shield current, I<sub>shield</sub>:

$$I_{\text{shield}} = Vcm / Z_{\text{loop}}$$

We can replace Vd by its value in the expression of Kr:

$$K_r = \frac{Zt \ l.(Vcm \ / \ Z_{loop})}{Vcm}$$

$$Kr = Zt.l / Z_{loop}$$

 $Kr = Zt.l \ / \ Z_{loop}$   $Z_{loop}$  itself is a length-dependent term, since it is simply the impedance of the shield-to-ground loop, which for any decent shield is a lesser value than that of the core wire plus the terminal impedances.

$$Z_{loop}(\Omega) = (R_{sh} + j\omega. L_{ext}) . l$$

where.

 $R_{sh}$  = shield resistance

 $L_{ext}$  = self-inductance of the shield-to-

ground loop

Replacing  $Z_{loop}$  by its expression:

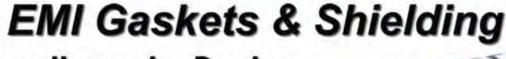
$$K_r = \frac{Zt.l}{R_{sh} + j\omega L_{syt}}$$

Zt (Fig. 2) consists in shield resistance R<sub>sh</sub> and shield transfer (or leakage) inductance Lt.

Thus, we reach an expression for Kr as a dimensionless



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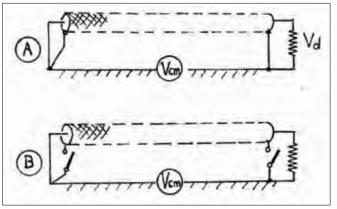


Figure 1. Conceptual view of the shield Reduction Factor (Kr), with two variations of the measurement set-up. In (B), the measurement compares the voltage measured at the termination with, and without the shield connected.

number, independent of the cable length:

$$K_{r} = \frac{(R_{sh} + j\omega Lt).l}{(R_{sh} + j\omega L_{ext})l}$$

$$K_r = \frac{R_{sh} + j\omega Lt}{R_{sh} + j\omega L_{ext}}$$
(2)



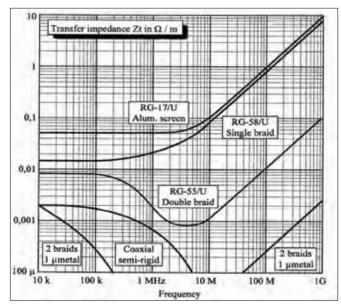


Figure 2. Some typical values of Zt for several shielded cables.

This expression is interesting in that it reveals three basic frequency domains:

a) for Very Low Freq., where the term  $\omega$ Lt is negligible, Zt is dominated by  $R_{sh}$ :  $Kr = R_{sh} / (R_{sh} + j\omega. L_{ext})$   $\approx 1$  (0dB) below few kHz, since the lower term, loop

$$Kr = R_{sh} / (R_{sh} + j\omega. L_{ext})$$

impedance reduces to Rs<sub>ch</sub>

b) at medium frequencies (typically above 5-10kHz for ordinary braided shield):

$$Kr = (R_{sh} + j\omega. Lt) / (j\omega. L_{ext})$$

Reduction Factor improves linearly with frequency

c) at higher frequencies (typically above one MHz), up to first  $< \lambda/2$  resonance:

$$Kr = Lt / L_{ext}$$

The Reduction Factor stays constant, independent of length and frequency.

A quick, handy formula can be derived, which is valid for any frequency from 10kHz up to first  $< \lambda/2$  resonance:

$$Kr(dB) = -20 Log [1 + (6. FMHz/Zt(\Omega/m))]$$
 (3)

The value for Zt being that taken at the frequency of concern.

(\*) Several formulas have been proposed in the past for expressing a cable shield effectiveness based on its Zt. An often mentioned quick-rule is: Kr (or SE) dB = 40 - 20 Log ( Zt. l). Although it are correct above the ohmic region of Zt, it can give widely optimistic results, like 50dB or 70dB at 50/60Hz where an ordinary shield has no effect at all against Common Mode induced Interference.

#### CALCULATION OF Kr WHEN LENGTH IS APPROACHING OR EXCEEDING λ/2

When the dimension of the cable reaches a half-wave length, one cannot keep multiplying  $Zt(\Omega/m)$  by a physical length which is no longer carrying a uniform current. In fact, the "electrically short line" assumption becomes progressively less and less acceptable when cable length "l" exceeds  $\lambda/10$ .



## A Seamless EMI & RF Solution For Cumbersome Cables



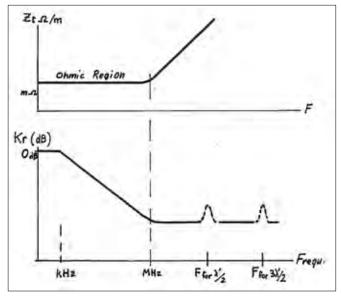


Figure 3. Conceptual view of the Kr behavior above resonance. Even with a good quality shield, the periodic shield current humps at odd multiples  $\lambda'/2$  account for a typical 10dB deterioration of Kr

With the cable being exposed to a uniform electromagnetic field or to an evenly distributed ground shift, a typical case with CM interference, the shield grounded

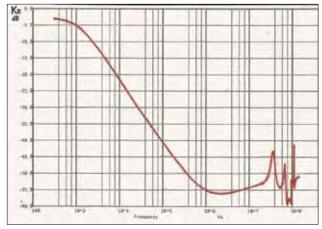


Figure 4. Calculated results for a 5m long single braid coaxial. First λ'/2 resonance is reached around 20MHz.

both ends behaves as a dipole exhibiting self-resonance and anti-resonance for every odd and even multiple of  $\lambda/2$ , respectively. Accordingly, current peaks will take place periodically for every odd multiple of  $\lambda/2$ , resulting in a worst-case value of Kr.

\*Some tests set-up for measuring Kr are based on end-driving of the cable shield by a  $50\Omega$  generator, which introduces also  $\lambda/4$  resonances. A quick discussion on this artefact is presented



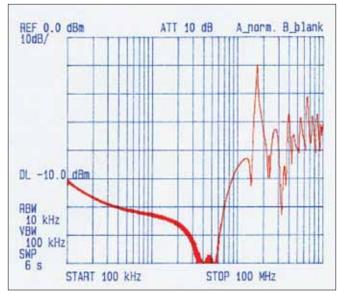


Figure 5. Kr for a 5m coaxial, shield grounded with 10cm pigtail (courtesy of AEMC Grenoble, France ).

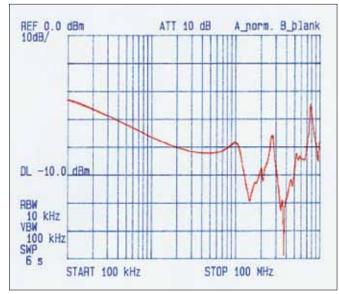


Figure 6. Kr for 5m shielded computer cable, with good quality SubD25 shielded connector (courtesy AEMC Grenoble, France)

in Appendix.

One must also take into account C', the actual propagation speed in the cable-to-ground transmission line, where C' is slower than the ideal free-space velocity C. Typically C' = 0.7 to 0.8 C. Therefore, the actual wavelength in the cable to ground loop is:

 $\lambda' = 0.7$  to  $0.8 \times \lambda$ 

If we align our calculations to the most detrimental conditions, the worst is reached (Figure 3) at the first



 $\lambda'/2$  where the received voltage Vd is maximum (due to a current peak) resulting in a low value for Kr. This is translating correctly the actual situation where, for a uniform field exposure, the victim receiver circuit will see a higher interference.

Beyond this first resonance point, for a constant CM excitation, the termination voltage Vd will run through a succession of peaks ( at odd multiples of  $\chi'/2$ ) and nulls. Yet, the amplitude of the peaks will not exceed that reached at first resonance.

Simply considering that the length of "electrically active" shield segment is limited to  $\lambda'/2$ ,  $Vd_{max}$  can be predicted as follows:

$$Vd_{max} = Zt (\Omega/m) \times 0.5 \lambda' \times I_{shield}$$
 (4) where,

Zt = transfer impedance at frequency of concern corresponding to  $\lambda$ '. At such frequency, Zt is dominated by Lt, the shield transfer inductance

 $\lambda'$ = corrected wavelength for propagation speed C'  $\approx$ 0.7 to  $0.8 \lambda$ 

 $\lambda' = 0.75 \cdot 300.10^6 / F(Hz) = 220.10^6 / F(Hz)$  (average value)

(Eq .4) for Vd (max) can be rewritten as:

$$Vd_{max}$$
 = Lt.  $\omega$  . 0.5 . (  $220.10^6$  /  $F$  ) x  $I_{sh}$ 

= Lt( H/m). 
$$2\pi$$
 . F. 0.5 . (  $220.10^6$  / F ) x I<sub>sh</sub>)

Frequency cancels-out in the equation, so reducing

all the variables and using more practical units like Lt in nH/m:

$$Vd_{max} \approx Lt (nH/m) \times 0.7 \times I_{sh}$$
 (5)

We can furthermore express  $I_{sh}$  max for a shield grounded both ends illuminated by a uniform field (typical EMI susceptibility scenario):

$$I_{sh (max)} = I_{loop (max)} = Vcm_{max} / Zc$$
 where,

Zc = characteristic impedance of cable-above-ground transmission line

=  $150\Omega$  for a height/diam ratio = 4 (typical of MIL-STD 461 test set-up)

=  $300\Omega$  for a height/diam ratio = 50

Thus, Zc can be given an average value of  $210\Omega$  ( a + /- 3dB approximation)

Combining Eq. 4 and 5 we get a simple expression for worst case Kr above resonance:

Kr (min) = Vd max / Vcm

= (0.7 Lt. Vcm / 210) / Vcm

Kr min (dB) = -20 Log [210 / 0.7 Lt(nH/m)]

 $Kr \min (dB) = -20 \text{ Log} [300 / \text{Lt}(nH/m)]$ (6)

#### A FEW PRACTICAL RESULTS FOR Kr, BELOW AND ABOVE FIRST CABLE RESONANCE

The following figures show some calculations using the formulas of this article, and test results.



Figure 4 shows calculated results on a 5m long good quality single braid coaxial cable, 1 meter above ground, with perfect 360° contact at connector backshell. On Figure 5, the curve shows the test results of a 5m coaxial cable where the shield has been is intentionally spoiled by a 10cm pigtail. The deterioration of Kr above 8 MHz is spectacular.

#### **APPENDIX**

We have seen that when dimension of the cable approaches, or exceeds a halfwave length, the current on the shield follows a sinusoidal distribution with alternating phase reversals every  $\lambda/2$ segment. This is complicated by the fact that, if the test set-up is based on a  $50\Omega$ generator driving one end of the shield, this latter appears as a transmission line shorted at the other end, subject to standing waves. This mismatch causes nulls and peaks of current at every multiple of  $\lambda/4$ .

For the odd multiples like  $\lambda/4$ , 3

 $\lambda/4$ ,  $5\lambda/4$  ... etc., the null of current correspond to the generator seeing an infinite impedance. While the driving voltage is equal to the open-circuit value, the current minimum on the shield is causing a drop in the terminal voltage Vd, therefore the value of Kr artificially jumps to higher values. This effect is visible on the figures, where Kr appears periodically better, then worse, than its average values. In the present paper, we have preferred to align the calculations on the worst case situation, not the most favorable one.

MICHEL MARDIGUIAN, IEEE Senior Member, graduated electrical engineer BSEE, MSEE, born in Paris, 1941. While working at IBM in France, he started his EMC career in 1974 as the local IBM EMC specialist, having close ties with his US counterparts at IBM/Kingston, USA. From 1976 to 80, he was also the French delegate to the CISPR Working Group, participating to what became CISPR 22, the root document for FCC 15-J and European EN55022. In 1980, he joined Don White Consultants (later re-named

ICT) in Gainesville, Virginia, becoming Director of Training, then VP Engineering. He developed the market of EMC seminars, teaching himself more than 160 classes in the US and worldwide. Established since 1990 as a private consultant in France, teaching EMI / RFI / ESD classes and working on consulting tasks from EMC design to firefighting. One top involvement has been the EMC of the Channel Tunnel, with his British colleagues of Interference Technology International. He has authored eight widely sold handbooks, two books co-authored with Don White and 28 papers presented at IEEE and Zurich EMC Symposia, and various conferences. He is also a semi-professional musician, bandleader of the CLARINET CONNECTION Jazz Group. Contact Mardiguian at m.mardiguian@orange.fr

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## **Protecting Security Systems** in a Healthcare Facility from Lightning **Induced Transients**

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healthcare facility is a multifunctional building or campus that provides health care to citizens and when designated, also provides protection to the population in times of crisis. This includes common functions associated with patient care (e.g. operating rooms, emergency rooms, recovery rooms, etc), but also areas for educational centers, exercise facilities, food service, and other non-patient care activities. Significant amounts of advanced information technology for patient records and accounting functions, laboratories, various imaging systems, (e.g. magnetic resonance imaging (MRI), ultrasounds, xray, computerized axial tomography, etc), and security systems are used to meet the mission of a healthcare organization.

Protecting the healthcare facility from environmental conditions is important for service continuity. Lightning is an environmental condition that can cause damage to the facility, the equipment, and rare cases, people. Because of the criticality of the healthcare facility and the risks associated with a lightning protection system (LPS) is required for most U.S. healthcare facilities.

Equipotential bonding is the fundamental principle concept within a LPS.

All components of the facility, including the LPS, the electrical system, the mechanical structure of the facility, and all external components and structures should be effectively bonded to provide a level of immunity from lightning induced transients [1,2,3]. External components include roof top mounted equipment (e.g. HVAC exchangers, communication receivers, etc), and ground level equipment (e.g. security components, parking lights, automatic gates, etc). External structures include remote power stations, remote MRI facilities, and remote security and parking offices.

When a LPS is installed, surge protective devices (SPDs) are required at the service entrance for the electrical distribution system and all communication systems [3]. SPDs are recommended to be deployed throughout the facility in a staged approach [4]. SPDs deployed in a staged or cascade approach have a SPD installed at the service entrance location. SPDs installed at distribution or branch locations, and SPDs installed at point of use equipment. SPDs should be sized in accordance with their location within the lightning protection zone (LPZ) (Figure 1) [1].

#### **HEALTHCARE POWER SYSTEM**

The electrical distribution system of a healthcare facility is complex. It is comprised of at least two power sources, power control devices, and separate infrastructure equipment (Figure 2). Normal power is typically provided by the local utility while emergency power is provided by on-

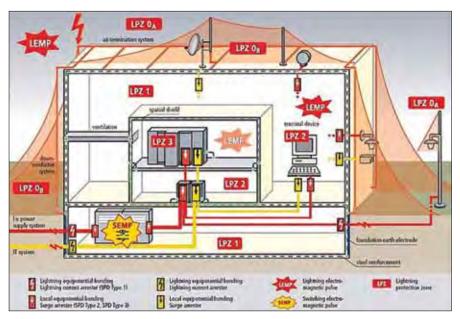


Figure 1. Lightning protection zone concept [1].

site generators [2]. Within the healthcare facility, electrical power is divided between the essential electrical system and the non-essential electrical system. The essential electrical system comprises the equipment system, the life safety branch and the critical branch of the emergency system, and is intended only for those systems intended for life safety [2]. This includes the equipment needed for emergency egress, which includes the security system.

Electrical power provided to the security system is required to be connected to the equipment branch of the essential electrical system in a healthcare facility [2]. When a LPS is installed, SPDs are required to provide protection to the electrical system and critical processes in a staged approach. (Figure 2, Item 1) [4,5]. When the generators are located outside, additional SPDs are needed to provide protection (Figure 2, Item 2) [5]. The cascading of SPDs throughout the facility provides a complete and effective approach to reducing transient overvoltages from affecting equipment and processes.

#### **HEALTHCARE SECURITY SYSTEM**

A security system for healthcare facilities can consist of numerous cameras and other detection and monitoring devices (Figure 3). Security systems require operation specific cameras, recording devices, uninterruptable power supplies (UPS) for back-up power, precision HVAC equipment, and SPDs.

The preferred method of recording devices uses stand alone digital video recorders (DVRs). DVRs are commonly provided in rackmount enclosures for ease of connection, ability to maintain required environmental conditions, and overall security. Monitors are provided remotely within the security center.

Connection of cameras to the security center's DVR(s) can be accomplished by a wired or wireless infrastructure. While the wireless infrastructure is advancing, it is still hindered by the inability of wireless frequencies to penetrate reinforced structures of a healthcare facility. The preferred connection for security systems is the wired infrastructure, with a growing popularity towards Category 5e and Category 6 infrastructures.

Point of use protection should be provided within the environmental controlled rackmount system. Using a rackmount SPD topology can provide convenient installation of surge protection that will protect the DVR, the environmental system, and any accompanying Ethernet communication systems. Using rackmount topology for Ethernet protection is advisable over discrete devices as it provides easy installation and ensures that all grounds for remote cameras

and other devices are bonded together.

#### POWERING AND PROTECTING REMOTE CAMERAS

All security cameras require power and communication





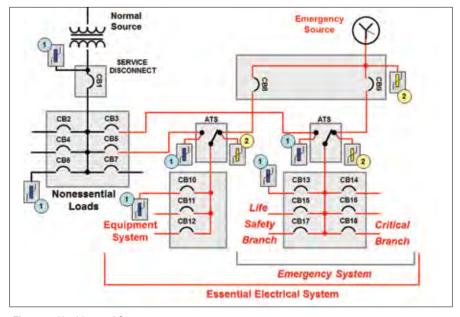


Figure 2. Healthcare AC power system.

circuitry to communicate to the security office. Powering a security camera is achieved with 12 VDC or 24 VDC from an external power supply. The external power supply of security cameras are typically hardwired to the electrical distribution panel as they are more tamper resistant than connecting to NEMA 5-15R receptacles. Video transmission to the security central office and control of the pan, tilt, zoom (PTZ) functions of the camera are accomplished through Ethernet communications.

Protection from lightning induced transients is required on the Ethernet and AC power lines (Figure 5). Security cameras installed in outdoor LPZ0 or indoor LPZ1 environments requires the same level of protection as those installed at the service entrance locations [1]. For AC power SPDs the minimum required surge current handling capability is 20 kA of 8/20 µs current per mode [3]. Ethernet communication SPDs are required to have a minimum surge current handling capability is 10 kA of 8/20 µs current per mode [3]. Security cameras installed in indoor applications also need SPDs for protection, but the current handling capability is less demanding.

Protection of the Ethernet sys-

tem can be troublesome if two basic fundamental rules are not followed. First, SPDs are required to attenuate lightning induced transients and allow Ethernet signals to pass without attenuation. Effective lightning transient mitigation for Ethernet systems is best achieved through using hybrid model that incorporates components that are capable of diverting highenergy transients, and components that capable of attenuating or diverting low-energy transients (Figure 6).

Gas discharge tubes (GDT) are effective components for reducing high-energy transients. Additional attenuation of lightning induced transients is achieved by thyristors (CR). When properly designed, positive temperature coefficient (PTC) resistors provide effective isolation between the GDT and the thyristor thereby allowing devices with differing specifications to work in conjunction with each other. PTC resistors are also effective at minimizing transient currents that may be caused by differing ground potentials between the central security office equipment and security cameras. Additional components may be required to ensure that Ethernet signals are not attenuated.

Secondly, if a shielded Ethernet cable is provided, the shield should not connect solidly to ground at the

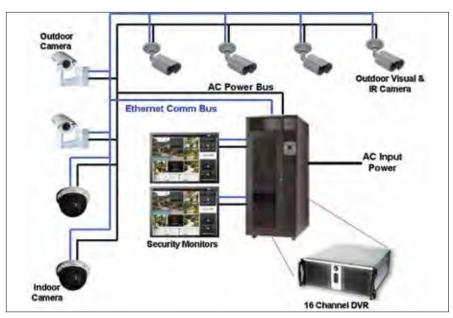


Figure 3. Overview of a security system.

DVR (source) and the security camera (load). To eliminate circulating ground currents, a solid connection to ground should occur at the DVR, but be isolated at the security camera [6]. The shield of the Ethernet cable can be connected to a ground connection at the security camera if is achieved through a high-frequency connection (Figure 6). A high-frequency

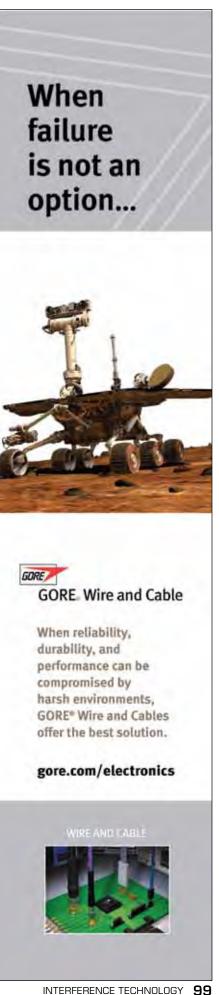
connection of the shield to ground is accomplished by either a discrete capacitor (C), through the parasitic capacitance of a GDT, or other components.

#### CONCLUSION

Advanced technology continues to be deployed throughout the healthcare system to meet various newly



Figure 4. Rackmounted SPDs.



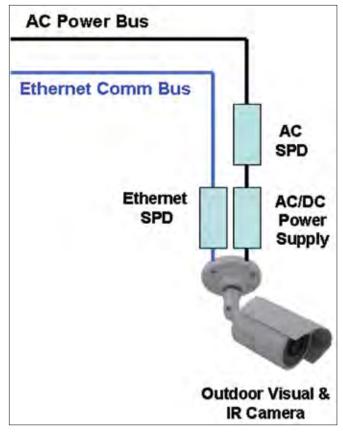


Figure 5. SPD connection at camera.

imposed regulations. Advanced technology is not only used to improve patient outcomes, but also to improve emergency and security systems within the healthcare facility. Security systems are included as a part of the essential electrical system and should be protected from lightning induced transients. The best protection is provided by proper bonding of the system grounds.

Whenever an LPS is installed, SPDs are also needed to provide effective protection against lightning. AC Power

SPDs should be installed on the electrical distribution system, and point of use locations. For security systems, AC Power SPDs should be installed on the incoming AC power of the environmentally controlled rackmount system located in the security office. Ethernet SPDs should be installed on all conductors prior entering/exiting the security system enclosure.

At the remote security cameras, AC Power and Ethernet SPDs should also be installed. Hardwired SPDs provide the best protection against tampering. Equipment located in LPZ0 or LPZ1 should be properly rated to provide adequate protection. Ethernet SPDs require design technologies that are capable of providing effective transient protection, but not hindering the quality of the video signals or the communication of the control system designed to move the camera or its lens: pan, tilt, zoom (PTZ) functions. If Ethernet cables with shields are used, the shield should use high-frequency grounding techniques to reduce ground loop currents.

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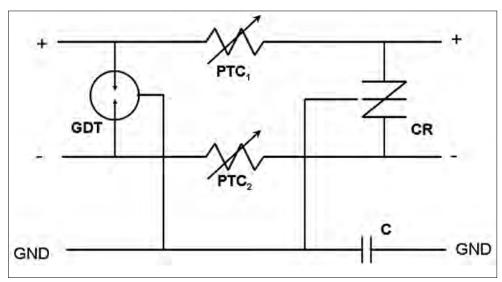


Figure 6. Communication SPDs circuitry.

## **Avionics Testing Evolution**

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any disturbance sources can affect the correct functioning and therefore the safety of an aircraft. The latest commercial airliner designs include many technological changes that have necessitated a review of avionic system test requirements.

The trend today is to move toward structures made from Carbon Fibre Reinforced Plastic (CFRP) materials that offer all the strength of previous materials but with a significant saving in weight. The last few decades have seen increasing amounts of composite material used in aircraft construction, culminating in the latest designs from Airbus (A350) and Boeing (787). The latter includes over 50% CFRP materials.

In parallel the type and amount of electrical and electronic systems used has also increased dramatically. Some of the latest systems relying on variable frequency power and electrical systems for everything from the galley coffee machine to replacing traditional hydraulic control of the flying surfaces.

The requirement RTCA DO-160 and EUROCAE ED-14 embody many of the tests to be performed on commercial aircraft. Both documents are in fact published under an agreement between the RTCA, EUROCAE and the Society of

Aerospace Engineers so that the content is identical.

All parts of DO-160 are equally important in their own right, but sections 22 and 17 are the focus for this discussion.

Section 22 discusses test requirements for indirect lightning testing of equipment mounted within an aircraft.

Latest generation aircraft require tests to the avionics equipment for which no experience existed. The responsibility is very much on the aircraft manufacturer to ensure that appropriate testing is performed. DO-160 / ED-14 remains the base for these tests, but separate standards are emerging for specific aircraft types with requirements to take account of construction, materials and amount of electronics.

### INDIRECT LIGHTNING REQUIREMENTS

DO-160 / ED-14 section 22 defines a series of waveforms that represent impulse energy entering an aircraft and being induced into cable bundles within the structure. This can occur through resistive coupling or via induced E and H fields. Based on many decades of experience, six waveforms have been defined and are applied as damage assessment (PIN Injection) with fixed test system impedances or cable and ground injection disturbance (Single Stroke, Multiple Stroke & Multiple Burst) tests.

Cable bundle and ground injection tests specify a Test level (voltage of current) that should be achieved in the cable. This

| Standard       | PIN Injection                     | Test Process                        | Cable Bundle   | Test Verification  |
|----------------|-----------------------------------|-------------------------------------|--|--|
| DO-160 / ED-14 | V <sub>oc</sub> /I <sub>sh</sub>  | System calibrated applied to EUT    | V <sub>†</sub> / I <sub>L</sub> or I <sub>†</sub> / V <sub>L</sub> | Voltage & Current Test and<br>Limit values must be<br>monitored during test process  |
| Boeing         | V <sub>OC</sub> /I <sub>BH</sub>  | System calibrated<br>applied to EUT | V <sub>T</sub> / I <sub>L</sub> only                               | I <sub>L</sub> can exceed specified value<br>to achieve V <sub>T</sub> in test cable.<br>Levels must be monitored<br>during test process |
| Airbus         | V <sub>oc</sub> / I <sub>sh</sub> | System calibrated<br>applied to EUT | V <sub>CC</sub> /I <sub>SH</sub>                                   | After calibration no monitoring<br>required  |

Table 1. Comparing test methods.

is coupled with a Limit level for either current or voltage. Waveforms are defined as having a predominately voltage form (WF2, 3, 4), current form (WF1, 3, 5A, 5B, 6) or a hybrid form (WF3). This latter can be defined in terms of either voltage or current.

There is no definition of test equipment impedance and the cable bundle impedance can have a significant influence on the test result.

To take account of changes in designs, aircraft manufacturers are basing their requirements on the principles in DO-160 but with some deviations.

#### WHAT DOES THIS MEAN FOR THE TEST **EQUIPMENT AND THE TEST ENGINEER?**

The DO-160 / ED-14 method requires constant monitoring of the impulses as the test signal is increased to the desired level. This is labour intensive and there is a risk that the cable impedance could prevent either the TEST or LIMIT level from being reached.

This situation requires a further test process and much more time. As these test types can already run for many days or even weeks, a further extension is undesirable.

Boeing test requirements set a Voltage level that should be reached in the cable, even if it means exceeding the current limit. This is still dependant on the cable impedance and may necessitate changing test equipment.

Airbus has arrived at a solution that is independent of cable impedance and in fact in line with most international impulse standards. The test system (generator, coupler and cables) is calibrated with fixed impedance as for PIN injection. After calibration, the test can be performed without monitoring impulse levels in the cable bundle.

A hybrid generator is a circuit design where the dynamic behavior is well known. The impulse waveform is specified in open circuit and again in short circuit. The advantage of this design is that independent of the load impedance (e.g. cable length, aluminium or carbon fibre structure) the test results are repeatable and comparable. A hybrid solution is the only generator design that gives comparable test results over the complete EUT load range.

#### **VOLTAGE SPIKE REQUIREMENTS**

The DO-160 / ED-14 section 17 specifies requirements for voltage spikes in an aircraft power system. There have always been voltage spikes transmitted around system cabling in aircraft. In modern times, increasing complexity of electronic systems and the advent of full computer control of platforms has meant that voltage spikes need to be addressed at a whole different level to the past. Aircraft contain many sources that can "generate" voltage spikes. The most likely source of voltage spikes are electric motors. All motors are inductors fitted in the power line. Energy is stored in the inductors magnetic field and when power is removed, is released as a spike with amplitude proportional to the inductor and therefore the motor size. In modern platforms there is a tendency to add more and more motors to automate certain functions. Aircraft have huge motors for flap and landing gear actuation. Because of the motor size, spikes can attain many times the nominal voltage level.

The phenomenon is fairly well known and many standards already exist, however, with the increasing technological challenges, existing ideas need to be challenged and revised where necessary. In particular the use of "fly-by-wire" technology requires a new level of immunity to voltage spikes to ensure aircraft safety.

#### REQUIREMENTS

DO-160 and ED-14 are identical and in section 17 address the voltage spike test requirements. The "classic" 2/10us impulse is used with a generator impedance of 50ohm to test AC and DC systems.

The latest edition of Airbus ABD0100.1.8 specifies test-

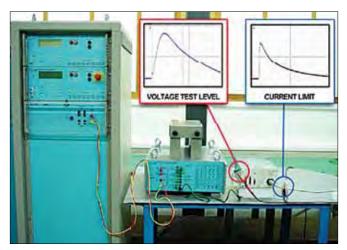


Figure 1. Indirect lightning setup.

| Standard           | Title  | Voltage Spike Test |
|--------------------|--|--------------------|
| RTCA DO160         | Environmental Conditions and Test<br>Procedures for Airborne Equipment | Section 17         |
| EUROCAE ED14       | Environmental Conditions and Test<br>Procedures for Airborne Equipment | Section 17         |
| AIRBUS AMD-24C     | Test conditions for voltage spikes                                     |                    |
| AIRBUS ABD0100.1.8 | Electrical and Installation<br>Requirements                            |                    |

Table 2. Voltage spikes from different perspectives.

ing requirements for the A350XWB aircraft. It is tailored specifically to include the experience gained by Airbus over many decades. The voltage spike tests included in this document, were originally proposed as specification AMD-24 C intended for the A400M military transport aircraft and A380 double decker. Based on the 2/10us impulse, this requirement adds a further 4 waveforms. The 2/50us, 2/100us, 2/200us and 2/400us. As pulse width increases, the test amplitude reduces. The intent is to inject higher energy levels into EUT cables, thus improving on the basic DO160/ED14 requirements. In order to achieve this aim, the generator impedance is reduced to 50hm for all pulses except the 2/10us, this remains at 50ohm. There is a logical explanation for reducing the impedance. Power supplies tend to have very low impedances, so to transfer maximum energy from the generator into the cable the two should, ideally, be matched.

The longer impulses generate more energy at lower frequencies. A generator with high output impedance feeding a low impedance load will burn energy internally rather than transfer it to the load. The  $2\mu s$  rise-time generates frequencies (at the 3dB point) of approximately 200kHz, so the majority of the energy is at lower frequencies.

In all cases, DO-160, ED-14 and ABD0100.1.8, specify injection on cable bundles only. The preferred application method in all cases is SERIAL injection. This requires the impulse to be coupled into the EUT cable bundle using an inductive coupling clamp. Serial injection is most widely used due to the non-intrusive nature of the coupling. The type of coupler used must have the correct bandwidth to accurately transmit the impulse and not saturate when AC or DC power from the EUT is passed through it.

For power line coupling, there would be a tendency

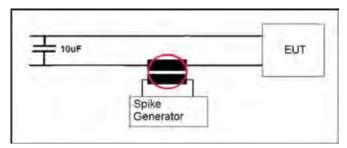


Figure 2. Voltage spike serial injection.

for impulse energy to flow into the low impedance power supply rather than the EUT. This is often overlooked but is simply addressed by inclusion of a  $10\mu F$  capacitor fitted between phase and neutral or phase to phase for 3-phase supplies. This adds a high impedance block for the impulse energy, directing it to the EUT.

A common thread running through the various standards is the need to superimpose the impulse on all lines simultaneously. What does this mean? Should every cable attached to an EUT be subjected to the impulse at the same time, or does this requirement refer to a all the wires in a single cable bundle. The diagram in DO160 / EUROCAE which shows the testing one cable at a time.

However, ABD0100.1.8 does request SIMULTANEOUS testing on ALL CABLES containing power lines connected to any one EUT. This is logical as voltage spikes circulating in a system will impinge on all power interfaces simultaneously.

#### CONCLUSION

Safety of airliners and the travelling public is paramount. To maintain the current high standard as technology evolves, there is a need to re-think test requirements.

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Figure 3. Voltage spike test system.

INTERFERENCE TECHNOLOGY 103

## Fundamentals of EMC Design: Our Products Are Trying To Help Us

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#### 1. INTRODUCTION

e often design electronic products only to find that when we test them for electromagnetic compatibility (EMC), their emissions and/ or immunity are not as good as we need them to be.

Usually, at this time, we feel as if we are fighting against the laws of physics to contain the conducted and radiated emissions, or to reduce susceptibility.

But in fact the laws of physics - Maxwell's Equations - are causing our design to have the best emissions and immunity that the physical structure allows. We might say that our product is doing the very best it can to reduce its emissions and improve its immunity!

(I am using the word "product" to mean every type of electronic assembly, from modules, subsystems, equipment and systems, to installations.)

The key issue - is that all currents (including strays) always flow in closed loops, and always take the path of least impedance, whether this path is along conductors or through the air (or other dielectrics) between them.

Current flows in the path of least impedance to minimize the energy in its associated electric and magnetic fields, rather like the way a drop of water in air assumes a

globular shape to minimize the energy in its surface tension.

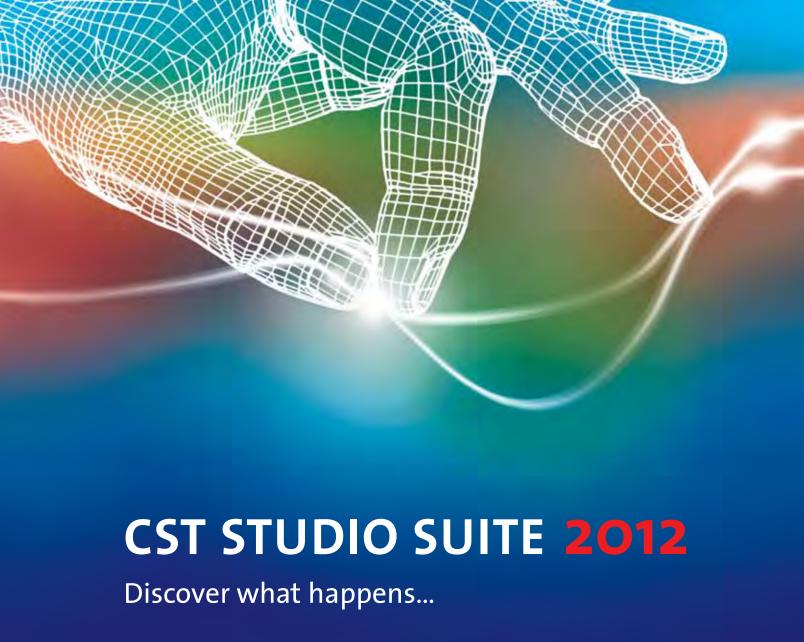
Because currents naturally take the paths that result in the lowest EM field energies, they automatically give us the best emissions and immunity of which our design is capable. Rather than fighting the laws of physics, what we are fighting is our own lack of understanding of how the laws of physics work. Once we understand this we can work with these laws from the start of our design, to easily and quickly create cost-effective products that meet their EMC specifications.

Unfortunately, the way that Maxwell's Equations are taught doesn't show how easy it is to derive (without any mathematics!) the easiest, simplest, most profitable way to design products using good EMC engineering techniques [1].

Signal Integrity (SI) and Power Integrity (PI) are subsets of EMC engineering, so employing good EMC design techniques from the start of a new project ensures excellent SI and PI (see [2]).

This has the effect of considerably reducing the number of design iterations, generally reducing overall cost of manufacture, and reducing time-to-market.

Time-to-market has, since 2000, become the most important issue for a financially successful electronic product. This is shown by the industry responses to Question 6 in [3], see Figure 1, and I have seen other reports from similar prestigious organizations that show the same for most electronic applications.



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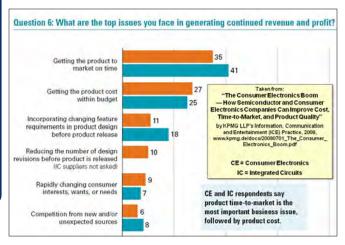


Figure 1. Time-to-market and cost.

It is often found in practice that employing good EMC design techniques from the start of a project improves functional performance, sometimes even giving signal quality and functional specifications better than anything that had ever been achieved before.

Unfortunately, some project/engineering managers insist on the lowest Bill Of Materials (BOM) cost, believing that this will somehow lead to the most profitable product.

Where it prevents us from working with the laws of physics, we often find ourselves fighting this ill-advised and plainly incorrect approach (see [4]). The result is a number of additional delays and cost-increases (e.g. adding filtering and shielding to pass EMC tests) that increase the overall cost-of-manufacture, delay market introduction, reduce profitability and increase financial risks.

For example, the ideal printed circuit board (PCB) layer stack for good EMC design of a given product might have eight layers, but the minimum SI and functional specifications can be met with just six. The cost-saving achieved by using the six-layer board is considerably outweighed by the extra delay and cost of adding filtering and shielding at the end of the project to meet its EMC specifications.

The overall cost of manufacture ends up being much higher than would have been achieved with an eight-layer PCB, and the (more important) time-to-market is delayed by several weeks – which in some situations can make the difference between a product's success and its failure.

This article briefly introduces the laws of physics as they apply to our products' SI, PI and EMC design issues, developing an "EM Design Toolkit". It then briefly describes applying that toolkit to a PCB assembly example.

I wrote a similar type of article on applying these same laws of physics to ease the EMC design of systems and installations or any size, [5], which might be of interest to some readers.

#### 2. EXTERNAL AND INTERNAL EMC

Apart from DC issues such as the fan-out of DC signals or the voltage drop caused by resistance in DC power conductors, all SI and PI issues are just subsets of EMC, as Figure 2 tries to show (also see [2]). They might be called "internal

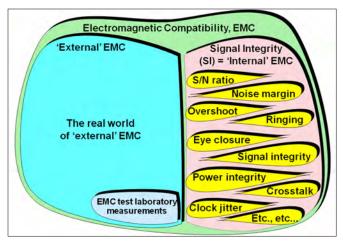


Figure 2. Good EMC design also takes care of SI and PI.

EMC" – the product interfering with itself. For more detail on this, see Chapter 8 of [6] or 2.10 of [7].

#### 3. EVERYTHING HAS PERMEABILITY (µ) AND **PERMITTIVITY** (ε)

All media and materials in this universe have conductivity, permeability ( $\mu$ ) and permittivity ( $\epsilon$ ).

In vacuum (and air):  $\mu_0 = 4\pi 10^{-7}$ Henries/meter  $\varepsilon_0 = (1/36\pi 10^{-9})$  Farads/meter

Other media and materials are characterized by their relative permeability  $(\mu_p)$  and permittivity  $(\varepsilon_p)$  – dimensionless numbers, just multipliers for the vacuum permeability and permittivity – so their overall permeability is:  $\mu_0 \mu_R$  and their overall permittivity is:  $\epsilon_{_{0}}\epsilon_{_{R}}$ 

Permeability is associated with inductive EM energy, which we draw as magnetic field contour lines.

Permittivity is associated with capacitive EM energy, which we draw as electric field contour lines.

Conductivity (and its reciprocal, resistivity) is associated with energy loss, i.e. the conversion of EM energy (magnetic or electric) into thermal energy.

The shape and size of conductive structures carrying current, and the  $\mu_0\mu_R$  and  $\epsilon_0\epsilon_R$  of the media or materials they are embedded in, cause inductance (L) and capacitance (C), respectively.

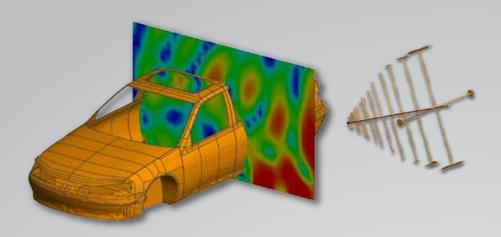
This means that whenever there is a fluctuating voltage (V) there is *always* an associated current (I).

And vice-versa: whenever there is a fluctuating current (I) there is *always* an associated voltage (V).

Some digital designers assume that because the input resistance of a CMOS gate is several M $\Omega$ , PCB traces carrying digital signal voltages carry no (or a very tiny) current. This is incorrect because it ignores the inevitable (and unavoidable) stray capacitance of the traces and the gate input.

For example, with a gate input capacitance of 3pF and a 3 Volt digital signal rise-time of 300ps (quite slow these days) the peak current required just to charge up this single input gate alone is about 30mA. This intense current "spike" must flow in a loop that includes the DC power supply distribution network, so can cause all manner of SI, PI and

# Covering a broad spectrum of your EMC simulation requirements



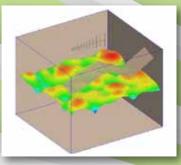
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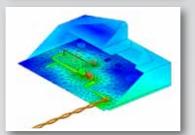
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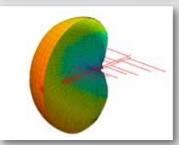


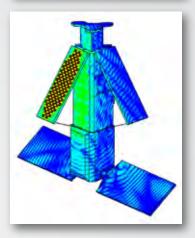












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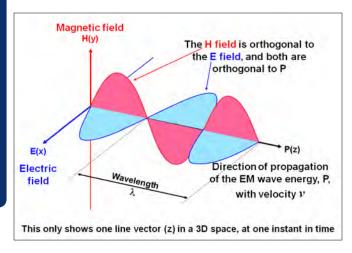


Figure 3. Visualizing a linearly-polarized EM wave in free space.

#### EMC problems.

In insulators and dielectrics (e.g. air, PVC, fiberglass)  $\mu_0 \mu_D$ and  $\boldsymbol{\epsilon}_{_{\boldsymbol{0}}}\boldsymbol{\epsilon}_{_{R}}$  cause analogous effects to inductance and capacitance – so whenever there is a fluctuating electric field (E) there is always an associated magnetic field (H).

And vice-versa: whenever there is a fluctuating magnetic field (H) there is *always* an associated electric field (E).

Chapter 2 of [6] and 2.3 of [7] have more details on the above.

#### 4. BECAUSE OF MAXWELL'S EQUATIONS...

Every fluctuating voltage or current is really EM power (Watts, i.e. rate of flow of electrical energy), propagating as a wave in the medium with velocity  $v = 1/\sqrt{(\mu_0 \mu_R \epsilon_0 \epsilon_R)}$ m/s (≅ 3.108 m/s in air or vacuum) and creating electromagnetic (EM) fields as it does so.

This applies to *every* kind of electrical event, whether we call it electrical power; electronic or radio signals; infra-red; light; lightning, etc., and including all mains 60Hz power; analogue, digital and switch-mode power and signals; data communications; radio-frequencies (RF) and microwaves, etc., including all electrical, electronic, or radio "noises".

Figure 3 is an attempt at visualizing a single vector of an EM wave at a single frequency, as it propagates in free space. Its shows that the E and H fields are perpendicular to each other, and that they both fluctuate in directions perpendicular to the direction in which the EM power is

The usual analogy is with waves on the ocean, which propagate wave energy across the surface of the ocean even though the molecules of seawater in a wave only move up and down.

A common way of visualizing the E and H fields associated with voltages and currents in conductors, is shown in Figure 4, for a send/return pair of conductors shown in cross section. E-field lines always terminate on conductors, perpendicular to their surface, and H-field lines never terminate on anything.

These lines should be considered like contour lines on

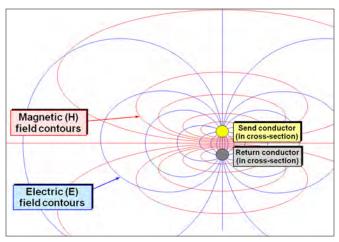


Figure 4. Cross section of fields associated with a pair of send/ return conductors.

a geographical map – they are not real, but their density (number of lines per inch) indicates the strength of the field (like the slope of a hill). So we can see that the E and H field strengths are highest in between the send and return conductors.

The electrical power associated with the current in the wires propagates along the length of the wires. Because Figure 4 shows the wires in cross section, the electrical power (i.e. propagating EM energy) is flowing perpendicular to the surface of the page or screen with which you are reading these words, and the E and H fields it sketches are fluctuating in the plane of the paper or screen.

Maxwell's famous four equations include Amperes Law, which says that currents always flow in closed loops, and Faraday's Law of electromagnetic induction, which says that currents always flow in such a way as to minimize their loop areas.

Maxwell himself invented the concept of displacement current, showing how a fluctuating current could flow through capacitance even though there was no conductive path for it.

#### 5. BECAUSE OF THE LAW OF CONSERVATION OF **ENERGY...**

Ignoring the virtual particles in the "quantum vacuum", [8], there is always zero EM power at any point in space. The EM power entering a point must be exactly balanced by the EM power leaving it.

This is Kirchoff's current law, which is often described as: "the sum of the currents at any point equals zero", and is equivalent to Ampere's Law.

Another way of putting this is to say that all currents flow in closed loops. If some current could escape from a loop and go wandering off on its own, never to return, then at the point where it left the main loop there would be an imbalance in the current. Current would accumulate at that point, and the Law of Conservation of Energy tells us this can't happen (in our universe, anyway).

So we see that Conservation of Energy (in this context

sometimes called the Law of Conservation of Charge) means we could rewrite Kirchoff's current law as: "the sum of the EM power at any point equals zero".

This means that at any circuit node that sends a current (whether power, signals, noise, etc.) also simultaneously emits an antiphase current that we call the return current.

These send and return currents propagate through the impedances of the various media (air, conductors, etc.), eventually meeting up to create what we think of as send/return current loops. At any instant in time, the currents in the send and return current paths balance each other out.

Notice that because all power, signal and (stray) noise currents, of any kind, flow in closed loops, this means that the connection to the safety earth/ground electrodes generally has no relevance at all for good SI, PI or EMC design.

(In poor EMC designs, stray current loops can travel through the safety earth/ground, using it as a convenient conductive structure, and causing high levels of emissions and poor immunity.)

#### 6. BUT IT'S <u>REALLY</u> ALL BECAUSE OF QUANTUM ELECTRODYNAMICS (QED)

How did the return currents "know" what paths to follow to exactly match up with their respective send currents? Prof Feynman's slim book, [9], says that propagating EM energy (light is also EM energy) takes the path of <u>least</u> time – which is also the path of least energy – which is also the path that gives the best SI, PI and EMC possible for a given geometry and media/materials (although this last conclusion is not found in [9]).

To find out how propagating EM energy "knows" to do this, we have to integrate over the whole of space and time, including negative time. This was Prof Feynman's great insight, which made the world of quantum electrodynamics amenable to calculation, and is responsible for much of modern electronic technologies.

But when Prof Feynman's students asked him what underpinned this natural behavior, he said no one knew and there was simply no point in even asking the question. It was just the way nature worked. However, some progress is now being made in answering this question, with the favored solutions being the "many worlds" or "parallel universes" theory, which is known to be true because otherwise quantum computers wouldn't work.

A characteristic of QED is that it defies common sense and destroys the time relationship between cause and effect, with some outcomes that can seem very weird. Apparently, with sensitive enough instruments listeners could hear what the outcome of a ball game would be by listening to radio broadcasts from the future! Unfortunately it only reaches a few femtoseconds into the future – not enough time to place a winning bet.

Also, QED permits the power budget for a point to deviate from zero for a few femtoseconds, but after that the Law of Conservation of Energy insists that the power books have to balance to zero once again, as described

in 5 above.

Maxwell's Equations and related laws of physics describe a common-sense, cause-and-effect world in which understanding basic concepts makes it quite easy and quick to design low-overall-cost good SI, PI and EMC – but the QED concepts that underpin this are very weird and wonderful.

Despite its weirdness, QED is the most well-proven theory ever known, and has been proven to be accurate to about 11 orders of magnitude more than has (so far) been possible for gravity.

Happily, for all SI, PI and EMC work, engineers need go no deeper than Maxwell's Equations and Conservation of Energy (or Charge).

#### 7. WHAT DOES ALL THE ABOVE MEAN FOR SI, PI AND EMC?

#### 7.1 EM power divides between alternate paths according to their admittances

In the "far field" of an EM source, E and H fields experience the "wave impedance" of the media or materials their EM power is propagating through:

in air or vacuum:  $\sqrt{(\mu_0/\epsilon_0)}=120\pi\Omega$  (near enough 377 $\Omega$ ) in other media (e.g. PVC, oil, fiberglass, etc.):  $120\pi\sqrt{(\mu_0/\epsilon_p)\Omega}$ 



These simple wave impedance formulae are only true in the "far field", typical for radio transmission and reception, whereas in the "near field" the impedance situation is more complex, and the dominant effects on the impedance of a path through the air or other dielectric are inductive and capacitive coupling – often called "stray" or "parasitic" inductance and capacitance. See Chapter 2.4 of [6] or 2.3.3 of [7], for more on this, including how to calculate whether we are in the near or far field.

For EM waves propagating along conductive structures (what we call power, signals or stray currents flowing in cables and PCB traces), the medium surrounding them has an important effect on impedance, but so does the shape of the structures carrying the current and the shape and proximity of nearby conductors - most especially the return conductor(s), but any other conductors in the near field will also have an effect.

So EM waves propagating along conductors can experience impedances that are lower, or higher, than the impedance of the medium surrounding them.

This means that for a fluctuating current travelling along a conductor there are always alternative paths in the air and other dielectrics, so its send/return current loop is never a simple one.

In fact, all currents always split and flow in multiple alternative paths, in proportions according to the admittances of each of the paths (a path's admittance is the reciprocal of its impedance).

This is conceptually no different from the way that a DC current flowing through a bunch of parallel resistors will divide up according to their various conductances (reciprocal of their resistances) - with the highest current flowing in the resistance with the lowest value (i.e. the highest conductance).

The big difference for fluctuating currents is what is sometimes called "the invisible schematic" – the impedances of the stray capacitances and inductances, which are alternative paths for EM energy to flow in, which successful practical EMC engineers learn to visualize whenever they look at conductive structures.

Each part of a current loop has several alternative paths. The paths can be along conductors or through components and devices, or through the stray paths in the insulation, PCB substrate, air, etc.

It simply doesn't matter to a propagating EM wave. The conductors, components and devices that we designed, and the stray capacitive/inductive coupling and "accidental antenna" emissions (see 7.2) that we didn't design and not wanted (but can't be prevented entirely) all just look like different admittances (reciprocals of their impedances).

For example, a significant portion of the EM wave power might leave a conductor and continue on its path by travelling through the air – for example as a (capacitive, E-field) displacement current – if it sees that air path as having impedance comparable with that of the conductor.

When a conductor resonates (i.e. is not a well-matchedimpedance transmission line, see 7.6) in a way that creates a high impedance, a "stray capacitance" path through the air can easily create a lower loop impedance, causing most of the current to travel as displacement currents.

And where an air path resonates in a way that creates a low impedance, it could easily create a path with much less loop impedance than that of the intended conductors, so once again most of the current can travel as E-field displacement currents in the air.

We could say that our main task of SI, PI and/or EMC designers is to reduce the proportion of the EM waves (wanted currents) that "leak out" of our conductors - "escaping" into nearby conductors via stray capacitance and inductance (what we call crosstalk), and also "escaping" into the air as far-field EM waves (what we call EM emissions and measured with antennas in test labs).

It is important to understand that every current loop, however formed, with however many branching current paths going wherever, always has to return exactly 100% of the EM energy back to its source, to comply with the law of conservation of energy.

Actually, the reality of power and signal propagation is not that a current starts off from a voltage source and eventually returns back to it - having flowed around a loop or loops - but that the send and return currents are actually generated simultaneously by the source, and balance each other out at every instant thereafter.

Anyway, this perspective that current flows in multiple paths according to their admittances, shows that - to achieve good SI, PI and/or EMC - all we need to do is control the impedances in the various paths that are available to our wanted signals or power currents, so that they travel predominantly in the loops we want them to.

For example, if it was possible to design so that no signal or power current was "lost" to alternative paths, then we must have no crosstalk, no emissions, and - as a direct result - our product's SI and PI must be perfect and its EM emissions zero (see [2]). Also, by the Principle of Reciprocity (see 7.2 below), its RF immunity would be perfect.

Of course, perfection is never achieved but we can get close enough to reduce emissions to sufficiently small amounts, and improve immunity by as much as is needed, without adding significantly to the overall cost of manufacture, simply by working with the laws of physics.

For more detail on this topic, see Chapter 2 of [6], 2.3 of [7] or 10.1.4 in [10].

#### 7.2 All conductors are "accidental antennas"

A transmitting antenna is merely a conductor that *inten*tionally leaks its voltages and currents as EM power into the air. A receiving antenna is simply a conductor that intentionally picks up voltages and currents from the EM fields around it.

Of course, the more usual situation is that we don't want our conductors to transmit (leak) some of their EM power, or pick up noise from the environment. EMC engineers usually call the fact that they always do leak and pick-up: "accidental antenna behavior" or "unintentional

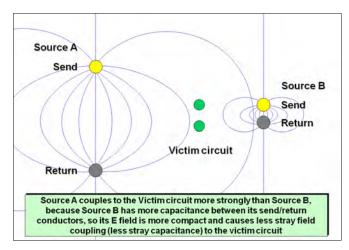


Figure 5. Example of E-field coupling.

antenna behavior".

When a conductor is exposed to E, H or EM waves propagating in its insulating medium (e.g. the air), its electrical/electronic circuit experiences the same voltage and current noise that we would need to create if we wanted to generate the exact same field pattern at the conductors. This is called the *Principle of Reciprocity*.

The Principle of Reciprocity also applies to accidental antennas, so when a conductor carrying a current has imperfect control of the wanted current loop that results in noise emissions, it will suffer noise pick-up from its EM environment in exactly the same way.

When electronic engineers are discussing SI or PI, they usually call accidental antenna behavior crosstalk, and they notice that the same techniques that reduce the noise coupled from the crosstalk's "aggressor" or source also help reduce the noise picked up by the crosstalk's "victim" – another example of the Principle of Reciprocity.

#### 7.3 Current loop size and coupling

The transfer of EM power from one conductive circuit to another – whether intentional or not – is called EM coupling. It can be described by "coupling coefficients" which are (of course) frequency dependent because they represent stray capacitance and inductance.

Up to the first resonant frequency, the larger the area of the send/return current path's total loop, the larger its impedance, the smaller its admittance, and the larger its E and H field patterns and hence its coupling with other conductors.

As shown in Figures 5 for E-fields and Figure 6 for H-fields (and Figure 10, see later) the larger the current loop, the higher is the proportion of its wanted current that couples with (leaks into) "victim" circuits, causing higher levels of noise currents flowing in unwanted loops, increasing the waveform distortion in wanted signals, and worsening emissions and immunity.

Figures 5 and 6 show us that it is important to minimize the send/return current loop areas, for all circuits – whether they are accidental transmitters or receivers of

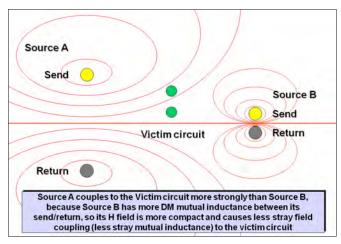


Figure 6. Example of H-field coupling.

EM noise – to maximize their SI, PI and EMC. For more detail on this, see Chapter 5 of [6], 2.7 of [7] or 10.1 of [10].

#### 7.4 All currents (including strays) naturally take the path of least impedance

The fact that currents naturally "prefer" to flow in the path with the smallest loop area and lowest impedance (described in 6 above) is the only way that I know of where the laws of physics work with SI, PI and EMC designers, instead of against us.

Computer field solvers show this phenomenon very clearly. Figures 7 and 8 are copied from [11], and show that when a bent wire carrying a current is routed close to a sheet metal chassis that it is using as a return path, the return current flows almost exclusively in the metal that lies underneath the wire, following its bent path, at frequencies above about 1kHz.

This is because the return path in the metal sheet below the bent wire creates the current loop area with the lowest possible overall impedance for that structure, even though the return current has to go around a bend to achieve it.

The red dotted lines in Figure 8 were drawn by the authors of [11] to help readers understand where the mean or average current return paths lie, because the EM field solver simply provides color gradients.

Notice that above 1kHz, although the return current is flowing in part of the metal sheet, the rest of the sheet is "quiet" – i.e. it has no currents flowing in it and so no voltage drops across it.

Circuits using those quiet parts of the sheet for their current return paths (e.g. as their 0V plane) do not suffer any voltage noises from the bent wire's return currents. (At 100Hz and below the impedance of the sheet is so low that the voltage noise caused in the other circuits by the now-widely-spreading return current are generally negligible).

This is a very important result that shows that we can have many different segregated areas of circuits (e.g. digital, analogue, switch-mode, etc.) sharing the same 0V plane (which I will start to call the RF Reference in 8 below) without their "ground noise" currents causing crosstalk or interference between the areas. See Chapter 7 of [7] and all of [12] for more detail on using this fact to help achieve low-cost SI, PI

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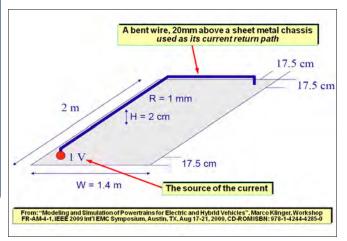


Figure 7. Example of a bent wire with a sheet metal chassis for its return current.

and EMC.

I have seen this sort of simulation done many times, with wire-over-sheet structures like Figure 7 or with PCB traces over planes (e.g. slides 46-50 in [13]), and I have also seen it done as practical demonstrations using close-field probes. The results are the same, up to however many GHz one cares to go.

#### 7.5 Power and signals in conductors have two modes of wave propagation

Differential Mode, DM (also called transverse or metallic mode) is what we call our "wanted" power and signals.

Common Mode, CM (also known as "longitudinal mode" or "antenna mode") is caused by the stray, leaked, "unwanted" EM energy when a DM loop's near-field E or H fields meet another conductor, as shown in Figures 5 and 6. It also occurs when far-field EM waves couple power from the wanted signal in its intended circuit, to another circuit – accidental radio transmission and reception.

Figure 9 shows the relative paths of the DM and CM currents in a simplified system.

Paraphrasing 7.1 above – the electricity does not all stay in the wire!

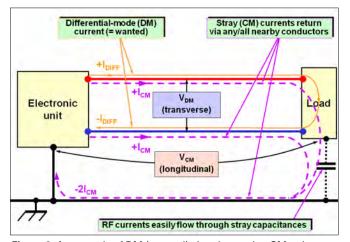


Figure 9. An example of DM (wanted) signals causing CM noises, for a 'floating' load.

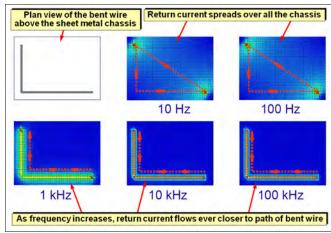


Figure 8. Computer simulations of the return current path for a wire above a plane.

Some of it travels as stray CM currents, which – like all currents - must flow in closed loops.

Because CM loops are generally very much larger than the DM loops that caused them, their E and H field patterns are much more widely spread. The result that CM is generally the major cause of "accidental antenna" effects causing EM problems for emissions and immunity over the frequency range from 1MHz to 1GHz.

Figure 10 shows that CM currents also couple with "victim" circuits through H-field coupling, similar to how DM currents couple (in Figure 6).

Reducing the size of the CM loop reduces its H-field coupling into the victim, in the same way that reducing the size of the DM loop does in Figure 6. And reducing the size of the CM current loop also reduces the amount of E-field coupling into the victim, in the same way as for the DM E-field in Figure 5.

So, just as it is important for good SI, PI and EMC to minimize the area enclosed by all wanted (DM) current loops, it is also important for all unwanted, accidental, CM current loops. For more detail on this topic, see Chapter 5.5 of [6], 2.7.5 of [7] or 10.1.5 of [10].

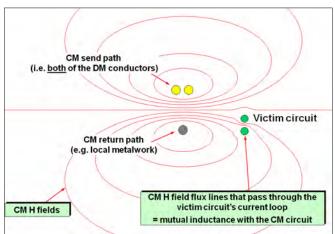


Figure 10. Example of CM H-field coupling.



Figure 11. This copper busbar is not an "earth" or "ground" for SI, PI or EMI.



Figure 12. These are not "earths" or "grounds" for SI, PI or EMI either.



Figure 13. ... these are also not "earths" or "grounds" for SI, PI or EMI.



Figure 14. ... and neither are these "earths" or "grounds" for SI, PI or EMI.

#### 7.6 Resonating conductors make perfect accidental antennas

There are various causes of resonances in conductive structures, at certain frequencies...

- When the L and C reactances happen to be equal
- Due to geometry interacting with wavelength

The second item concerns transmission-line matching. When mismatched conductor characteristic impedances cause propagating waves to be reflected, under certain conditions and at certain frequencies they can cause standing waves to arise, which are a type of resonance.

At resonant frequencies, loop impedances fluctuate wildly, in the range between the conductor's series resistance (possibly just a few m $\Omega$ ), up to the stray shunt resistance (possibly a few  $M\Omega$ ).

Accidental antenna effects (stray couplings, whether near-field or farfield) are significantly amplified by resonances, often between 10 and 100 times (20 to 40dB), possibly more, affecting both emissions and immunity equally due to the Principle of Reciprocity.

#### 7.7 There is no such thing as "earth" or "ground" for SI, PI and EMC

Currents always flow in closed loops. So the idea that the earth/ground electrodes provide a perfect zeroimpedance sink that we can use to absorb, or otherwise make unwanted electrical power, signals or noises go away, can't possibly be true - it is a total myth, pure and simple, having no basis in reality in this universe. [13] has more on this, especially its slides 32, 33 and 79.

Even if a zero-impedance earth/ ground could exist (which it can't, because everything has impedance) if we sent some unwanted current into it, the current would come back via some other route to complete its loop. So, then: no current sinks (in this universe).

Earth/ground is only a valid concept (can only have any effect) for

human safety, where it an issue of preventing electric shock by limiting the maximum potential differences that someone could come into contact with, whether they are caused by mains electricity leakage currents or faults, or lightning strokes.

Even when earth/ground electrodes are doing their thing for safety reasons, the relevant currents still flow in closed loops.

Figures 11 through 14 show some examples of what are commonly called earths or grounds, but are really just elements of a product's, equipment's, building's or site's conductive structures that help return CM currents back to their sources. Whether these structures are connected to safety earth/ground electrodes, or not, is of no consequence for SI, PI or EMC.

Of course, I am not the first person to comment on the meaninglessness of the term earth or ground for SI, PI and EMC. Dr Bruce Archambeault is an IBM Distinguished Engineer and a mainstay of the IEEE EMC Society, and many years ago he produced the graphic copied in Figure 15, as a way of making the same point, but in a more amusing way, see [13].

Because it is natural to assume that something called "earth" or "ground" is an infinite sink for noise currents - even though such a thing simply cannot exist – the use of such words or their graphical symbols encourages incorrect design for SI, PI and EMC, and I have seen millions of dollars have been wasted over the years for this exact reason.

So I always strongly recommend that the words "earth" or "ground" and their graphical symbols are never used in electronic design (except when a safety earth or ground is actually intended - and then for electrical safety purposes only). Instead, call the conductive structures by other names that mean what they say, e.g. RF Reference (see 8 below), CM Return Path, or whatever.

Using words such as "chassis", "frame", "enclosure", "shield" or "Faraday Cage" can also lead to the same conceptual design errors as "earth"

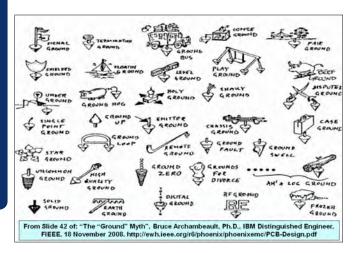


Figure 15. "Ground" is meaningless for SI and EMC.

or "ground" - so it is important to be very careful to only use them to mean what they actually are (i.e. mechanical structures made of metal) rather than assume they are (mythical) infinite sinks for noise currents.

For more detail on this, see 5.7 of [6] or 2.7.7 of [7], also 11.1.2 and 11.1.3 of [10].

#### 8. APPLYING THESE "EM DESIGN TOOLS" TO A **REAL-LIFE PCB ASSEMBLY**

#### 8.1 Introduction to the example

Sections 2 to 7 above have given us a set of EM design tools - really just mental concepts for how the EM energy that we call our power and signals actually prefers to flow to maximize SI, PI and EMC.

Notice that in sections 2 through 7 I intentionally used very little math; it is not necessary for an understanding of these important concepts. In fact, using equations can obscure what is really going on, which every successful EMC designer learns to "see" with his/her "mind's eye" just by looking at the conductive structure of a product.

With the complexity of modern products it is best for the designer to understand the concepts and have "the eye" for them, leaving the calculations to the appropriate types of EM field solvers.

Anyway, now for a real-life example – controlling the EM emissions and immunity of the typical electronic product sketched in Figure 16.

To minimize the overall cost of manufacture, this PCB assembly should have good EMC characteristics, so that a lot of money and time does not have to be spent (and add weight and size) by shielding and filtering it to get it to pass its EMC tests.

Because our EM design tools are all concerned with controlling EM field patterns to minimize unwanted "noise" coupling, the exact same tools also improve immunity (e.g. maximizing immunity to nearby walkie-talkies, cellphones, GPRS, 3G, Wi-Fi and Bluetooth transmitters, and also transients, ESD and lightning).

The assumptions made in the initial design of the ex-

ample were not in accordance with the "Laws of Physics Based EM Design Tools" outlined in 2 through 7 above. Instead, they represent what are unfortunately still commonplace bad practices in many electronic product design departments.

One bad practice used in our example is the use of so-called "single-point earthing/grounding" (sometimes called "star earthing/grounding"), using 0V plane splits between (and on) the PCBs. This is assumed to keep devices' circulating return currents confined to certain circuit areas, preventing crosstalk of noise between them (e.g. digital noise in analogue) - but it only works well below a few tens of kHz.

Splitting 0V planes ignores the fact that fluctuating currents always divide up according to the admittances of the various alternative paths, including "stray" paths through the air or insulation (see 7.1 above). For this reason, since 1980, the author has always found that when microprocessors and switch-mode converters are used, single-point earthing/grounding has always been a bad design practice for SI, PI and EMC. Others will no doubt be able to give examples from before 1980.

Another bad design practice used in the example is the assumption that achieving the lowest BOM cost is sufficient to produce the most profitable product. So the number of board layers and amount of power decoupling was reduced to the minimum that achieved the functional specifications. Also, provision has not been made for fitting EMI filters to all of the cable connections, because this would have increased the board's area.

Section 1 mentioned that relying on achieving the lowest BOM cost to create profitable products has been known to be an incorrect practice since 2000. Plain common sense easily reveals the fallacy inherent in this overlysimplistic approach – we only have to consider a product that had a BOM cost that was half (or less) of that of all its competitors - but suffered a 100% warranty return rate. Clearly, this would not be a successful product, so there is very much more to a product's profitability than its BOM cost.

I see many designs like the example in Figure 16 every

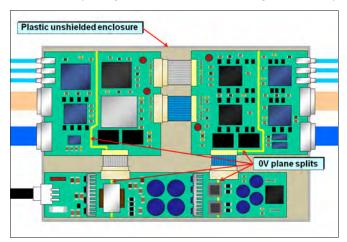


Figure 16. Overview of the example PCB assembly.

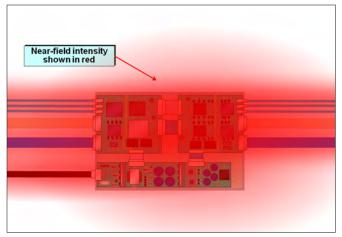


Figure 17. Near-field plot of the example (simulated, or measured with near-field probes).

year. They all suffer poor functional performance at first, especially poor signal-to-noise (S/N) ratios and unreliable software that take many design iterations to solve, causing project delays, increasing costs and reducing profitability.

Once the functional problems are solved, they then fail their EMC tests, requiring many *more* design iterations to solve, causing more delays and more project costs, plus requiring the addition of filters and shielding that increase BOM cost, weight and size and reduce profitability even more. They also suffer higher-than-hoped-for warranty return rates, which erode profitability even more.

A plot of the near-field emissions 20mm above the PCB assembly, at the stage where it meets its functional specifications but has not yet been tested for EMC, is shown in Figure 17.

What do such near-fields mean? This close to the PCB and its components they are the wanted DM signals, plus DM and CM crosstalk and noise. High levels mean reduced S/N ratios in analogue circuits, and reduced noise margins in digital circuits — leading to unreliable software.

In EMC testing, high levels of near-fields over large areas indicate high levels of conducted and radiated emissions, and correspondingly poor conducted and radiated immunity.

In real life, high levels of near-fields over large areas means a lower proportion of satisfied customers (increasing the cost of future sales, because it is easier to sell products that customers like), and higher levels of warranty costs. All causing lower profitability.

We understand, from the laws of physics discussed in sections 2 through 7, that:

- all currents (including DM and CM "noise" currents) flow in closed loops
- current loop shape and area govern field patterns
- currents naturally "prefer" to flow in the loops that have the lowest impedance – hence the smallest field patterns and best internal and external EMC.

So we can see how to make a number of improvements

to the circuit design and PCB layout, to reduce the areas of the DM and CM current loops and make their near fields more compact.

#### 8.2 Improvement #1: Create an RF Reference

We replace the multiple PCBs, with a single PCB that has a common conductor (almost always a 0V plane) over its entire area, which I shall call the RF Reference. You may choose your own name for it, as long as it is not "earth" or "ground".

The RF Reference in a PCB is at least one solid, continuous, copper plane layer, which lies underneath – and extends well beyond – all devices, components, traces and power plane areas.

There should be no traces "snuck into" this plane layer, and any gaps in it must be unavoidable and as small as possible.

Cellphone designers found that their products' close proximity between 2 Watt UHF or microwave RF transmitters, microphone amplifiers and digital processors meant that even the clearances around via holes added too much impedance to their RF Reference planes, so developed microvia PCB manufacturing technology (also called "High Density Interconnect" or HDI, or "Build Up") that provides 100% solid copper RF Reference planes.

An RF Reference achieves very low impedance (Z), the value of which depends on the devices and the EMC requirements specification to be met – but it must always be  $<<1\Omega$  over the frequency range that must be controlled to avoid causing/suffering EMI.

"The frequency range that must be controlled to avoid causing/suffering EMI" is all of the DM frequencies created in the devices on the PCB, and all of the frequencies existing in the operational environment and/or in the immunity test standards (if they require immunity over a larger frequency range).

Designing a profitable product is all about satisfying customers whilst selling a legal product at an overall profit, and there can be many more EMI requirements involved in satisfying customers than merely passing the minimum requirements of the minimum set of EMC test standards required for legal sales.

The point of creating an RF Reference is that it automatically provides a low-impedance (high-admittance) return path for all possible power/signal/noise currents, and CM noise currents on the PCB. Because it is in very close proximity to the PCB's components, devices and traces, all these current loop areas are small – just what we need for good SI, PI and EMC.

It is important to realize that we don't have to "make" the return currents flow in the RF Reference and so have the least E and H field emissions – we only have to provide an RF Reference plane and they will naturally "prefer" to flow in it rather than elsewhere! (See Figures 7 and 8). The RF Reference plane works best with lower-profile components, so we also replace any tall components and devices with ones that lie close to the PCB and its RF Reference plane layer(s).

See Chapter 7.4 of [7], 3 and 4 of [12] and 11.2.2 of [10] for more detail on creating effective low-impedance RF Reference Planes in PCBs.

#### 8.3 Improvement #2: Decoupling the DC supplies

We design the decoupling between DC power rails and the RF Reference to achieve low Z, the value of which (as for 8.1) depends on the devices and the EMC requirements specification to be met – but must always be  $<<1\Omega$  over the frequency range that must be controlled to avoid causing/suffering EMI.

This permits the fluctuating DM currents in the power rails to flow in much smaller loops very close to the devices that cause them - which they naturally "prefer" to do, rather than flowing more widely in the RF Reference - making small areas of DM near-fields that create less CM noise emissions than larger areas would.

PC motherboards now need to achieve power supply impedances of much less than 0.25 m $\Omega$  to frequencies much more than 1GHz. This is impossible to achieve with low-cost decoupling capacitors, because above about 300MHz they are beyond their self-resonant frequency and so act inductively - their impedance rises with frequency - making low-enough impedances impossible.

However, because we now have a RF Reference plane in the PCB, we can pair it with adjacent power planes to provide distributed decoupling capacitances within the PCB's fiberglass dielectric, which can maintain very low impedances up to any number of GHz.

See Chapter 7.5 of [7], 5 of [12] and 12.1.3 of [10] for details on how to do effective decoupling on PCBs.

#### 8.4 Improvement #3: Cable filtering

We add direct bonds or filters to the RF Reference on all traces connected to off-PCB conductors, whatever their electrical/electronic/other purpose (including metal mechanical parts; and metal hydraulic/ pneumatic pipes, etc.).

Filters on inputs can often be just a capacitor connected to the RF Reference, but filters on outputs will generally need a series resistor or soft-ferrite choke so that adding the capacitor to the RF Reference does not significantly increase the peak output current.

Of course, we might need to make more complex filters by combining capacitors with resistors and/or soft-ferrite chokes and/or CM chokes - but there are far too many details involved to even start to address this topic in this article. For more details on filtering, see Chapter 5 of [7], 2 of [12] or 13.2 of [10].

These direct bonds or filters are placed where the traces connect to the off-board conductors, to provide low-Z paths for CM currents that would otherwise "leak" from the PCB into the conductors. As for 8.1, the values of Z that are required depends on the devices and the EMC requirement specification, but must always be  $<<1\Omega$  over the frequency range that must be controlled to avoid causing/suffering EMI.

#### 8.5 Improvement #4: Using matched transmission lines

Where device data sheets specify the use of matched transmission-lines - usually for high-speed clocks or serial data lines - designers almost always remember to control their trace geometry and matching impedances.

But they generally do not consider treating all of the other traces as matched transmission lines, until they are investigating digital signal over/undershoots, ringing or other unwanted noises that cause incorrect or unstable software operation late in a project - the stage where delays and design changes are most costly.

These over/undershoots or ringing are indications of strong emissions (and poor immunity at the emission frequencies), as shown in [2]. Suppressing them to get good EMC, either by filtering at their drivers or by using matched transmission lines to reduce "accidental antenna" effects and prevent resonances, results in very low over/ undershoots and no ringing. It also reduces crosstalk and makes (bug-free!) software work very reliably indeed.

EMC textbooks often make recommendations about when to treat a PCB trace or cable as a matched transmission line, but digital device rise- and fall-times are now generally so short (typically < 0.5ns for 74-series glue logic and < 0.2ns for microprocessors and memories) that almost all practical trace and cable lengths now need either to be filtered to significantly reduce their frequency content, or else be treated as matched-impedance transmission lines.

See Chapters 4.7 and 7.6 of [7] and 6 of [12] for more on designing with matched transmission lines.

#### 8.6 The improved example

The appearance of the example PCB improved by 8.2 through 8.5 above, is shown in Figure 18. Notice that it still has one plane split, under the mains safety isolation transformer - which cannot be avoided.

Despite increasing the number of board layers to provide RF Reference and Power Supply planes, and additional planes for controlling transmission-line impedances, and despite increasing the number of decoupling capacitors and filters, it is guite normal to find that the overall cost of manufacture (not the BOM) is lower. This is because the inter-board connectors and their cables have been removed – significant causes of assembly errors and rework; unreliability and warranty returns.

Figure 19 shows the near-field plot 20mm above the improved PCB assembly, which now has only small red areas around the components. These are almost entirely the DM fields associated with the wanted power and signals, which we cannot eliminate without eliminating the power or signals themselves.

Remember, all fluctuating currents (whether power, signals or noise) are really EM energy propagating as waves, so the best we can do is provide structures that allow these currents to naturally flow in loops of low impedance (high admittance) so that they naturally create

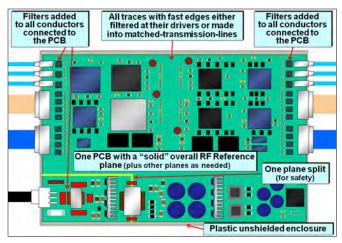


Figure 18. The improved example PCB assembly.

very small and local field patterns, with great benefits for SI, PI and EMC. When we have achieved this, as shown in Figure 19, we see very little field-spreading is seen due to CM noise currents.

#### 8.7 Improving by using cable shielding

Where the use of filtering and unshielded cable techniques (Chapter 4.4 of [7], 2 of [12] and 13.1.8 of [10]) could not suppress the DM or CM fields around a cable by enough, shielding might be necessary for some (or all) cables and/or parts of (or the whole) PCB assembly.

#### 9. CONCLUSIONS

All electrical and electronic activities are really EM energies travelling as propagating waves, and connecting to safety earth/ground has no effect on them so is unimportant and unnecessary for SI, PI and EMC.

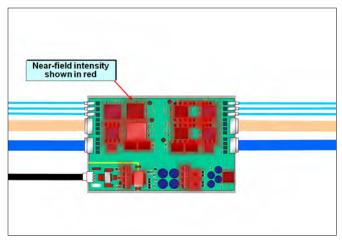
We can easily design circuits and PCBs to create small, low-Z current loops for both the wanted DM and the stray CM currents, the EM waves naturally prefer to flow in these routes. So, by working *with* the laws of physics, we automatically achieve very compact field patterns, which are best for internal and external EMC and financial success.

Because these techniques control field patterns to minimize unwanted "noise" coupling, because of the principle or reciprocity the exact same techniques also minimize susceptibility, for example minimizing unwanted "noise" couplings.

The principles of good design techniques for SI, PI and EMC are very clear, easy to understand, and easy for everyone to implement at low cost in practice. Products really are doing their best to help us pass EMC tests and meet EMC requirement specifications – all we need to do is give them a little help, from the start of their design process.

#### 10. REFERENCES

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**Figure 19.** Near-field plot of the improved PCB assembly (simulated, or measured with near-field probes).

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KEITH ARMSTRONG graduated from Imperial College, London, in 1972 with an Honours degree in electrical engineering. He has been a member of the IEE since 1977, a UK Chartered Engineer since 1978, and a Group 1 European Engineer since 1988. He founded Cherry Clough Consultants in 1990. Keith can be reached at keith.armstrong@cherryclough.com.

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### **CALENDAR**

#### **EVENTS**

#### 6th European Conference on Antennas and Propagation (EuCAP)

March 26-29, 2012, Prague, Czech Republic

EuCAP2012 provides an ideal and unique place in Europe for the exchange of scientific and technical information, at academic and industrial levels, on the latest results and developments in antenna theory and technology, in electromagnetic wave propagation on antenna measurement techniques.

#### **INATRONICS 2012**

March 28 - 31, Jakarta International Expo Center, Jakarta, Indonesia

The Indonesia's Only Electronics Industry Event in 2012, in which is designed to feature a full spectrum of products & services for electronic components, materials, assemblies and electronics production technology. The product spectrum is optimally geared to the market requirements.

www.inatronics-exhibition.net

#### 2012 DoD E3 Program Review

April 2-6, Royal Plaza Hotel, Orlando, Fla.

The DoD E3 Program Review will provide an information exchange forum for DoD Components, the Federal Government, and Industry E3 and Spectrum professionals. The DoD E3 Program Review will feature unclassified presentations for General Session Forums conducted throughout the week and a ½ day Restricted Session Forum for "Distribution Controlled and Classified Presentations." This year will also include a full day Restricted Session Forum for the Navy Day.

#### **ExpoElectronica**

April 11-13, Crocus Expo, Moscow, Russia

The exhibition was launched in 1998 and in its 15 years of existence has rightly earned a reputation not just as an eagerly anticipated event and key place for demonstrating the latest developments and achievements in the electronics industry, but also as the main platform for leading industry professionals to meet and sign mutually beneficial, long-term contracts.

#### WAMICON 2012

April 16-17, Cocoa Beach, Fla.

IEEE Wireless and Microwave Technology (WAMI) Conference 2012 conference will address up-to-date multidisciplinary research needs and interdisciplinary aspects of wireless and RF technology.

#### **ESTECH 2012**

April 30- May 3, Doubletree by Hilton at the Entrance to Universal Orlando, Orlando, Fla.

ESTECH offers attendees a valuable educational experience with conference sessions and continuing education courses in the fields of design, test, and evaluation/product reliability; contamination control; aerospace; and nanotechnology.

www.iest.org/Meetings/ESTECH

#### **IEEE International Magnetics Conference**

May 7-11, Vancouver Convention Center, Vancouver, Canada

INTERMAG is the premier conference on all aspects of applied magnetism. The conference will provide a range of oral and poster presentations, invited talks and symposia, a tutorial session, and exhibits reviewing the latest developments in magnetism. Selected papers from the conference will be published in the IEEE Transactions on Magnetics.

http://intermagconference.com/2012/

#### The Fifteenth Meeting of the Symposium on **Polymers for Microelectronics**

May 8-10, Winterthur, Wilmington, Del.

The charter for the Symposium on Polymers for Microelectronics is to promote the study of the integration of polyimides and other advanced polymeric materials into semiconductor, thin film packaging, MEMS and optical application areas.

www.symposiumonpolymers.com/

#### SVIAZ-EXPOCOMM 2012

May 14-17, Expocentre Fairgrounds, Moscow, Russia

Every year it serves as the most excellent place for industry professionals to network, to promote technology and exchange information. Sviaz-Expocomm enjoys a high international standing and is one of the major events used by overseas IT manufacturers to promote their products and develop their business in Russia.

#### **Electric Power 2012**

May 15-17, Baltimore Convention Center, Baltimore, Md.

ELECTRIC POWER is the largest coal power conference in the U.S., offering more sessions and speakers and attracting more coal power producers than any other event. In addition, the leading users' group for PRB Coal holds its primary meeting at ELECTRIC POWER each year.

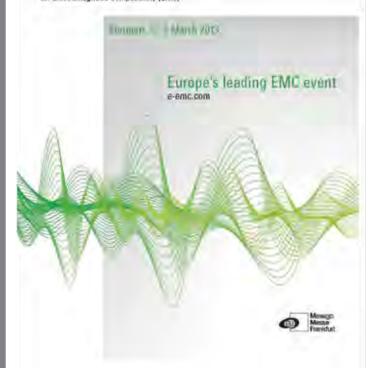
www.electricpowerexpo.com/





Internationale Fachmosse mit Workshops für Elektromagnetische Verträglichkeit

International Exhibition with Workshops on Electromagnetic Compatibility (EMC)



EMV is the international discussion platform and showcase of the EMC industry. EMV 2013 takes place from 5 – 7 March 2013 in Stuttgart, Germany. The trade show and the workshops provide a comprehensive picture of the most recent EMC trends and highlights.

In times of ever more technical innovations, the challenges in the EMC field are steadily increasing. E-mobility and other new developments place high demands on EMC and safety. Ten times higher voltages and currents, increasing shielding requirements and new charging technologies for electric vehicles make discussions and the exchange of ideas and solutions important for the entire industry. The rapid development in the electronics industry is expected to continue. It is necessary to guarantee the reliable functioning of all the highly complex systems.

EMV 2013 will provide the opportunity to gain hands-on experience in this area. In the previous years, a special action zone on e-mobility showcased electric cars and other exhibits.

EMV 2013 will provide the opportunity to gain hands-on experience in this area. In the previous years, a special action zone on e-mobility showcased electric cars and other exhibits. Impulse speeches informed many interested visitors about the newest development in this field. The organizer of EMV, Mesago Messe Frankfurt GmbH, is hoping to continue this successful cooperation with EMV Test NRW GmbH and its partners.

Another great opportunity to gather information is the exhibitor forum. Here, the exhibitors have the chance to present their company and their products.

EMV 2013 will offer numerous half-day workshops. Topics will range from EMC basics, to legal aspects or niche topics. For the participants these workshops provide the perfect opportunity to keep up with the current state of technology. The speakers have the chance to share their knowledge and experiences with their colleagues.

The proximity of workshops and exhibition creates unique synergies for all parties. EMV 2013 is the place where experts meet the experts.

Detailed information on EMV 2013 is available at www.eemc.com. For questions and wishes please contact the EMV-Team directly at emv@mesago.com or +49 711 61496 63

#### Exhibitor statements of EMV 2012:

"LCR has exhibited at many trade shows in the USA and China. We were impressed with the professional level of attendees which resulted in a higher quality of leads. We were also suitably impressed with the overall exhibition. We will definitely consider exhibiting at next years EMV show."

Nissen Isakov, President, LCR Electronics Inc.

"For us, the first time we were at the EMC, it was a successful show. We had a large number of interesting conversations and made many new business contacts." Theo Hellmann, Magh und Boppert GmbH

"Small is beautiful! A must for all EMC professionals." Mathias Kalmbach, WÜRTH ELEKTRONIK eiSos

#### 2012 Asia-Pacific EMC Week

May 21-25, Singapore

The conference is aiming at providing a forum to continue and accelerate the momentum of researching in microwave technologies and related fields. The conference provides a unique opportunity for international scientists, engineers and scholars to share and exchange experiences.

www.apmc2012.com

#### 2012 ESA Workshop on Aerospace EMC

May 21-23, Palazzo Cavalli Franchetti, Venice Italy

This workshop will establish a forum opportunity for EMC researchers and engineers involved in aerospace and give a wide picture of the present state of EMC technology and trends. It will also encourage awareness of, and foster discussion in future developments which will allow the EMC community to keep the pace of spacecraft and aircraft design advances and challenges.

www.congrex.nl/12A05/

#### IEEE EMC Society Chapter Meeting

May 28, Rhein Tech Laboratories, Washington/NOVA

Short pulses are inherently ultra-wideband (UWB) and have been the subject of interest for various applications such as wireless communications, high speed data transfer, fast switches, high speed interconnects, and medical sciences. Understanding the characteristics of UWB signals is best suited in time domain. Therefore, the beauty of time domain technique for example, finite-difference time-domain (FDTD) method for simulating various EM problems will be discussed. FDTD method provides wealth of information about the simulated device – applications towards the extraction will be demonstrated.

www.wll.com/academy.html

#### The 7th Annual European Spectrum Management Conference

**June 19-20, The Management Centre Europe, Brussels** 

Now in its 7th year, the European Spectrum Management Conference has an established reputation as the major European meeting point of the year for stakeholders in the field of spectrum management, bringing together more than 280 participants on an annual basis.

http://eu-ems.com/summary.asp?event\_id=112&page\_id=848

#### **Intersolar Europe**

June 11-15, New Munich Trade Fair Centre, Munich, Germany www.intersolar.de/

#### The 7th Annual European Spectrum Management Conference

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http://eu-ems.com/summary.asp?event\_id=112&page\_id=848

#### **Techno-Frontier 2012**

July 11-13, Tokyo Big Sight, Tokyo, Japan

Visitors know that the latest technologies & products in Electronics and Mechatronics gather here. Each clearly-focused exhibition enables the professionals to locate what they need, and the wide range of the products sparks ideas on possibilities of technical coordination.

www.jma.or.jp/tf/en11/index.html

#### 2012 IEEE EMC Society

Aug. 5-10, David L. Lawrence Convention Center, Pittsburgh, Pa.

This symposium is sponsored by the IEEE EMC Society will feature several concurrent technical sessions. You'll find an Exhibit hall with hundreds of booths filled with latest products, equipment and services. Later in the event we'll feature concurrent workshops / tutorials. In addition there are many collateral industry and profession meetings planed thoroughout the week. Finally, there a numerous formal and informal opportunities to network with old friends, meet new friends, experts, professionals and industry representatives.

http://2012emc.org/

#### MSPO 2012 - 20th International Defence **Industry Exhibition**

Sept. 3-6, Kielce, Poland

The 19th edition MSPO – facts and figures – 13,000 trade fair attendants, 25,000 square metres of the exhibition space, 400 exhibitors, international concerns, official delegations from 30 countries and the presence of the European Defence Agency.

#### 34th Annual EOS/ESD Symposium & Exhibits

Sept. 9-14, Tucson, Ariz.

www.esda.org/symposia.html

#### electronica India 2012 & productronica India 2012

Sept. 11-13, Bangalore, BIEC

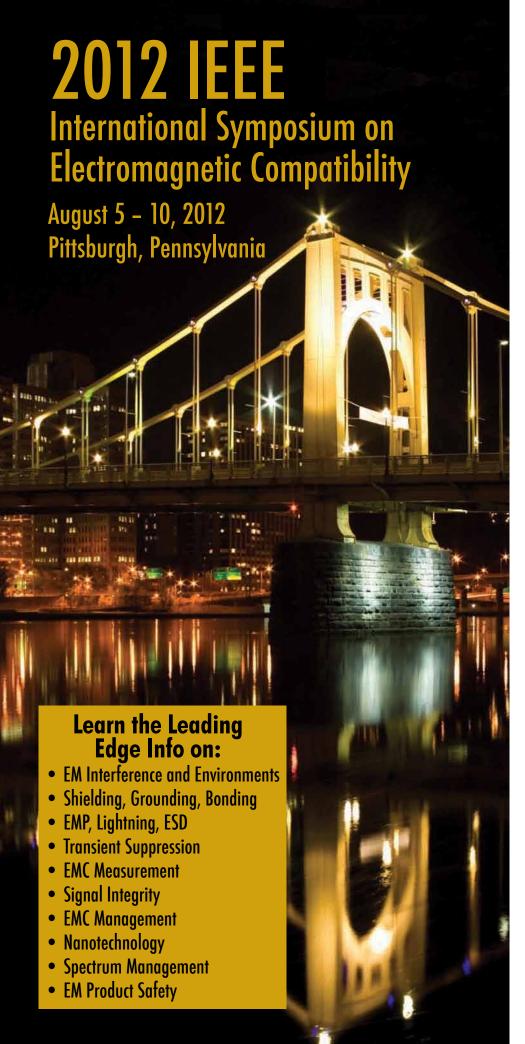
electronica India and productronica India clearly demonstrate their close links to the world's leading trade fairs electronica and productronica in Munich.

#### **EMC EUROPE 2012 ROME**

Sept. 17-21, Faculty of Engineering of "Sapienza" University of Rome, Rome, Italy

The Symposium will consist of 5-day oral and poster presentations, workshops, tutorials, special sessions, short-courses, industrial forum, and exhibits. The Preliminary Program, registration form, information on accommodation and social activities will be available in the web pages of the Symposium. The advanced registration fee will include the attendance to all technical sessions, social events, the electronic version of the Symposium Proceedings and Workshop Notes.

www.emceurope2012.it





### **BRIDGE TO EMC**

Cross over with us to the city of bridges. This event will have something for everyone — from the novice EMC engineer to the advanced practitioner. This is an opportunity to advance your knowledge, build new relationships, and reconnect with industry friends from around the world.





For Complete Event Details Visit: www.emc2012.isemc.org

### **STANDARDS**

Compliance with standards makes or breaks the marketing of any new product. This section recaps new and revised national and international EMC standards. The information below has been featured in our weekly Interference Technology eNews. Just go to InterferenceTechnology.com, subscribe to the eNews, and you'll be updated on important changes in EMC standards weekly.

#### **International Electrotechnical Commission (IEC)**

#### **EMC AND HEARING AIDS STANDARD**

IEC 60118-13:2011 in principle covers all relevant EMC phenomena for hearing aids. Hearing aid immunity to high frequency electromagnetic fields originating from digital wireless devices operating in the frequency ranges 0.8 GHz to 0.96 GHz and 1.4 GHz to 2.48 GHz is currently identified as the only relevant EMC phenomenon regarding hearing aids. Future editions of this part of IEC 60118 may add tests for other frequency bands, as they come into more common use. IEC 61000-4-3 is the basis for relevant EMC tests to be conducted on hearing aids. Measurement methods and acceptance levels are described in this part of IEC 60118. This third edition cancels and replaces the second edition published in 2004 and constitutes a technical revision. It introduces a new set of requirements for use of hearing aids with mobile phones.

#### **HIGH-VOLTAGE SWITCHGEAR AND CONTROLGEAR**

Project IEC 62271-204 ed1.0, High-voltage switchgear and controlgear - Part 204: Rigid gas-insulated transmission lines for rated voltage above 52 kV, is an up to 3 months pre-release of the official publication.

This part of IEC 62271 applies to rigid HV gas-insulated transmission lines (GIL) in which the insulation is obtained, at least partly, by a non-corrosive insulating gas, other than air at atmospheric pressure, for alternating current of rated voltages above 52 kV, and for service frequencies up to and including 60 Hz.

It is intended that this international standard be used where the provisions of IEC 62271-

203 do not cover the application of GIL (see NOTE 3).

At each end of the HV gas-insulated transmission line, a specific element may be used for the connection between the HV gas-insulated transmission line and other equipment like bushings, power transformers or reactors, cable boxes, metal-enclosed surge arresters, voltage transformers or GIS, covered by their own specification.

#### **ELECTRICAL INSULATING MATERIALS AND SYSTEMS**

IEC/TS 61934 ed2.0, Electrical insulating materials and systems - Electrical measurement of partial discharges (PD) under short rise time and repetitive voltage impulses, is applicable to the off-line electrical measurement of partial discharges (PD) that occur in electrical insulation systems (EIS) when stressed by repetitive voltage impulses generated from electronic power devices. Typical applications are EIS belonging to apparatus driven by power electronics, such as motors, inductive reactors and windmill generators. Excluded from the scope of this technical specification are:

-methods based on optical or ultrasonic PD detection,

-fields of application for PD measurements when stressed by non-repetitive impulse voltages such as lightning impulse or switching impulses from switchgear.

The principal changes with regard to the previous edition concern the addition of:

 an Introduction that provides some background information on the progress being made in the field of power electronics;

- -impulse generators;
- -PD detection methods;
- -a new informative Annex C covering practical experience obtained from round-robin testing (RRT);
- -example of noise levels, as shown in new informative Annex D.

#### IEC 61000-4-16 ED1.2 CONSOL. WITH AM1&2

Electromagnetic compatibility (EMC) - Part 4-16: Testing and measurement techniques - Test for immunity to conducted, common mode disturbances in the frequency range 0 Hz to 150 kHz IEC 61000-4-16:1998+A1 :2001+A2:2009, establishes a common and reproducible basis for testing electrical and electronic equipment with the application of common mode disturbances to power supply, control, signal and communication ports. This standard defines test voltage and current waveform, range of test levels, test equipment, test set-up and test procedures. The test is intended to demonstrate the immunity of electrical and electronic equipment when subjected to conducted, common mode disturbances such as those originating from power line currents and return leakage currents in the earthing/grounding system.

#### **ELECTROMAGNETIC ENVIRONMENTS**

IEC/TR 61000-2-5:2011 is a Technical Report intended for guidance for those who are in charge of considering and developing immunity requirements. It also gives basic guidance for the selection of immunity levels. The data are applicable to any item of electrical or electronic equipment, sub-system or system that operates in one of the locations as considered in this Technical Report. It

has the status of a basic EMC publication in accordance with IEC Guide 107. Knowledge of the electromagnetic environment that exists at locations where electrical and electronic equipment and systems are intended to be operated is an essential precondition in the process of achieving electromagnetic compatibility. This knowledge can be obtained by various approaches, including a site survey of an intended location, the technical assessment of the equipment and system as well as the general literature.

#### SEMICONDUCTOR DEVICE STANDARD

Mechanical standardization of semiconductor devices - Part 6-12: General rules for the preparation of outline drawings of surface mounted semiconductor device packages - Design guidelines for fine-pitch land grid array (FLGA), IEC 60191-6-12:2011, provides standard outline drawings, dimensions, and recommended variations for all fine-pitch land grid array packages (FLGA) with terminal pitch of 0,8 mm or less. This edition includes the following significant changes with respect to the previous edition:

- scope is expanded so that this standard include the square type FLGA. The title of this standard has been changed accordingly: "Rectangular type" has been deleted from the title;
  - ball pitch of 0,3 mm has been added;
- datum is changed from the body datum to the ball datum:
- combination lists of D, E, MD, and ME have been revised.

#### **NEW CONNECTORS STANDARD**

IEC 61076-2-106:2011 describes circular connectors with IP40 or IP65/67 protection degree, typically used for industrial process measurement and control. These connectors consist of fixed and free connectors, either rewireable or non-rewireable, with M16 x 0,75 screwlocking. Male connectors have round contacts Ø 1,5 mm or Ø 1,0 mm.

#### MICROPROCESSOR SYSTEM STANDARD

ISO/IEC/IEEE 60559:2011(E) specifies formats and methods for floating-point arithmetic in computer systems - standard and extended functions with single, double, extended, and extendable precision - and recommends formats for data interchange. Exception conditions are defined and standard handling of these conditions is specified. It provides a method for computation with floating-point numbers that will yield the same result whether the processing is done in hardware, software, or a combination of the two. The results of the computation will be identical, independent of implementation, given the same input data. Errors, and error conditions, in the mathematical processing will be reported in a consistent manner regardless of implementation. This first edition, published as ISO/IEC/IEEE 60559,

replaces the second edition of IEC 60559.

#### **CONNECTORS STANDARD**

IEC 60512-9-3:2011 defines a standard test method to assess the mechanical and electrical operational endurance, i.e. engaging and separating cycles, of a connector in an operating mode which includes a specified electrical load. This second edition cancels and replaces Test 9c of IEC 60512-5, issued in 1992, and constitutes a technical revision. The main technical changes with regard to the previous edition are as follows:

- An additional requirement to 4.1 stating that if more than one electrical circuit is wired for testing, the wiring shall be carried out in a parallel electrical circuit.
- Subclauses 4.3 through 4.7 were removed and replaced by 4.2 through 4.4.

#### SEMICONDUCTOR STANDARD

IEC 60749-40:2011 is intended to evaluate and compare drop performance of a surface mount semiconductor device for handheld electronic product applications in an accelerated test environment, where excessive flexure of a circuit board causes product failure. The purpose is to standardize test methodology to provide a reproducible assessment of the drop test performance of a surface mounted semiconductor devices while duplicating the failure modes normally observed during product level test. This international standard uses a strain gauge to measure the strain and strain rate of a board in the vicinity of a component.

#### **RF CONNECTORS STANDARD**

IEC 61169-35:2011(E) provides information and rules for preparation of detail specification of 2,92 series RF coaxial connectors together with the pro-forma blank detail specification. It also prescribes mating face dimensions for high performance connectors - grade 1, dimensional detail of standard test connectors - Grade 0, gauging information and tests selected from IEC 61169-1 applicable to all detail specifications relating to 2,92 series RF coaxial connectors. It cancels and replaces IEC/PAS 61169-35, published in 2009, of which it constitutes a minor revision. The only change is that the PAS has been changed into and International Standard.

#### **SEMICONDUCTOR STANDARD**

IEC 60749-30:2005+A1:2011 establishes a standard procedure for determining the preconditioning of nonhermetic surface mount devices (SMDs) prior to reliability testing. The test method defines the preconditioning flow for non-hermetic solid-state SMDs representative of a typical industry multiple solder reflow operation. These SMDs should be subjected to the appropriate preconditioning sequence described in this standard prior to being submitted to specific in-house reliability testing (qualification and/or reliability monitoring) in order to evaluate long term reliability (impacted by soldering

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stress). This consolidated version consists of the first edition (2005) and its amendment 1 (2011). Therefore, no need to order amendment in addition to this publication.

#### **EMC REQUIREMENTS FOR POWER SUPPLY UNITS**

IEC 61204-3:2011 specifies electromagnetic compatibility (EMC) requirements for power supply units (PSUs) providing d.c. output(s) with or without auxiliary a.c. output(s), operating from a.c. or d.c. source voltages up to 600 V a.c. or 1 000 V d.c. The main changes with respect to the previous edition are listed below:

- Update of the scope to align with IEC 61204-7.
- Update of the normative references to the latest edi-
- Change of the definitions of environments to align with the latest editions of the applicable normative refer-
- Revision of the applicability of tests to different power supply technologies.
- Revision of the emission limits and requirements to align with the latest editions of the applicable normative references.
- Revision of the immunity limits and requirements to align with the latest editions of the applicable normative references.
  - Clarification of the different classes of PSU.

#### **INTEGRATED CIRCUITS STANDARD**

IEC 61967-8:2011 defines a method for measuring the electromagnetic radiated emission from an integrated circuit (IC) using an IC stripline in the frequency range of 150 kHz up to 3 GHz. The IC being evaluated is mounted on an EMC test board (PCB) between the active conductor and the ground plane of the IC stripline arrangement.

This publication is to be read in conjunction with IEC 61967-1:2002.

#### **ELECTROMAGNETIC COMPATIBILITY STANDARD**

IEC/TR 61000-3-15:2011(E) is concerned with the critical assessment of existing and emerging national and international standards for single and multi-phase dispersed generation systems up to 75 A per phase, particularly converters connected to the public supply low voltage network. This Technical Report intends to serve as a starting point and to ultimately pave the way for the definition of appropriate EMC requirements and test conditions. This Technical Report is limited to EMC issues (immunity and emission) up to 9 kHz and does not include other aspects of connection of generators to the grid. This Technical Report focuses on emission caused by distributed generation (mainly harmonics and inter-harmonics, DC emissions flicker, rapid voltage changes and fluctuations), as well as immunity aspects to normally occurring events in the public supply network

(voltage dips and short interruptions, frequency variations, harmonics and interharmonics). Every effort has been made to utilize already existing emission and immunity standards, including the test set-up and existing test equipment in use.

#### SEMICONDUCTOR AND MICRO-**ELECTROMECHANICAL DEVICES STANDARD**

IEC 62047-12:2011 specifies a method for bending fatigue testing using resonant vibration of microscale mechanical structures of MEMS (micro-electromechanical systems) and micromachines. This standard applies to vibrating structures ranging in size from 10 μm to 1 000  $\mu m$  in the plane direction and from 1  $\mu m$  to 100  $\mu m$ in thickness, and test materials measuring under 1 mm in length, under 1 mm in width, and between 0,1 µm and 10 μm in thickness. The main structural materials for MEMS, micromachine, etc. have special features, such as typical dimensions of a few microns, material fabrication by deposition, and test piece fabrication by means of non-mechanical machining, including photolithography. The MEMS structures often have higher fundamental resonant frequency and higher strength than macro structures. To evaluate and assure the lifetime of MEMS structures, a fatigue testing method with ultra high cycles (up to 1012) loadings needs to be established. The object of the test method is to evaluate the mechanical fatigue properties of microscale materials in a short time by applying high load and high cyclic frequency bending stress using resonant vibration.

#### **EMC EMISSION ASSESSMENT STANDARD**

IEC/TR 61000-3-14:2011(E) is a Technical Report which provides guidance on principles that can be used as the basis for determining the requirements for the connection of disturbing installations to low voltage (LV) public power systems. For the purposes of this part of IEC 61000, a disturbing installation means an installation (which may be a load or a generator) that produces disturbances: harmonics and/or interharmonics, voltage flicker and/or rapid voltage changes, and/or voltage unbalance. The primary objective is to provide guidance to system operators or owners for engineering practices, which will facilitate the provision of adequate service quality for all connected customer installations. In addressing installations, this report is not intended to replace equipment standards for emission limits. This report addresses the allocation of the capacity of the system to absorb disturbances. It does not address how to mitigate disturbances, nor does it address how the capacity of the system can be increased.

#### SEMICONDUCTOR MAGNETIC AND **CAPACITIVE COUPLER STANDARD**

IEC/PAS 60747-17:2011(E) gives the terminology, essential ratings, characteristics, safety test and the measuring methods of magnetic and capacitive couplers. It specifies the principles of magnetic and capacitive coupling across an isolation barrier and the related requirements for basic isolation and reinforced insulation.

#### **RADIATION PROTECTION INSTRUMENTATION**

IEC 61577-3:2011 describes the specific requirements for instruments measuring the volumetric activity of airborne short-lived radon decay products and/or their ambient potential alpha-energy concentration outdoors, in dwellings, and in workplaces including underground mines. This standard applies practically to all types of electronic instruments that are based on grab sampling, continuous sampling technique and electronic integrating measurement methods. This new edition includes the following significant technical changes with respect to the previous edition:

- implementation of new requirements and tests concerning radiation detection performance;
- implementation of new requirements and tests concerning environmental performance;
- harmonization of the requirements and tests concerning electrical and mechanical performance with other standards in the area of radiation protection instrumentation.

#### FIXED CAPACITORS STANDARD FOR USE IN ELECTRONIC EQUIPMENT

IEC 60384-2:2011 applies to fixed capacitors for direct current, with metallized electrodes and polyethyleneterephthalate dielectric for use in electronic equipment. These capacitors may have "self-healing properties" depending on conditions of use. They are primarily intended for applications where the a.c. component is small with respect to the rated voltage. Two performance grades of capacitors are covered, Grade 1 for long-life application and Grade 2 for general application. Capacitors for electromagnetic interference suppression and surface mount fixed metallized polyethylene-terephthalate film dielectric d.c. capacitors are not included, but are covered by IEC 60384-14 and IEC 60384-19 respectively. This fourth edition cancels and replaces the third edition published in 2005 and contains the following significant technical changes with respect to the previous edition.

- Table 1, Sampling plan together with numbers of permissible non-conformance for qualification approval test, has been adjusted.
- Table 3, Lot-by-lot inspection, has been changed, highlighting assessment level EZ only.
- Table 4, Periodic inspection, has been changed, highlighting assessment level EZ only.
- The preferred values of rated voltages have been updated in conformance with the basic series of preferred values R5 and R10 given in ISO 3.

#### **CONNECTORS FOR ELECTRONIC EQUIPMENT**

IEC 60603-7:2008+A1:2011 covers 8-way unshielded free and fixed connectors and is intended to specify the

common dimensions, mechanical, electrical and environmental characteristics and tests for the family of IEC 60603-7-x connectors. These connectors are intermateable and interoperable with other IEC 60603-7 series connectors. This new edition includes the following significant technical changes with respect to the previous edition:

- updated drawings and test schedules on the basis of IEC 60603-7-4;
- corrected figure illustrating a connector de-rating curve.

This consolidated version consists of the third edition (2008) and its amendment 1 (2011). Therefore, no need to order amendment in addition to this publication.

#### **COAXIAL COMMUNICATION CABLES**

IEC 61196-8-1:2012 is part of the IEC 61196 series and applies to coaxial communications cables described in IEC 61196-8. It specifies the requirements for semiflexible radio frequency and coaxial cables with polytetrafluoroethylene (PTFE) dielectric. These cables are for use in microwave and wireless equipment or other signal transmission equipment or units at frequencies from 500 MHz up to 18 GHz. This blank detail specification is to be read in conjunction with IEC 61196-1 and IEC 61196-8. The blank detail specification determines the layout and style for detail. Detail specifications, based on the blank detail specification, may be prepared by a national organization, a manufacturer or a user.

#### EMC METALLIC COMMUNICATION CABLE TEST METHODS

Project IEC 62153-4-14 ed1.0 Final Draft International Standard is an up to 3 months' pre-release of the official publication. It is available for sale during its voting period: 2012-02-17 to 2012-04-20. By purchasing this FDIS now, you will automatically receive, in addition, the final publication.

### International Organization for Standardization (ISO) / IEC

#### INFORMATION TECHNOLOGY SOFTWARE MEASUREMENT STANDARD

ISO/IEC 14143-2:2011, functional size measurement -- Part 2: conformity evaluation of software size measurement methods to ISO/IEC 14143-1:

- establishes a framework for the conformity evaluation of a Candidate FSM Method against the provisions of ISO/IEC 14143-1;
- describes a process for conformity evaluation of whether a Candidate FSM Method meets the (type) requirements of ISO/IEC 14143-1 such that it is an actual FSM method, i.e. they are of the same type;
  - describes the requirements for performing a

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conformity evaluation in order to ensure repeatability of the conformity evaluation process, as well as consistency of decisions on conformity and the final result;

- aims to ensure that the output from the conformity evaluation process is objective, impartial, consistent, repeatable, complete and auditable;
- provides informative guidelines for determining the competence of the conformity evaluation teams;
- provides an example checklist to assist in the conformity evaluation of a Candidate FSM Method; and
- provides an example template for the conformity evaluation report.

#### **RFID CONFORMANCE TEST METHODS**

ISO/IEC 18047-2:2012 defines test methods for determining the conformance of radio frequency identification (RFID) devices (tags and interrogators) for item management with the specifications given in ISO/IEC 18000-2, but does not apply to the testing of conformity with regulatory or similar requirements.

The test methods require only that the mandatory functions, and any optional functions which are implemented, be verified. This may, in appropriate circumstances, be supplemented by further, application-specific functionality criteria that are not available in the general case.

The interrogator and tag conformance parameters in ISO/IEC 18047-2:2012 are the following:

- mode-specific conformance parameters including nominal values and tolerances;
- parameters that apply directly affecting system functionality and inter-operability.

The following are not included in ISO/IEC 18047-2:2012:

- parameters that are already included in regulatory test requirements;
- high-level data encoding conformance test parameters (these are specified in ISO/IEC 15962).

Unless otherwise specified, the tests in ISO/IEC 18047-2:2012 are to be applied exclusively to RFID tags and interrogators defined in ISO/IEC 18000-2.

#### **International Special Committee** on Radio Interference (CISPR)

#### PRE-RELEASE ON ELECTROMAGNETIC **COMPATIBILITY OF MULTIMEDIA EQUIPMENT**

This International Standard applies to multimedia equipment (MME) as defined in 3.1.23 and having a rated r.m.s. AC or DC supply voltage not exceeding 600 V. Equipment within the scope of CISPR 13 or CISPR 22 is within the scope of this publication. MME intended primarily for professional use is within the scope of this publication. The radiated emission requirements in this standard are not intended to be applicable to the intentional transmissions from a radio transmitter as defined by the ITU, nor to any spurious emissions related to these intentional transmissions. Equipment, for which emission requirements in the frequency range covered by this publication are explicitly formulated in other CISPR publications (except CISPR 13 and CISPR 22), are excluded from the scope of this publication.

#### FCC ACCEPTANCE OF CISPR 22 DATA

The FCC accepts measurement data for unintentional unlicensed Part 15 devices using CISPR 22 1997 standard. However, most manufacturers and some test laboratories believe that the FCC accepts measurement data based on any CISPR 22 standard, regardless of the year. In fact, 47CFR 15.38(a) lists only the third edition of the International Special Committee on Radio Interference (CISPR), Pub. 22, "Information Technology Equipment—Radio Disturbance Characteristics—Limits and Methods of Measurement," 1997, IBR approved for §15.109. The FCC accepts data based only on this CISPR edition. For any other edition or year to be acceptable, it would have to be included in the list in 47CFR 15.38(a), or included in a policy from the FCC, as described here in FCC 47CFR 15.38(a) "Incorporation by reference" rule: "The materials listed in this section are incorporated by reference in this part. These incorporations by reference were approved by the Director of the Federal Register in accordance with 5 U.S.C. 552(a) and 1 CFR part 51. These materials are incorporated as they exist on the date of the approval, and notice of any change in these materials will be published in the Federal Register."

We have no knowledge of FCC dismissals as a result of using other CISPR 22 standard versions and dates; nonetheless, FCC 47CFR15.38(a) lists CISPR 22 1997 standard as the only alternative standard for Part 15 device measurement data.

#### **EMC REQUIREMENTS FOR HOUSEHOLD APPLIANCES**

CISPR 14-1:2005+A1:2008+A2:2011 applies to the conduction and the radiation of radio-frequency disturbances from appliances whose main functions are performed by motors and switching or regulating devices, unless the R.F. energy is intentionally generated or intended for illumination. It includes such equipment as:

- household electrical appliances,
- electric tools.
- regulating controls using semiconductor devices,
- motor-driven electro-medical apparatus,
- electric/electronic toys,
- automatic dispensing machines as well as cine or slide projectors. Also included in the scope of this standard are separate parts of the above mentioned equipment such as motors, and switching devices relays (power or protective). However, no emission requirements apply unless formulated in this standard. The frequency range covered is 9 kHz to 400 GHz. Multi-

function equipment which is subjected simultaneously to different clauses of this standard and/or other standards shall meet the provisions of each clause/standard with the relevant functions in operation; details are given in 7.2.1. The limits in this standard have been determined on a probabilistic basis, to keep the suppression of disturbances economically feasible while still achieving an adequate radio protection. In exceptional cases radio frequency interference may occur, in spite of compliance with the limits. In such a case, additional provisions may be required. The effects of electromagnetic phenomena relating to the safety of apparatus are excluded from the scope of this standard. This consolidated version consists of the fifth edition (2005), its amendment 1 (2008) and its amendment 2 (2011). Therefore, no need to order amendments in addition to this publication.

#### ELECTROMAGNETIC COMPATIBILITY OF MULTIMEDIA EQUIPMENT STANDARD

CISPR 32:2012 International Standard applies to multimedia equipment (MME) having a rated r.m.s. AC or DC supply voltage not exceeding 600 V. Equipment within the scope of CISPR 13 or CISPR 22 is within the scope of this publication. MME intended primarily for professional use is within the scope of this publication. The radiated emission requirements in this standard are not intended to be applicable to the intentional transmissions from a radio transmitter as defined by the ITU, nor to any spurious emissions related to these intentional transmissions. Equipment, for which emission requirements in the frequency range covered by this publication are explicitly formulated in other CISPR publications (except CISPR 13 and CISPR 22), are excluded from the scope of this publication. This document does not contain requirements for in-situ assessment. Such testing is outside the scope of this publication and may not be used to demonstrate compliance with it. This publication covers two classes of MME (Class A and Class B). The objectives of this publication are to establish requirements which provide an adequate level of protection of the radio spectrum, allowing radio services to operate as intended in the frequency range 9 kHz to 400 GHz and to specify procedures to ensure the reproducibility of measurement and the repeatability of results.

#### **EMC FILTERING DEVICES STANDARD**

CISPR 17:2011 specifies methods to measure the radio interference suppression characteristics of passive EMC filtering devices used in power and signal lines, and in other circuits. The defined methods may also be applied to combinations of over-voltage protection devices and EMC filtering devices. The measurement method covers the frequency range from 9 kHz to several GHz depending on the device and test circuit. The standard describes procedures for laboratory tests (type tests) as well as factory tests. The suppression characteristics of EMC filters and components used for the suppression of

EM disturbances, are a function of numerous variables such as impedance of the circuits to which they connect, operating voltage and current, and ambient temperature. This standard specifies uniform test methods that will enable comparison of filtering and suppression characteristics determined by test laboratories or specified by manufacturers. Measurement procedures are provided for unbiased and bias conditions.

### **European Telecommunications Standards Institute (ETSI)**

#### HARMONIZED EUROPEAN STANDARD

ETSI EN 302 729-2 V1.1.2 specifies the requirements for Level Probing Radar (LPR) applications based on pulse RF, FMCW or similar wideband techniques.

LPRs are used in many industries concerned with process control to measure the amount of various substances (mostly liquids or granulates). LPRs are used for a wide range of applications such as process control, custody transfer measurement (government legal measurements), water and other liquid monitoring, spilling prevention and other industrial applications. The main purposes of using LPRs are:

- to increase reliability by preventing accidents;
- to increase industrial efficiency, quality and process control:
- to improve environmental conditions in production processes.

LPR always consist of a combined transmitter and receiver and are used with an integral or dedicated antenna. The LPR equipment is for professional applications to which installation and maintenance are performed by professionally trained individuals only.

#### **EMC AND RADIO SPECTRUM MATTERS**

ETSI EN 305 550-2 V1.1.1 is a new standard that takes advantage of technical developments within the SRD industry. In particular this includes the development in technologies which makes applications in the higher frequency range possible. This standard is part 2 of a multi-part deliverable covering Electromagnetic compatibility and Radio spectrum Matters (ERM); Short Range Devices (SRD); Radio equipment to be used in the 40 GHz to 246 GHz frequency range.

#### **RADIO EQUIPMENT AND SERVICES**

ETSI EN 301 489-1 V1.9.2 contains the common requirements for radio communications equipment and associated ancillary equipment, in respect of Electromagnetic Compatibility (EMC).

Product dependent arrangements necessary to perform the EMC tests on dedicated types of radio communications equipment, and the assessment of test results, are detailed in the appropriate product related parts of

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EN 301 489 series [i.13].

The present document, together with the product related part, specifies the applicable EMC tests, the methods of measurement, the limits and the performance criteria for radio equipment and associated ancillary equipment. In case of differences (for instance concerning special conditions, definitions, abbreviations) between part 1 of EN 301 489 series [i.13] and the relevant product related part of EN 301 489 series [i.13], the product related part takes precedence.

Technical specifications related to the antenna port of radio equipment and radiated emissions from the enclosure port of radio equipment and combinations of radio and associated ancillary equipment are not included in the present document. Such technical specifications are normally found in the relevant product standards for the effective use of the radio spectrum.

The environment classification used in the present document refers to the environment classification used

- EN 61000-6-3 [i.4] and EN 61000-6-1 [i.5] for the residential, commercial and light industrial environment;
- TR 101 651 [i.6] for the telecommunication centre environment; or
  - ISO 7637-2 [8] for the vehicular environment.

The EMC requirements have been selected to ensure an adequate level of compatibility for apparatus intended to be used in the environments mentioned above. The levels, however, do not cover extreme cases which may occur in any location but with low probability of occurrence.

#### **PORTABLE VERY HIGH FREQUENCY** RADIOTELEPHONE EQUIPMENT STANDARD

This standard states the minimum technical characteristics and methods of measurement required for portable Very High Frequency (VHF) radiotelephones with integrated handheld class D DSC operating in certain frequency bands allocated to the maritime mobile service using either 25 kHz channels or 25 kHz and 12,5 kHz channels.

#### **Institute of Electrical and Electronics Engineers (IEEE)**

#### **NEW COMMUNICATION STANDARDS FOR SMART GRID METERING DEVICES**

Among the efficiencies promised by the smart grid is the use of metering devices that not only report usage to utilities but also inform users how to schedule consumption to lower-cost off-peak hours or even control that consumption automatically. Two new IEEE standards provide multisource "plug and play" environments for the millions of metering devices in the field now and in

the future. Both standards solve problems associated with single-source systems and with multisource systems based upon proprietary communications protocols.

IEEE 1702™, "IEEE Standard for Telephone Modem Communication Protocol to Complement the Utility Industry End Device Data Tables" is for devices using the ANSI C12.21 telephone modem communication interface. IEEE 1701™, "IEEE Standard for Optical Port Communication Protocol to Complement the Utility Industry End Device Data Tables," (also known as MC1218 and ANSI C12.18) is for devices using the ANSI Type 2 optical port interface.

#### STANDARD LIMITING INSERTION OF HARMONICS INTO POWER GRID

The IEEE Standards Association (IEEE-SA) Standards Board approved two new projects to develop standards that will limit the injection of harmonic frequencies into the public electric transmission system. Harmonic pollution is a growing problem caused by the widespread use of power supplies and other non-linear loads. It can result in power loss and equipment damage and it may also be related to environmental safety issues. Both standards will address harmonic injection in 60Hz and 120V/240V systems such as those in use in the United States, Canada and other regions of the world. Both standards will also use the IEC SC77A and IEC 61000-3-12 standards as seed documents.

#### **NEW WIRELESS NETWORK STANDARD FILLS IN THE WHITE SPACE**

The wireless spectrum was carved up in the mid-20th century with protection of commercial radio and television signals as its primary concern. One example of this was the practice of leaving "white space" between broadcast channels to prevent interference by analog signals crowded too close together. Especially since the dawn of the digital age, technology has gotten better and better at reclaiming such underutilized slices of this spectrum, creating a wide array of new markets and applications that have opened up communication in revolutionary ways—without degrading performance by legacy spec-

A new standard, IEEE 1900.4a<sup>™</sup>-2011, defines additional components of the IEEE 1900.4™ system to enable mobile wireless access service in white space frequency bands without any limitation on used radio interface (physical and media access control layers, carrier frequency, etc.).

#### **WIRELESS LAN MEDIUM ACCESS CONTROL** AND PHYSICAL LAYER SPECIFICATIONS

This revision specifies technical corrections and clarifications to IEEE Std 802.11 for wireless local area networks (WLANS) as well as enhancements to the existing medium access control (MAC) and physical layer (PHY) functions. It also incorporates Amendments 1, 2, 3, 4, 5,

#### **Other News**

#### FCC PROPOSES RULES CHANGES TO IMPROVE WIRELESS COVERAGE

The Federal Communications Commission adopted a Notice of Proposed Rulemaking (NPRM) to facilitate the development and deployment of well-designed signal boosters, which hold great potential to empower consumers in rural and underserved areas to improve their wireless coverage.

Coverage gaps exist within those service areas and continue to pose a problem for residents, particularly in rural areas. Signal boosters are part of the solution to addressing coverage gaps in rural areas. The regulatory framework for signal boosters proposed in this Notice of Proposed Rulemaking (NPRM) is one element in a set of initiatives designed to promote deployment of mobile voice and broadband services in the United States.

#### **EMC AND ELECTRICAL PROTECTION**

This technical report addresses electromagnetic compatibility and protection of telecommunications equipment that is typically used by telecommunications service providers. Topics covered included ESD, EMI (both emissions and susceptibility), Lightning, Power Induction (transient and steady state), Power Contact, Corrosion, and DC Power.

#### FCC FINALIZES RULES FOR BROADBAND FROM WALL SOCKETS

The Federal Communications Commission affirmed its rules for Broadband over Power Lines with minor modifications. The new rules provide a balance between providing for Access BPL technology that has potential applications for broadband and Smart Grid while protecting incumbent radio services against harmful interference. The rules have been modified "to increase the required notch filtering capability for systems operating below 30 MHz from 20 to 25 dB; establish a new alternative procedure for determining site-specific extrapolation factors...; and adopts a definition for the 'slant-range distance' used in the BPL measurement guidelines to further clarify its application."

BPL allows electrical utilities to deliver broadband service over medium voltage lines to homes and businesses through electrical wall sockets. It also allows them to monitor power usage in the form of Smart Grid applications.

### STANDARD TOPICAL OUTLINES FOR QUALIFICATION OF NONDESTRUCTIVE TESTING PERSONNEL

Recommended Practice No. SNT-TC-1A: Personnel Qualification and Certification in Nondestructive Test-

ing (2011) provides guidelines for employers to establish in-house certification programs for the qualification and certification of nondestructive testing personnel. Since 1966, employers have used this industry-valued document as the general framework for their NDT certification programs. This revision provides updated training and certification requirements for Level I, II and III personnel. New content on:

- Guided Wave and Ground Penetrating Radar as Methods
- Radiological Testing Method which includes: Radiographic Testing, Computed Radiography, Computed Tomography, and Digital Radiography.
- Ultrasonics, Time of Flight Diffraction and Phased Array as Techniques
- Additional Example Questions ANSI/ASNT CP-105: Training Outlines for Qualification of Nondestructive Personnel (2011) is included.

#### NEW LAW FOCUSES ON RARE METALS IN ELECTRONICS

A provision on "conflict minerals" that was slipped into a 2010 financial reform law, the Dodd-Frank Act, will help educate American consumers on what is in their smart phones, computers and other electronics and where U.S. electronics manufacturers are getting those rare metals. In the jungles and mountains of the Democratic Republic of the Congo, armed groups have been wreaking havoc and getting much of their funding from mining rare metals during the area's 13-year-long civil war.

#### STANDARD FOR EM EXAMINATION OF FERROMAGNETIC STEEL WIRE ROPE

ASTM E1571 - 11 outlines a procedure to standardize an instrument and to use the instrument to examine ferromagnetic wire rope products in which the magnetic flux and magnetic flux leakage methods are used. If properly applied, the magnetic flux method is capable of detecting the presence, location, and magnitude of metal loss from wear, broken wires, and corrosion, and the magnetic flux leakage method is capable of detecting the presence and location of flaws such as broken wires and corrosion pits.

The instrument's response to the rope's fabrication, installation, and in-service-induced flaws can be significantly different from the instrument's response to artificial flaws such as wire gaps or added wires. For this reason, it is preferable to detect and mark (using set-up standards that represent) real in-service-induced flaws whose characteristics will adversely affect the serviceability of the wire rope.

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### **SOCIETIES**

#### **IEEE Electromagnetic Compatibility Society (S-27)**

#### **Headquarters:**

**IEEE Operations Center** 445 Hoes Lane, P.O. Box 6804 Piscataway, NJ 08855-1331 Phone: (732) 981-0060

www.emcs.org

President: Ghery Pettit, ghery.pettit@intel.com

#### The Institute of Electrical & Electronics Engineers

(IEEE), the world's largest professional engineering society, is a global organization of individuals dedicated to improving the understanding of electrical and electronics engineering and its applications to the needs of society. The parent organization has over 360,000 members, approximately 70 percent of whom belong to technical groups such as the EMC Society.

Membership in the IEEE is on a qualified basis, with a basic annual fee of between \$140 and \$180 depending on the region of the world. The U.S. fee is \$183. The Institute offers major medical and life insurance at low group rates, and each member receives a copy of the monthly publication, Spectrum. Affiliate, associate, and student memberships are available for those who do not qualify for regular membership; and special arrangements are provided for those temporarily out of work. Members may join one or more of the 39 technical societies by paying the additional individual society fee(s). The EMC Society has an annual fee of \$30. Student memberships are \$15.

The EMC Society, which enjoys a membership of over 5000, functions through a Board of Directors elected by the Society membership. The Board includes 20 membersat-large who serve staggered 3-year terms. The Executive Board consists of the President, President-Elect, Immediate Past President, Secretary, Treasurer, and five Vice Presidents, who oversee the activities of standing and technical committees. The officers are elected by the Board of Directors. The annual IEEE International Symposium on Electromagnetic Compatibility is sponsored by the Board of Directors, which also coordinates activities of standing technical and ad hoc committees.

EMC Society publications include Transactions on EMC, a quarterly journal which features state-of-the-art papers on interference technology and EMC, and the EMC Society Newsletter, a quarterly newsletter of society activities, industry developments, practical papers, and notices of meetings, regulations, and new publications.

The EMC Society also has a group of distinguished lec-

turers who are available to present talks to IEEE and other organizations. The Society subsidizes the lecturers' expenses, and organizations are encouraged to contact the society for further details.

Chairmen of these committees welcome assistance and indications of interest in committee activities from the EMC Society membership. EMC Society activities are provided by 54 chapters with members in 61 countries worldwide.

A Committee Directory, listing officer, board, committee, and chapter contacts' names, addresses, and telephone numbers, is available on the IEEE EMC Society website at www.emcs.org.

The EMC Society is also active in technical conferences and symposia through its sponsorship of the annual International Electromagnetic Compatibility Symposium and participation in other worldwide symposia. Symposia and conferences are announced in the EMC Society Newsletter.

The IEEE Symposium on Electromagnetic Compatibility will be held in Long Beach, Calif. USA from August 14-19, 2011. Visit the Symposium website at www.emc2011.org.

The EMC Society has published a number of standards. For information on EMC Society and other IEEE standards, contact the IEEE Operations Center, 445 Hoes Lane, P.O. Box 6804, Piscataway, NJ 08855-1331; Phone: (732) 981-0060.

#### 2012 Events

#### **IEEE EMC Society Board of Directors Meetings**

- March 16-18, 2012, Scottsdale, Arizona
- August 5 and 9, 2012, Pittsburgh, Pennsylvania
- November 16-18, 2012, Raleigh, North Carolina

#### **IEEE EMC Chapter Colloquium and** Exhibition"Table-Top Shows"

- March 5, Williamsburg, Virginia, Advances in Antenna Test and Measurement, Various speakers, with keynote address by Erik Vedeler, Head of Electromagnetics and Sensor Branch at NASA Langley Research Center
- March 27, Milwaukee, Wisconsin, Jeremy Campbell, PE, General Motors, Applied Technology Center, "Designing a Product to Meet Today's Emission and Immunity Requirements"
- April 11Beaverton, Oregon, Elya Joffe, Lead author of the book "The Grounds for Grounding", will discuss grounding and other EMC-related
- May 8, Chicago, Illinois, Speakers and topics to be announced
- May 16, Detroit, Michigan, Todd Hubing of

Clemson University on Automotive EMC Topics
 October 11, Santa Clara, California, with speakers Doug Smith on ESD and Dr. Ege Engin of San Diego State University on Power Integrity

### **IEEE Product Safety Engineering Society**

#### While product safety had been addressed in

various committees over the years, there was never a professional society or symposium solely devoted to product safety engineering as a discipline until recently. The IEEE Product Safety Engineering Society (PSES) began operation on 1 January 2004.

The field of interest of the Society is the theory, design, development and implementation of product safety engineering for electronic and electro-mechanical equipment and devices. This includes the theoretical study and practical application of analysis techniques, testing methodologies, conformity assessments, and hazard evaluations.

The Society's mission is to strive for the advancement of the theory and practice of applied electrical and electronic engineering as applied to product safety and of the allied arts and sciences.

The Society provides a focus for cooperative activities, both internal and external to IEEE, including the promotion and coordination of product safety engineering activities among IEEE entities. In addition, the Society will provide a forum for product safety engineering professionals and design engineers to discuss and disseminate technical information, to enhance personal product safety engineering skills, and to provide product safety engineering outreach to engineers, students and others with an interest in the field. The Society is accepting members at any time during the calendar year, both full IEEE members and affiliate members. Membership is available at www. ieee.org/services/join/.

The IEEE Product Safety Engineering Society works closely with various IEEE Societies and Councils that also include product safety engineering as a technical specialty. Currently there are 14 chapters with more in the formation process.

Every year, the PSES hosts a Symposium on Product Compliance Engineering. The next conference will be in Portland, Oregon, USA on November 5-7, 2012. The Symposium will consist of Technical Sessions, Workshops, Tutorials and Demonstrations specifically targeted to the compliance engineering professional. Attendees will have the opportunity to discuss problems with vendors displaying the latest regulatory compliance products and services. For more information, visit http://www.ieee-pses.org/symposium/. Past papers from the Symposia are available in IEEE Xplore or on CD (for a fee).

In addition to hosting an annual conference, the PSES provides the opportunity for product safety engineers to publish technical papers in a newsletter. See http://www.

ieee-pses.org/newsletters.html. For further information and details on the Society, including becoming an author, please visit the website at www.ieee-pses.org.

#### dB Society

#### This unique, interesting, and exclusive fraternity

of EMC engineers was founded in 1975 by 10 eminent EMC engineers. The purpose of the dB Society is to open doors within the EMC community. Its primary objectives are to greet and to welcome new engineers, suppliers, vendors, and manufacturers to the EMC community and to assist them in establishing contacts in the EMC field.

The following membership requirements are unique and rigidly enforced:

- Ten years of service to the EMC community,
- Five years of service to a recognized professional, EMC organization,
- Sponsorship by two Duo-Decade members,
- Favorable recommendations by three other recognized individuals in the EMC community, and
- · Acceptance by the Admissions Board.

Business meetings and informal, relaxed get-togethers take place during major EMC functions. A formal evening social function is the highlight of each year and is usually conducted during the IEEE EMC Symposium. All meetings are for members only.

U.S. membership is limited to 100 EMC engineers. There are Society affiliates in the United Kingdom, India, and Israel. Qualified candidates are invited to write to:

#### The dB Society

22117 NE 10th Place Sammamish, WA 98074 FAX: (425) 868-0547 E-mail: j.n.oneil@ieee.org

#### **ESD** Association

#### Headquarters:

ESD Association 7900 Turin Road, Building 3 Rome, NY 13440-2069 phone: 315-339-6937 fax: 315-339-6793 email: info@esda.org

website: www.esda.org

#### Founded in 1982, the ESD Association is a pro-

fessional voluntary association dedicated to advancing the theory and practice of electrostatic discharge (ESD) avoidance. From fewer than 100 members, the Association has grown to more than 2,000 members throughout the world. From an initial emphasis on the effects of ESD on electronic components, the Association has broadened its horizons to include areas such as textiles, plastics, web pro-

cessing, cleanrooms, and graphic arts. To meet the needs of a continually changing environment, the Association is chartered to expand ESD awareness through standards development, educational programs, local chapters, publications, tutorials, certification, and symposia.

#### **ELECTROSTATIC DISCHARGE (ESD) TECHNOLOGY ROADMAP**

In the late 1970s, electrostatic discharge, or ESD, became a problem in the electronics industry. Low-level ESD events from people were causing device failures and yield losses. As the industry learned about this phenomenon, both device design improvements and process changes were made to make the devices more robust and processes more capable of handling these devices. With devices becoming more sensitive through the year 2010, it is imperative that companies begin to determine the ESD capabilities of their handling processes. The ESD Technology Roadmap can be downloaded at: www.esda.org

#### **ANSI/ESD S20.20 CONTROL PROGRAM** STANDARD AND CERTIFICATION

A primary direction for the association is the continued implementation of a facility certification program in conjunction with ISO registrars. With the association's ESD control program standard, ANSI/ESD S20.20: Protection of Electrical and Electronic Parts, Assemblies and Equipment (Excluding Electrically Initiated Explosive Devices), the Association offers a means of independently assessing a company's ESD control program and of issuing a formal ANSI/ESD S20.20 certification.

The ANSI/ESD S20.20 standard covers the requirements necessary to design, establish, implement, and maintain an ESD control program to protect electrical or electronic parts, assemblies and equipment susceptible to ESD damage from Human Body Model (HBM) discharges greater than or equal to 100 volts. Developed in response to the Military Standardization Reform Act, ANSI/ESD S20.20 has been formally adopted for use by the U.S. Department of Defense.

Although ESD programs have been part of some ISO 9000 audits in the past, the assessment frequently has been cursory and actual judgment of the program has been left to the individual auditor. ANSI/ESD S20.20 provides a formal, consistent process standard that can be audited. It provides a single, auditable ESD standard for OEM's, suppliers, and contractors. To date, there are approximately 132 facilities in 13 countries that have become ANSI/ESD S20.20 certified.

Accredited registrars conduct the actual assessments of the companies. The association has developed a training program for the registrars and supervises registrar witness audits. This independent assessment of a company's ESD control program could be performed as part of the company's ISO 9000 surveillance audit or as a separate audit. Currently, there are 161 trained auditors in 13 countries who have been certified to conduct ANSI/ESD S20.20 audits.

In addition, the ESD Association offers an ESD program

documentation review service. For a fee of \$1,500 (US), members of the ESD Association's Facility Certification committee will review your ESD program documentation and will compare it to the requirements listed in ANSI/ ESD S20.20-2007. Facilities that choose to become certified will use the ANSI/ESD S20.20-2007 standard as the basis for their certification. A report will be provided that describes the areas that need to be improved for documentation to be compliant with ANSI/ESD S20.20-2007. This service should be considered a MUST for any company that is preparing for facility certification based on ANSI/ESD S20.20-2007.

#### SYMPOSIA, TUTORIALS, AND PUBLICATIONS

As part of its commitment to education and technology, the association holds the annual EOS/ESD Symposium, which places major emphasis on providing the knowledge and tools needed to meet the challenges of ESD. Scheduled for September 9-14, 2012, at the Westin Tucson, La Poloma, Arizona, USA, the annual Symposium attracts attendees and contributors from around the world. Technical sessions, workshops, authors' corners, seminars, tutorials, and technical exhibits provide a myriad of opportunities for attendees to expand their knowledge of ESD.

In addition to tutorials and seminars, the association offers a number of publications and reference materials for sale. These range from proceedings of past EOS/ESD Symposia to textbooks written by experts in the field of ESD.

#### **TechAmerica**

#### **Electromagnetic Compatibility Committee** (G-46) Headquarters

**TechAmerica** 1401 Wilson Blvd., Suite 1100 Arlington, VA 22209 Phone: (703) 284-5344 www.geia.org

#### TechAmerica is the association that was cre-

ated by the merger of AeA and ITAA. Earlier in 2008, ITAA and GEIA merged. The result of these mergers is an organization that is the leading voice for the U.S. technology industry, which is the driving force behind productivity growth and jobs creation in the United States. TechAmerica is the technology industry's only grassroots-to-global advocacy network. With nearly 1200 member companies, 20 regional councils and offices in Beijing and Brussels, the association represents the full spectrum of the technology industry.

TechAmerica is the technology industry's only grassroots-to-global advocacy network. The organization has expanded initiatives in areas such as: information Assurance / Information Security, Identity Management, Cloud Computing, Global Sourcing / Globalization, Intelligence agencies, Department of Defense & NASA, and State & Local programs and public policy advocacy.

TechAmerica provides programs for business development, networking and market intelligence in the Federal arena, dealing with government entities such as Department of Defense, Homeland Security, Federal Communications Commission, Federal Trade Commission,, Congress, as well as with state and local governments.

TechAmerica has a team of public policy professionals at state, federal and international levels, that allow the organization to successfully influence legislative and regulatory issues that affect member companies.

In addition, TechAmerica offers an active standards development program to provide industry with proven solutions to business process challenges. The program is nationally and internationally recognized for its leadership and expertise in the development of standards. Configuration Management, Systems Engineering, Systems Safety, Earned Value Management, Logistics, Reliability and Electromagnetic Compatibility (EMC) area where TechAmerica is involved in standard.

The Electromagentic Compatibility (EMC) Committee (formally known as G-46) deals with the system-oriented discipline that ensures electromagnetic compatibility in electronics design. The Committee develops technical criteria and procedures to guide the design engineer. Its work also includes spectrum management and conservation; secure communications; and electromagnetic emissions, susceptibility, control, and characterization.

The EMC Committee was established to provide an industry/user position on government specifications, regulations, and standards. Participation has expanded to include G-46 representation on the various committees drafting government specifications and standards. For example, G-46 participated on the working committees for MIL-STD-464A and MIL-STD-461E and provided update recommendations to MIL-STD-461F. The scope of G-46 activities has expanded to foster and facilitate the EMC discipline for the benefit of TechAmerica member companies.

Committee activities include spectrum management and conservation; personnel safety; and health care electronics design, usage and installation in terms of regulated and non-regulated electromagnetic (EM) emissions and immunity. Inter- and intra-environmental areas as they affect systems, subsystems and equipment, subassemblies, and components are also areas of concern. In addition to other activities, committees:

- Review, assess, advise, and coordinate related activities of organizations/individuals in government, industry, and technical societies.
- Assure that EMC legislation, regulations, specifications, standards, requirements, and evaluation procedures are adequate for procurement and application.
- Assure that EMC legislation, regulations, specifications, standards, requirements, and evaluation procedures are harmonized with their commercial counterparts to the maximum extent practical for procurement and application.

- Propose and recommend action and provide support to other organizations, as deemed desirable.
- Coordinate and promulgate information to facilitate advancement of the state-of-the-art.

Additional information on TechAmerica and the EMC Committee (G-46) can be obtained at (703) 284-5315, phyllis.call@techamerica.org, or via the GEIA website at http://www.geia.org.

#### **Society of Automotive Engineers**

#### Committee AE-4, Committee Headquarters:

Society of Automotive Engineers 400 Commonwealth Drive Warrendale, PA 15096-0001 Phone: (724) 776-4841

#### SAE International is a professional society of

engineers dedicated to a broad spectrum of engineering disciplines within the aerospace and automotive fields. Under the SAE Aerospace Council, technical standards committees address disciplines ranging from electrical power to multiplex signal characteristics—and from fiber optic data transmission to electromagnetic compatibility. The many elements of EMC are handled by SAE Committee AE-4, Electromagnetic Compatibility, which was organized in 1942 under the Aerospace Council. The committee is composed of technically qualified members, liaison members, and consultants—all of whom are responsible for writing standards on electromagnetic compatibility.

Committee AE-4 provides assistance to the technical community through standardization, improved design and testing methodology, and technical forums for the resolution of mutual problems. Engineering standards, specifications, and technical reports are developed by the Committee and are issued by the Society for industry and governments worldwide. Objectives of Committee AE-4 are to advance the state of technology, to stabilize existing technology, to obtain a uniformity of EMC requirements among government agencies, and to further the interests of the EMC technical community. The theme of "design before the fact" for EMC is a guiding concept. Special attention is given to maintenance of EMI control requirements consistent with the rapidly advancing state-of-the-art.

The following is a partial list of documents that have been issued to assist in implementing SAE objectives. For a complete list, visit the SAE website at www.sae.org or call SAE Customer Service at (724) 776-4841.

#### **AEROSPACE RECOMMENDED PRACTICES (ARPS)**

| VBB 032V  | Control Plan/Technical Construction File        |
|-----------|---|
| AIII JOJA | Control Flan, reclinical Construction File      |
| ARP 936A  | Capacitor, 10 mF for EMI Measurements           |
| ARP 958C  | Electromagnetic Interference Measurement Anten- |
|           | nas, Standard Calibration Method                |
| ARP 958D  | Electromagnetic Interference Measurement Anten- |

interferencetechnology.com INTERFERENCE TECHNOLOGY 133

|     |       | nas, Standard Calibration Method                     |
|-----|-------|--|
| ARP | 1172  | Filters, Conventional, EMI Reduction, Specifications |
|     |       | for  |
| ARP | 1173  | Test Methods for EMI Gasketing                       |
| ARP | 1267  | EMI Measurement of Impulse Generators, Standard      |
|     |       | Calibration Requirements and Techniques              |
| ARP | 1481A | Corrosion Control and Electrical Conductivity in     |
|     |       | Enclosure Design                                     |
| ARP | 1705  | Coaxial Test Procedure to Measure the RF Shielding   |
|     |       | Characteristics of EMC Gasket Materials              |
| ARP | 1870  | Aerospace Systems Electrical Bonding and Ground-     |
|     |       | ing for Electromagnetic Compatibility and Safety     |
| ARP | 1972  | Recommended Practices and Procedures for EMC         |
|     |       | Testing  |
| ARP | 4043A | Flightline Bonding and Grounding of Aircraft         |
| ARP | 4242  | Electromagnetic Compatibility Control Require-       |
|     |       | ments, Systems                                       |
| ARP | 4244  | Recommended Insertion Loss Test Methods for EMI      |
|     |       | Power Line Filters                                   |

#### **AEROSPACE INFORMATION REPORTS (AIRS)**

EMI on Aircraft from Jet Engine Charging

mission Lines for EMI Susceptibility Testing

AIR 1209 Construction and Calibration of Parallel-Plate Trans-

AIR 1147

| AIR | 1221  | EMC System Design Checklist                          |
|-----|-------|--|
| AIR | 1255  | Spectrum Analyzers for EMI Measurements              |
| AIR | 1394A | Cabling Guidelines for Electromagnetic Compatibil-   |
|     |       | ity  |
| AIR | 1404  | DC Resistivity vs. RF Impedance of EMI Gaskets       |
| AIR | 1423  | EMC on Gas Turbine Engines for Aircraft Propulsion   |
| AIR | 1425A | Methods of Achieving EMC of Gas Turbine Engine       |
|     |       | Accessories, for Self-Propelled Vehicles             |
| AIR | 1499  | Recommendations for Commercial EMC Susceptibil       |
|     |       | ity Requirements                                     |
| AIR | 1662  | Minimization of Electrostatic Hazards in Aircraft    |
|     |       | Fuel Systems   |
| AIR | 1700A | Upper Frequency Measurement Boundary for             |
|     |       | Evaluation of Shielding Effectiveness in Cylindrical |
|     |       | Systems  |
| AIR | 4079  | Procedure for Digitized Method of Spark Energy       |
|     |       |  |

#### **SAE AE-4 ELECTROMAGNETIC ENVIRONMENTAL EFFECTS (E3 OR EMC) COMMITTEE**

The SAE AE-4 E3 Committee provides a technical, coordinating, and advisory function in the field of E3. The focus is on problem areas in which committee expertise can be effectively applied at the national and international levels. Electrical and electronic accessories are studied for compatibility within systems and with various communications media. Engineering standards, specifications, and technical reports are developed and are issued for the general information of industry and government.

In the past, subcommittees have included AE-4R, Aircraft Radiated Environments, and AE-4H, High Power RF Simulators and Effects. AE-4 E3 holds national meetings in

conjunction with the IEEE EMC Society Symposium, usually held in August at various locations. Additional information about meetings or more specific information on the activities of the Committee can be obtained by contacting:

Dorothy Lloyd

Aerospace Standards Specialist Society of Automotive Engineers 400 Commonwealth Drive Warrendale, PA 15096-0001

Phone: (724) 776-4841

dlloyd@sae.org

or the Chairman, Gary Fenical, gfenical@lairdtech.com. Visit the SAE's Technical Standards Committee Forum website at http://forums@sae.org.

#### **INARTE**

#### iNARTE, Inc. (The International Association for

Radio, and Telecommunications and Electromagnetics, Inc.) was founded as a non-profit membership/certification organization in 1982. With the advent of deregulation and the Federal Communications Commission's "encouragement/urging" private industry to establish certification standards to fill the licensing void, iNARTE initiated and developed a comprehensive certification program for telecommunications engineers and technicians.

In 1988, a Command of the United States Navy, seeking a credible and respected certification entity, selected iNARTE as the administrative agent for the certification of engineers and technicians in the field of electromagnetic compatibility (EMC).

In 1993, iNARTE, certified by the Federal Communications Commission (FCC) as a Commercial Operators License Examination Manager (COLE Manager), was authorized to administer all examination elements for FCC licensure (formally an FCC responsibility).

In 1994, the ESD Association selected NARTE to implement and administer a certification program for Electrostatic Discharge Control Engineers and Technicians.

During 1997, two nations, China and Japan, requested iNARTE assistance in the establishment of specific incountry certification programs comparable to and able to meet iNARTE certification standards.

In 2000, iNARTE established the Unlicensed Wireless Systems Installer certification to identify fully qualified design and installation personnel. This certification accredits professionals who design and install wireless systems that do not require a license from the FCC—including information systems, security systems, and transportation systems.

In 2001, iNARTE developed an Agreement with the IEEE EMC Society for the co-promotion of awareness and education in EMC/EMI fields. Today the EMC Society is the keeper of the body of knowledge from which the iN-ARTE examinations are derived.

In 2003 iNARTE, together with specialist partners, developed the Product Safety certification program. The Product

Measurement

Safety program accredits professionals who use hazard-based analysis to identify and develop solutions to eliminate or minimize safety hazards. In 2004 iNARTE signed an Agreement with the IEEE Product Safety Engineering Society, PSES, to co-promote awareness and education in Product Safety. Today, technical experts within the PSES assist iNARTE in the development of the examination question pools.

In 2006 iNARTE executed Agreement with ANSI ASC 63, the Accredited Standards Committee on EMC, for the purposes of joint cooperation and promotion in education and technical achievement in EMC engineering.

By 2007, the global interest and participation in iN-ARTE Certification programs had resulted in almost one quarter of members being from overseas countries. In recognition of this, the iNARTE Board of Directors voted unanimously to change the Association name to the, "International Association for Radio. Telecommunications and Electromagnetics, iNARTE."

As iNARTE, an agreement of mutual support and cooperation was signed with the ESD Association in 2007. The ESDA will assist iNARTE in formulating and maintaining the question pools from which certification examinations are derived.

Website: www.inarte.org

### ACIL—The American Council of Independent Laboratories

#### The American Council of Independent Laboratories

(ACIL) is the trade association representing independent, commercial engineering, and scientific laboratory, testing, consulting, product certifying, and R&D firms; manufacturers' laboratories; related non-profit organizations; and consultants and suppliers to the industry. The organization was founded in 1937. All ACIL activities focus on its mission: to enhance members' success by providing advocacy, education, services, and mutual support and by promoting ethics, objectivity, independence, and free enterprise.

ACIL is a voluntary, non-profit membership organization. Programs are determined by members, administered by an elected Board of Directors, and supported by a professional staff operating from headquarters in Washington, D.C.

#### **ACIL'S CONFORMITY ASSESSMENT SECTION**

ACIL's Conformity Assessment Section consists of firms with wide and varied interests, all performing testing, listing, or labeling in accordance with applicable safety and performance standards, and/or materials testing and resolution of product and structural problems. Several committees have evolved within the Section to meet the needs of its diverse membership, including the EMC Committee, the U.S. Council of EMC Laboratories, and the Third-Party Product Certifiers Committee. In January 2005, the Section sponsored a booth at the Consumer Electronics Show that advocated the advantages of independent third-party test-

ing and the capabilities of ACIL member EMC laboratories.

#### **ACIL'S EMC COMMITTEE**

ACIL's EMC Committee was established in 1996 to address the common concerns of the ACIL EMC community. The Committee sponsors educational sessions at ACIL meetings that include both technical and policy issues such as mutual recognition agreements (MRAs). The Committee updates members on the latest developments, upcoming requirements, and activities in the field—both domestic and international.

In January 2002, ACIL published a 143-page document, Technical Criteria for the Accreditation of Electromagnetic Compatibility (EMC) and Radio Testing Laboratories, a checklist to assist both assessors and laboratories.

The Committee also formed the U.S. Council of EMC Laboratories (USCEL) in an effort to aid U.S. laboratories in addressing technical issues arising from the U.S./EU MRA and other global concerns. As the USCEL Secretariat, ACIL provides staff and supports volunteers active in this important area.

Over the past several years, ACIL has administered round robin proficiency testing programs with two arti-

s allowing laboratories to make both AC line conducted radiated emissions measurements over the frequency range of 0.15–30 MHz and 30 MHz–1 GHz, respectively. While continuing the round robins in the frequencies noted above, ACIL has launched another round robin with a new test artifact. This artifact will allow participating laboratories to demonstrate proficiency for radiated emissions measurements in the frequency range of 1–18 GHz. Emissions measurements above 1 GHz are becoming increasingly common with the advent of fast processors and wireless devices in the 2.4- and 5-GHz bands.

ACIL also was instrumental in the formation of the Telecommunication Certification Body Council (TCBC). New rules establishing TCBs were adopted by the FCC in December 1998, providing more options for manufacturers—they can now choose to have their product certified by either the FCC or a private certification body (TCB). A TCB may approve equipment subject to certification (e.g., transmitters, telecom terminal equipment, or scanning receivers). The TCB Council addresses the specific concerns of the TCB community and all constituent bodies are permitted to participate.

#### **U.S. PRODUCT CERTIFIERS**

Key U.S. product certifiers are ACIL members and are reaping many benefits, such as participation in the ACIL Third-Party Product Certifiers Committee (3P<sup>2</sup>C<sup>2</sup>). This Committee provides a forum for members to discuss and to act upon various issues of common interest. This committee formed the American Council for Electrical Safety to serve as a forum among testing laboratories, regulators, and electrical inspectors.

Website: www.acil.org

# GOVERNMENT DIRECTORY

The following is a list of the principal U.S., NATO and Canadian

Government personnel known to be involved in the interference technology field. This list is based upon best available data at the time of publication. Additions, deletions and corrections for any facility may be updated at any time by e-mailing your changes to slong@interferencetechnology.com.

#### DEPARTMENT OF DEFENSE

| Defense S | pectrum ( | Organization |
|-----------|-----------|--------------|
|           |           |              |

DSO Director: Ms. Paige R. Atkins......(703) 325-2567 Paige.Atkins@disa.mil

DSO Dep Dir: Mr. Ralph Puckett...... (703) 325-2874 Ralph.Puckett@disa.mil

#### Strategic Planning Office (SPO)

SPO Director: Mr. Steven A. Molina .... (703) 325-0435 Steven.Molin@disa.mil Internat'l Team Lead: Mr. Chris Hofer... (703) 325-2876

EST Team Lead: Ms. Mary Lin.....(703) 325-0136 National Team Lead: Mr. Dan O'Neill ... (703) 325-2606

#### Joint Spectrum Center (JSC)

2004 Turbot Landing, Annapolis, MD 21402-5064 Tel: (410) 293-4957, Fax: (410) 293-2631

#### Commander, JSC (J00):

COL John J. HICKEY Jr., USA .....(410) 293-2450 John.Hickey@jsc.mil Commander's Group: commander@jsc.mil

#### Technical Director (J01):

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#### Executive Officer (J02):

CDR Robert "Jeff" Lamont, USN .....(410) 293-2452 Jeff.Lamont@jsc.mil

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#### Spectrum Management Information Technology Division (J6):

Acting Chief: Mr. Joseph R. Whitworth.....

#### ......(410) 293-9822 Plans and Resources Division (J7):

Chief: Mrs. Joanne F. Sykes ...... (410) 293-2356 ioanne.svkes@isc.mil

#### Applied Engineering Division (J8):

Chief: Aaron Leong, Lt Col, USAF...... (410) 293-2682 Aaron.Leong@jsc.mil Senior Engineer: Mr. Irving Mager, Jr. (J8) ..... .....(410) 293-2103 irving.mager@jsc.mil Chief, DSRMA: Mr. Ted Grove.....(410) 293-2222

#### Joint Frequency Management and **Spectrum Engineering Office, Atlantic** (JFMO LANT)

Director JFMO LANT (USJFCOM/J63) 1562 Mitscher Ave., Ste. 200 Norfolk, VA 23551-2488 Tel.: (757) 836-8006

#### UNITED STATES AIR FORCE

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#### Aeronautical Systems Center (ASC) 312/326 AE SW (Fighter Bomber Wing) 702 AE SG (B-2)

2690 C St., B556

Wright-Patterson AFB, OH 45433-7424

Dr. Phil Beccue....(937) 255-6881 Philip.Beccue@wpafb.af.mil

#### **Aeronautical Systems Center (ASC)** 312/326 AE SW (Fighter Bomber Wing)

#### 651 AE SS (B-52)

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.....(937) 255-7025 Mr. Jeremy Burns ..... jeremy.burns@wpafb.af.mil

#### **HQ Air Force Material Command (AFMC)** AFMC/EN P

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#### **Aeronautical Systems Center (ASC)** 516 AE SW (Mobility)

836 AE SG (Tankers) 2530 Loop Road West,

Wright-Patterson AFB, Ohio 45433

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#### Air Force Research Laboratory, Sensors Directorate AFRL/RYWD

2241 Avionics Circle

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**EMI Laboratory** 

Fax: (937) 656-9047

Mr. Steven Coffman.....(937) 528-8673 steven.coffman.ctr@wpafb.af.mil

#### **Aeronautical Systems Center Reconnaissance Systems Wing** 303 AE SG (Global Hawk)

2640 Loop Road West Wright-Patterson Air Force Base, OH 45433-7106 Mr. Dave Osborn.....(937) 255-7437 david.osborn@wpafb.af.mil

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## PRODUCTS & SERVICES INDEX

INTERFERENCE TECHNOLOGY'S 2012 EMC Products & Services Index contains approximately 250 different categories to help you find the equipment, components, and services you need. Locate additional product information by consulting the Advertiser Index on page 168. Full details of all the suppliers listed within each category can be found in the Company Directory, starting on page 151. For individual Products & Services Indeces broken out by category, see the box at the bottom of this page.

#### ABSORBER CLAMPS

DNB Engineering, Inc. ETS-Lindgren Fischer Custom Communications

#### ABSORPTIVE FILTERS

Dontech, Inc. Instruments for Industry (IFI) Intermark (USA) Inc.

#### **ACTIVE FILTERS**

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**Advanced Test Equipment Rentals** AE Techron, Inc. **Amber Technologies** Applied Systems Engineering, Inc. **AR Receiver Systems** AR RF/Microwave Instrumentation **CAP Wireless** Comtech PST Corp. CPI (Communications & Power Industries) dB Control Instruments for Industry (IFI) MCL, Inc., A MITEQ Company MILMEGA Ltd. Noise Laboratory Co., Ltd. NP Technologies, Inc. Ophir RF Pasternack Enterprises Power Products International Ltd. Quarterwave Corporation Silicon Labs Teseq

#### ANECHOIC CHAMBER **CALIBRATION TO IEC 80-3**

ETS-Lindgren Panashield

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D.A.R.E!! Instruments DNB Engineering, Inc. Electronics Test Centre (Kanata) ETS-Lindgren National Technical Systems Radiometrics Midwest Corp. **Retlif Testing Laboratories** TUV SUD America Inc.

#### ANECHOIC CHAMBERS

Albatross Projects GmbH ETS-Lindaren Videon Central Inc.

#### **ANECHOIC CHAMBERS -FIRE PROTECTION**

ETS-Lindgren

#### ANECHOIC MATERIALS

ETS-Lindgren Fair-Rite Products Corp.

#### ANTENNA FILTERS

Captor Corp. Fotofab Spectrum Advanced Specialty **Products** 

#### ANTENNA MASTS

ETS-Lindgren

#### **ANTENNAS**

A.H. Systems, Inc. Advanced Test Equipment Rentals Applied Electromagnetic Technology LLC AR RF/Microwave Instrumentation ARA Technologies **Beehive Electronics** Com-Power Corp. Dynamic Sciences International, Inc. Electro-Metrics Corp. ETS-Lindgren **Fotofab** Instruments for Industry (IFI) Laird Technologies Liberty Labs, Inc. **Lubrizol Conductive Polymers** Noise Laboratory Co., Ltd. Q-par Angus Ltd. Spectrum Advanced Specialty **Products** Sunol Sciences Corp. TDK Corp. **TDK RF Solutions** Teseq

#### **ANTISTATIC COATINGS**

Dontech, Inc. Lamart Corp. Swift Textile Metalizing LLC

#### ANTISTATIC MATERIALS

ACL Inc. Swift Textile Metalizing LLC

#### ARCHITECTURAL SHIELDING **PRODUCTS**

Alco Technologies, Inc. Kemtron Ltd.

#### **AUDIO BAND POWER AMPLIFIERS**

AE Techron, Inc.

#### AUTOMOTIVE TESTING

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#### BACKSHELLS, SHIELDED ASSEMBLIES, TERMINATIONS

Federal-Mogul Corporation **Systems Protection** Kensington Electronics Inc. Northern Technologies Corp.

#### BELLCORE TESTING (SEE TELCORDIA)

D.L.S. Electronic Systems, Inc. National Technical Systems TUV SUD America Inc.

#### **BICONICAL ANTENNAS**

A.H. Systems, Inc. ETS-Lindgren Instruments for Industry (IFI) Liberty Labs, Inc. Noise Laboratory Co., Ltd. Teseq

#### BIDIRECTIONAL COUPLERS

Instruments for Industry (IFI)

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3Gmetalworx World W. L. Gore & Associates, Inc. Kensington Electronics Inc. Mech-Tronics Photofabrication Engineering Inc. Precision Photo-Fab, Inc. Schlegel Electronic Materials Tech-Etch. Inc. United Western Enterprises, Inc Kemtron Ltd.

#### **BOOKS**

**Henry Ott Consultants** ITEM Media Kimmel Gerke Associates, Ltd. Montrose Compliance Service

#### BRAID

Alco Technologies, Inc. Calmont Wire & Cable, Inc. Federal-Mogul Corporation **Systems Protection** Syscom Advanced Materials

#### BROADBAND EMI DETECTORS

**Advanced Test Equipment Rentals** Agilent Technologies, Inc. ETS-Lindgren

#### CABINETRY & HARDWARE

FIBOX Enclosures Fotofab

#### **CABLES & CONNECTORS**

**AEF Solutions** Alco Technologies, Inc. **Amphenol Industrial Operations** Brim Electronics, Inc. Calbrooke Marketing Inc. Captor Corp. CONEC Corp. - USA **Electri-Flex Company** ETS-Lindgren

#### **PRODUCTS & SERVICES INDECES BY CATEGORY**

| lest instrumentation .      |  |  |  |  |  |  |  |  |  |  |  | Ш  | IJ |
|-----------------------------|--|--|--|--|--|--|--|--|--|--|--|----|----|
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Federal-Mogul Corporation Systems Protection Fischer Connectors Inc. Fotofab Harwin Hi-Tech Controls Hi-Voltage & EMI Corp. ITT Interconnect Solutions Ja-bar Silicone Corporation Lutze Inc. PennEngineering Positronic Industries Potters Industries, Inc. **PSC Electronics** Qualtek Electronics Corp. **RIA CONNECT** Schaffner EMC, Inc. Schurter Inc. Sealcon Spectrum Advanced Specialty Products Swift Textile Metalizing LLC Teledyne Reynolds Wilcoxon Research Wurth Electronics Midcom Inc.

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A.H. Systems, Inc. Austest Laboratories D.A.R.E!! Calibrations ETS-Lindgren Fischer Custom Communications Instruments for Industry (IFI) LTI Metrology National Technical Systems Pearson Electronics, Inc. Teseq TUV SUD America Inc.

#### **CALIBRATION TESTING**

D.A.R.E!! Calibrations Liberty Labs, Inc.

# CERTIFICATION SERVICES

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#### **CHAMBERS REVERB**

ETS-Lindgren

#### **COAXIAL FILTER CONNECTORS**

Captor Corp. EMC Eupen, A Div. of I2R Corp. Kensington Electronics Inc. Soshin Electronics Europe GmbH Spectrum Advanced Specialty **Products** 

#### COMPETENT/CERTIFIED **ACCREDITING BODIES TESTING**

D.A.R.E!! Instruments D.L.S. Electronic Systems, Inc. Elite Electronic Engineering Co. National Technical Systems

#### **COMPUTER-AIDED ANALYSIS SERVICES**

**Apache Design Solutions** CST of America, Inc. Electronics Test Centre (Kanata) ETS-Lindgren National Technical Systems TUV SUD America Inc. Visron Design, Inc.

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Alco Technologies, Inc. ARC Technologies, Inc. Creative Materials, Inc. Dontech, Inc. **EEMCCOIMEX** Ja-bar Silicone Corporation Kemtron Ltd. Metal Textiles Corp. P&P Technology Ltd. Silicone Solutions Sunkyoung S.T. VTI Vacuum Technologies, Inc. Seal Science Tech-Etch, Inc.

#### **CONDUCTIVE CLOTH**

Alco Technologies, Inc. ARC Technologies, Inc. Dontech, Inc. **Eeonyx Corporation** Federal-Mogul Corporation Systems Protection Intermark (USA) Inc. Ja-bar Silicone Corporation Jinan EMI Shielding Technology Co., Ltd. Kemtron Ltd. Swift Textile Metalizing LLC

#### **CONDUCTIVE COATINGS**

Alco Technologies, Inc. **ALX Technical** Conductive Compounds Inc. Dontech, Inc. **Ja-bar Silicone Corporation** Master Bond Plastic-Metals Technologies, Swift Textile Metalizing LLC VTI Vacuum Technologies, Inc.

#### **CONDUCTIVE CONTAINERS**

MµShield Company, Inc. Swift Textile Metalizing LLC VTI Vacuum Technologies, Inc.

#### **CONDUCTIVE LAMINATES**

Dontech, Inc. Ja-bar Silicone Corporation Kemtron Ltd. Swift Textile Metalizing LLC

3M Electronics Markets

Adhesives Research, Inc.

Alco Technologies, Inc.

**Materials Division** 

**Alchemetal** 

#### CONDUCTIVE MATERIALS

Antistatic Industries of Delaware ARC Technologies, Inc. Caprock Mfg. Cool Polymers, Inc. Creative Materials, Inc. Desco Industries Inc. Device Technologies, Inc. Dontech, Inc. **EEMCCOIMEX Eeonyx Corporation** Federal-Mogul Corporation **Systems Protection** Intermark (USA) Inc. Ja-bar Silicone Corporation Kemtron Ltd. LGS Technologies M&C Specialties Marktek Inc. Master Bond MTI - Microsorb Technologies, Inc. Mueller Corp. Oak-Mitsui Technologies P&P Technology Ltd. Premix Oy Progressive Fillers International Sealing Devices Inc. Sulzer Metco (Canada) Inc. Swift Textile Metalizing LLC Tech-Etch, Inc. THEMIX Plastics, Inc.

# VTI Vacuum Technologies, Inc. **CONDUCTIVE PAINT**

Alco Technologies, Inc. Dontech, Inc. Swift Textile Metalizing LLC

Venture Tape Corp.

#### **CONDUCTIVE PARTICLES**

Ja-bar Silicone Corporation

# CONDUCTIVE PLASTICS

CAPLING Corp. Cool Polymers, Inc. **Dexmet Corporation**  Dontech, Inc. Premix Oy VTI Vacuum Technologies, Inc.

#### **CONDUCTIVE PLATING**

Dontech, Inc. Ja-bar Silicone Corporation Kemtron Ltd. Swift Textile Metalizing LLC VTI Vacuum Technologies, Inc.

#### **CONDUCTIVE TAPES**

Alco Technologies, Inc. Bystat International Inc. Dontech, Inc. Intermark (USA) Inc. ITW/Pressure Sensitive Adhesives & Components Ja-bar Silicone Corporation Kemtron Ltd. **M&C Specialties** P&P Technology Ltd. Swift Textile Metalizing LLC

#### CONDUIT, ELECTRICAL, SHIELDED, MAGNETIC & RF

Federal-Mogul Corporation Systems Protection Ja-bar Silicone Corporation Kemtron Ltd. VitaTech Electromagnetics

#### CONSULTANTS

Captor Corp. D.A.R.E!! Instruments D.L.S. Electronic Systems, Inc. DNB Engineering, Inc. **Don HEIRMAN Consultants** Elite Electronic Engineering Co. EM Software & Systems EMC Cons Dr. Rasek GmbH **EMC Management Concepts** EMCC Dr. Rasek **EMCMCC EMITEMC Equipment Reliability Institute** ERA Technology Ltd. Trading as Cobham Technical Services ETS-Lindgren Henry Ott Consultants Hoolihan EMC Consulting ITEM Media Kimmel Gerke Associates, Ltd. Montrose Compliance Service, MOOSER Consulting GmbH

NewPath Research L.L.C.

Paladin EMC

Update, add or edit your company's information in the EMC Buyers' Guide at www.interferencetechnology.com Power & Controls Engineering

Power Standards Lab (PSL) Radiometrics Midwest Corp. **Retlif Testing Laboratories** TUV SUD America Inc. Wyatt Technical Services LLC

#### COUPLING-DECOUPLING **NETWORKS**

Haefely EMC

#### CRT ELECTRO-OPTICAL **SHIELDS**

Dontech, Inc. MµShield Company, Inc.

#### **CURRENT PROBES**

A.H. Systems, Inc. ETS-Lindgren **Fischer Custom Communications** Pearson Electronics, Inc.

#### **DESIGN SOFTWARE**

AR RF/Microwave Instrumentation **AWR Corporation** CST of America, Inc. **EM Software & Systems** Moss Bay EDA Sonnet Software, Inc.

#### **DIE CUT SHIELDING MATERIAL**

Apex Die & Gasket Inc. Dontech, Inc. W. L. Gore & Associates, Inc. **Identification Products Corp** Ja-bar Silicone Corporation Kemtron Ltd. Orion Industries Inc. P&P Technology Ltd. Spira Manufacturing Corp. Tech-Etch, Inc.

#### DIRECT LIGHTNING TESTING

DNB Engineering, Inc. Electronics Test Centre (Kanata) National Technical Systems TUV SUD America Inc.

#### **DISCOIDAL CAPACITORS**

Union Technology Corp.

#### E-FIELD ANTENNAS

A.H. Systems, Inc. **Advanced Test Equipment Rentals** AR RF/Microwave Instrumentation ETS-Lindgren

Instruments for Industry (IFI) Noise Laboratory Co., Ltd.

#### **ELECTRIC FIELD PROBES**

Agilent Technologies, Inc.

#### **ELECTROSTATIC CHARGE** / **DECAY METERS**

Amstat Industries, Inc. TREK, INC.

#### **ELECTROSTATIC DISCHARGE** (ESD) GENERATORS

Advanced Test Equipment Rentals **EM Test USA EMC Partner AG** Haefelv EMC Noise Laboratory Co., Ltd.

#### **ELECTROSTATIC DISCHARGE** (ESD) SIMULATORS

Advanced Test Equipment Rentals CST of America, Inc. **EM Test USA EMC Partner AG Fischer Custom Communications** Haefely EMC HV Technologies, Inc. Liberty Labs, Inc. National Technical Systems Noise Laboratory Co., Ltd.

#### **ELECTROSTATIC DISCHARGE** (ESD) TESTING

D.L.S. Electronic Systems, Inc. DNB Engineering, Inc. Elite Electronic Engineering Co. Radiometrics Midwest Corp. Retlif Testing Laboratories TUV SUD America Inc.

#### **EMI GASKETS**

ACS Industries, Inc. **Boyd Corporation CGS** Technologies **Connors Company** Fabritech, Inc. **GETELEC** W. L. Gore & Associates, Inc. Insulfab Intermark (USA) Inc. Ja-bar Silicone Corporation Kemtron Ltd. P&P Technology Ltd. Spira Manufacturing Corp. Stockwell Elastomerics, Inc. Tech-Etch, Inc.

For more information on these and other EMI/EMC companies, visit the new and improved Interference Technology EMC Buyers' Guide at www.interferencetechnology.com

United Seal and Rubber Co., Inc. VTI Vacuum Technologies, Inc.

#### **EMI RECEIVERS**

Agilent Technologies, Inc. AR RF/Microwave Instrumentation **GAUSS Instruments** Inceleris

#### **EMI TEST ANTENNAS**

A.H. Systems, Inc. Advanced Test Equipment Rentals AR RF/Microwave Instrumentation ETS-Lindgren **Fotofab** Instruments for Industry (IFI) Laird Technologies **TDK RF Solutions** 

#### **EMISSIONS TESTING**

Captor Corp. D.A.R.E!! Instruments D.L.S. Electronic Systems, Inc. DNB Engineering, Inc. **Don HEIRMAN Consultants Electronics Test Centre (Kanata)** Elite Electronic Engineering Co. maturo GmbH Mitsubishi Digital Electronics America Inc.

Montrose Compliance Service, Inc.

National Technical Systems Radiometrics Midwest Corp. **Retlif Testing Laboratories** TUV SUD America Inc. V-Comm, LLC

### **EMP GENERATORS**

**EM Test USA EMC Partner AG Fischer Custom Communications** HV Technologies, Inc.

# **EMP SIMULATORS**

**Advanced Test Equipment Rentals** CST of America, Inc. **EM Test USA EMC Partner AG Fischer Custom Communications** HV Technologies, Inc. Montena Technology sa National Technical Systems

#### EMP, SGEMP SYSTEM ASSESSMENT

DNB Engineering, Inc. Kimmel Gerke Associates, Ltd. National Technical Systems

#### **EMP/LIGHTNING EFFECTS** TESTING

D.L.S. Electronic Systems, Inc. DNB Engineering, Inc. Electronics Test Centre (Kanata) Elite Electronic Engineering Co. National Technical Systems

Radiometrics Midwest Corp. **Retlif Testing Laboratories** Teseq TUV SUD America Inc.

#### ENVIRONMENTAL TESTING

D.A.R.E!! Instruments D.L.S. Electronic Systems, Inc. Elite Electronic Engineering Co. National Technical Systems TUV SUD America Inc.

#### **EUROPEAN CERTIFICATION TESTING**

D.A.R.E!! Instruments D.L.S. Electronic Systems, Inc. DNB Engineering, Inc. Electronics Test Centre (Kanata) Elite Electronic Engineering Co. EMC Testing Laboratories. Inc. EU Compliance Services, Inc. F-Squared Laboratories GTN GmbH & Co. KG INTERTest Systems, Inc. ITL Israel Montrose Compliance Service National Technical Systems Radiometrics Midwest Corp. **Retlif Testing Laboratories** TUV Rheinland Of North America TUV SUD America Inc.

#### **FACILITIES & SHIELDED ENCLOSURE SERVICES**

AR Tech Compac Development Corp. DNB Engineering, Inc. ETS-Lindgren Rittal Corp.

#### FCC PART 15 & 18 TESTING

D.A.R.E!! Instruments D.L.S. Electronic Systems, Inc. DNB Engineering, Inc. Don HEIRMAN Consultants Electronics Test Centre (Kanata) Elite Electronic Engineering Co. Montrose Compliance Service National Technical Systems Radiometrics Midwest Corp. **Retlif Testing Laboratories** TUV SUD America Inc.

#### FCC PART 68 TEST EQUIPMENT

DNB Engineering, Inc. **EM Test USA EMC Partner AG** HV Technologies, Inc. **Retlif Testing Laboratories** 

#### FCC PART 68 TESTING

D.L.S. Electronic Systems, Inc. DNB Engineering, Inc. Electronics Test Centre (Kanata) Elite Electronic Engineering Co. Haefely EMC National Technical Systems

#### FEED-THROUGH FILTERS

Captor Corp. **EMI Filter Company** Instec Filters Radius Power, Inc. RF Immunity Ltd. Schaffner EMC, Inc. Spectrum Advanced Specialty **Products** Syfer Technology Limited TDK-EPC Corp. Tri-Mag, Inc.

#### **FERRITE BEADS & CORES**

AEM, Inc. Allied Components International Cosmo Ferrites Limited Fair-Rite Products Corp. Ferronics, Inc. Intermark (USA) Inc. Kemtron Ltd. Magnet Industry Ltd. MEC Kitagawa National Magnetics Group, Inc. TDK-EPC Corp. THORA Elektronik GmbH

#### **FERRITE SUPPRESSION COMPONENTS**

ARC Technologies, Inc. Fair-Rite Products Corp. Intermark (USA) Inc. Kemtron Ltd. Spectrum Advanced Specialty **Products** 

#### FERRITES

Adams Magnetic Products Co. AEM, Inc. Allied Components International ARC Technologies, Inc. **Dexter Magnetic Technologies** EMC Component Group, Inc. Fair-Rite Products Corp. Intermark (USA) Inc. Kemtron Ltd. Magnet Industry Ltd. MEC Kitagawa Spectrum Advanced Specialty **Products** Taiyo Yuden (U.S.A.) Inc.

#### FIBER OPTIC CABLES

ETS-Lindgren

# FIBER OPTIC SYSTEMS

Accurate Controls Ltd. D.A.R.E!! Consultancy **Fischer Custom Communications** Michigan Scientific Corp. Micronor Inc.

#### FIELD INTENSITY METERS

**EMC Test Design** ETS-Lindgren Instruments for Industry (IFI) Narda Safety Test Solutions S.r.l. Potomac Instruments Inc. SRICO, Inc.

#### FILTER ARRAYS

Captor Corp. **Fotofab** Syfer Technology Limited Spectrum Advanced Specialty **Products** 

#### **FILTER CAPACITORS**

**AVX** Corporation **Beijing Tempest Electronics** Technologies Co. Ltd. Captor Corp. **EMI Filter Company Fotofab** Instec Filters LCR Electronics, Inc. Radius Power, Inc. Schaffner EMC, Inc. Spectrum Advanced Specialty Products Syfer Technology Limited Synergistic Technology Group, TDK-EPC Corp. X2Y Attenuators LLC

#### FILTER CHOKES

Captor Corp. **Datatronics** Fair-Rite Products Corp. LCR Electronics, Inc. Radius Power, Inc. Schaffner EMC, Inc. Schurter Inc.

# **FILTER COILS**

Captor Corp. Communication Coil, Inc. Curtis Industries / Filter Networks Radius Power, Inc. Schaffner EMC, Inc. Schurter Inc.

# FILTER CONNECTORS

**AEF Solutions** Captor Corp. Curtis Industries / Filter Networks Glenair Inc. **Heilind Electronics** Kensington Electronics Inc. Spectrum Advanced Specialty **Products** Spectrum Control Schurter Inc.

#### FILTER MODULES

Captor Corp. Curtis Industries / Filter Networks Elite EMC Ltd. Instec Filters Schaffner EMC, Inc. Schurter Inc.

Spectrum Advanced Specialty **Products** 

#### FILTER PIN CONNECTORS

Captor Corp. Fischer Connectors Inc. Kensington Electronics Inc. Spectrum Advanced Specialty **Products** 

#### **FILTER PINS**

**EMI Filter Company** Instec Filters Spectrum Advanced Specialty **Products** Syfer Technology Limited

#### FILTER SEAL INSERTS

Kensington Electronics Inc. Lamart Corp.

#### **FILTERED POWER ENTRY MODULES**

Americor Electronics, Ltd. Captor Corp. Curtis Industries / Filter Networks Qualtek Electronics Corp. Radius Power, Inc. Schaffner EMC, Inc. Schurter Inc. Spectrum Advanced Specialty **Products** Tri-Mag, Inc.

**FILTERS** Advanced Monolythic Ceramics, Aerodev Electronmagnetic Tech Alco Technologies, Inc. Amphenol Canada Corp. API Delevan Arcotronics, Inc. **Aries Electronics AVX** Corporation Capcon International, Inc. Captor Corp. Cre8 Associates Ltd. Curtis Industries / Filter Networks E3 Displays **EESeal** Electrocube, Inc. Elite EMC Ltd. **EMI Filter Company** EMI Solutions Inc. EPCOS, Inc. ETS-Lindgren

Fil-coil Filter Concepts, Inc. Filtronica, Inc. Fotofab Fuss-EMV Genisco Filter Corp. Gowanda Electronics **High & Low Corporation** Instruments for Industry (IFI) Integrated Microwave Corp.

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### FINGERSTOCK

Ja-bar Silicone Corporation Kemtron Ltd. P&P Technology Ltd. Tech-Etch, Inc.

#### **GROUND RESISTANCE TESTERS**

AEMC Instruments, Inc.

#### **GROUNDING RODS**

Intermark (USA) Inc.

# **GROUNDING SERVICES**

Intermark (USA) Inc.

#### **GROUNDING SYSTEMS**

Intermark (USA) Inc. Lightning Eliminators & Consultants, Inc.

#### **GTEM CELLS**

ETS-Lindgren Fischer Custom Communications Instruments for Industry (IFI) Noise Laboratory Co., Ltd.

#### **H-FIELD ANTENNAS**

A.H. Systems, Inc.

AR RF/Microwave Instrumentation ETS-Lindgren Instruments for Industry (IFI) Noise Laboratory Co., Ltd.

#### HARNESSES

Captor Corp.

#### **HELMHOLTZ COILS**

ETS-Lindgren Fischer Custom Communications

#### HIGH VOLTAGE PULSE **TRANSFORMERS**

Pearson Electronics, Inc.

#### **HONEYCOMB SHIELDING**

ETS-Lindgren Intermark (USA) Inc. Ja-bar Silicone Corporation Kemtron Ltd. P&P Technology Ltd. Spira Manufacturing Corp. Tech-Etch, Inc.

#### **HORN ANTENNAS**

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#### **HYBRID ANTENNAS**

ETS-Lindgren

#### **IMMUNITY TESTING**

A.H. Systems, Inc. D.A.R.E!! Instruments D.L.S. Electronic Systems, Inc. DNB Engineering, Inc. Electronics Test Centre (Kanata) Elite Electronic Engineering Co. LEDE-SIECIT National Technical Systems Radiometrics Midwest Corp. **Retlif Testing Laboratories** Teseq TUV SUD America Inc.

# **IMPULSE GENERATORS**

AR RF/Microwave Instrumentation Compliance West, USA **EM Test USA EMC Partner AG** Haefely EMC HV Technologies, Inc.

Ion Physics Corp. National Technical Systems

#### **INDUCED CURRENT METERS** & PROBES

AR RF/Microwave Instrumentation **EMC Partner AG** ETS-Lindgren

#### **INDUCTORS**

BI Technologies Captor Corp. Curtis Industries / Filter Networks Frontier Electronics, Corp. Gowanda Electronics Kensington Electronics Inc. LCR Electronics, Inc. Micrometals, Inc. Schaffner EMC, Inc. Schurter Inc.

#### **INSERTION LOSS TEST NETWORKS**

Captor Corp.

#### INTERFERENCE GENERATORS

**EMC Partner AG** HV Technologies, Inc.

#### **IRON CORE POWDERED** MAGNETIC MATERIALS

Fair-Rite Products Corp.

#### **ISO 9000 TESTING**

Electronics Test Centre (Kanata) National Technical Systems Swift Textile Metalizing LLC TUV SUD America Inc.

#### ISOTROPIC FIELD SENSORS

D.A.R.E!! Consultancy ETS-Lindaren Instruments for Industry (IFI)

#### LIGHTNING GENERATORS

**Advanced Test Equipment Rentals** Avalon Test Equipment Corp. **EM Test USA EMC Partner AG Fischer Custom Communications** Haefely EMC HV Technologies, Inc. Lightning Technologies, Inc. Noise Laboratory Co., Ltd.

#### LIGHTNING SIMULATORS

**Advanced Test Equipment Rentals** 

Update, add or edit your company's information in the EMC Buyers' Guide at www.interferencetechnology.com **EM Test USA EMC Partner AG Fischer Custom Communications** Haefely EMC HV Technologies, Inc. Noise Laboratory Co., Ltd.

#### LIGHTNING STRIKE TESTING

D.L.S. Electronic Systems, Inc. DNB Engineering, Inc. Elite Electronic Engineering Co. National Technical Systems Pearson Electronics, Inc. Radiometrics Midwest Corp. Retlif Testing Laboratories TUV SUD America Inc.

#### LISNS

ETS-Lindgren

#### LOG PERIODIC ANTENNAS

A.H. Systems, Inc. **Advanced Test Equipment Rentals** AR RF/Microwave Instrumentation ETS-Lindgren Instruments for Industry (IFI) Liberty Labs, Inc. Noise Laboratory Co., Ltd.

#### MAGNETIC FIELD METERS

Combinova AB Ergonomics, Inc. **Fischer Custom Communications** 

#### MAGNETIC FIELD PROBES

Agilent Technologies, Inc. AR RF/Microwave Instrumentation ETS-Lindgren Fischer Custom Communications Langer EMV-Technik GmbH

#### **MAGNETIC SHIELDING**

VTI Vacuum Technologies, Inc.

#### **MAGNETIC SHIELDING GASKETS**

Kemtron Ltd. Spira Manufacturing Corp. VTI Vacuum Technologies, Inc.

#### **MAGNETIC SHIELDS**

VTI Vacuum Technologies, Inc.

#### MICROWAVE ABSORBERS

ARC Technologies, Inc. **ETS-Lindaren** Intermark (USA) Inc. Kemtron Ltd.

#### MICROWAVE FILTERS

Cobham Microwave **EMI Filter Company Fotofab** Instec Filters Instruments for Industry (IFI) LCR Electronics, Inc.

Spectrum Advanced Specialty **Products** Syfer Technology Limited

#### MICROWAVE POWER **AMPLIFIERS**

Advanced Test Equipment Rentals AR RF/Microwave Instrumentation Giga-tronics/Ascor Inc. Instruments for Industry (IFI)

#### MIL-STD 188/125 TESTING

DNB Engineering, Inc. Elite Electronic Engineering Co. National Technical Systems

#### MIL-STD 461 / 462 TESTING

D.L.S. Electronic Systems, Inc. DNB Engineering, Inc. Electronics Test Centre (Kanata) Elite Electronic Engineering Co. **EMC Compliance** Harris Corp (GCSD) **National Technical Systems Retlif Testing Laboratories** Radiometrics Midwest Corp. TUV SUD America Inc. Wyle

#### MOBILE SHIELDED ROOMS

EMI Technologies, Inc. Select Fabricators, Inc. Source1 Solutions Swift Textile Metalizing LLC

#### **MONOPOLE ANTENNAS**

ETS-Lindgren Instruments for Industry (IFI) Liberty Labs, Inc. Noise Laboratory Co., Ltd.

#### MRI SHIELDING

Dontech, Inc. **ETS-Lindaren** MuShield Company, Inc. Select Fabricators, Inc.

#### NAVLAP / A2LA APPROVED **TESTING**

A2LA ATLAS Compliance & Engineering Bay Area Compliance Labs Corp. Compliance Management Group D.L.S. Electronic Systems, Inc. DNB Engineering, Inc. Electronics Test Centre (Kanata) Elite Electronic Engineering Co. Liberty Labs, Inc. National Technical Systems **NU Laboratories** Radiometrics Midwest Corp. TUV SUD America Inc.

#### NETWORK ANALYZERS

Agilent Technologies, Inc.

#### **PARALLEL PLATE LINE TEST SET**

ETS-Lindgren **Fischer Custom Communications** 

#### PORTABLE TEST EQUIPMENT

A.H. Systems, Inc. ETS-Lindgren Haefely EMC HV Technologies, Inc. Instruments for Industry (IFI) MPB Srl Prostat Corp.

#### POWER LINE DISTURBANCE **MONITOR**

Voltech Instruments Ltd.

#### POWER LINE ELECTRONICS

Delta Products Corp.

#### **POWER LINE FILTERS**

Captor Corp. Curtis Industries / Filter Networks DNB Engineering, Inc. Emission Control, Ltd. Filter Concepts, Inc. Genisco Filter Corp. **High & Low Corporation** Instec Filters JINAN Filtemc Electronic Equipment Co., Ltd. LCR Electronics, Inc. MPE Limited Radius Power, Inc. Schaffner EMC, Inc. Schurter Inc. Syfer Technology Limited TDK-EPC Corp. Tri-Mag, Inc.

#### **PRINTED CIRCUIT BOARD (PCB) FILTERS**

Captor Corp. Curtis Industries / Filter Networks Radius Power, Inc. Schurter Inc. Spectrum Advanced Specialty **Products** Syfer Technology Limited Tri-Mag, Inc.

#### **PROBES**

Agilent Technologies, Inc.

#### PRODUCT SAFETY TESTING

D.A.R.E!! Instruments D.L.S. Electronic Systems, Inc. DNB Engineering, Inc. Electronics Test Centre (Kanata) Elite Electronic Engineering Co. Montrose Compliance Service National Technical Systems **Retlif Testing Laboratories** TUV SUD America Inc.

#### **RADHAZ TESTING**

DNB Engineering, Inc. Electronics Test Centre (Kanata) **Retlif Testing Laboratories** 

#### RADIATION HAZARD METERS

ETS-Lindgren

#### RADIATION HAZARD PROBES

ETS-Lindgren Instruments For Industry (IFI)

#### **RETROFIT FILTERS &** CONNECTORS

**Quell Corporation** Schaffner EMC, Inc. Schurter Inc.

#### RF POWER AMPLIFIERS

**Advanced Test Equipment Rentals** AR RF/Microwave Instrumentation Instruments for Industry (IFI) Noise Laboratory Co., Ltd. Teseq

#### RF POWER COMPONENTS

**EM Test USA** MKS Instruments

#### **RF POWER METERS**

Agilent Technologies, Inc. AR RF/Microwave Instrumentation D.A.R.E!! Consultancy ETS-Lindgren

#### RF SHIELDING GASKETS

ARC Technologies, Inc. W. L. Gore & Associates, Inc. Ja-bar Silicone Corporation Kemtron Ltd. P&P Technology Ltd. Spira Manufacturing Corp. Tech-Etch, Inc. VTI Vacuum Technologies, Inc.

#### RF SHIELDING MATERIAL

Axonics, Inc. Cybershield **Dexmet Corporation** Federal-Mogul Corporation **Systems Protection** Feuerherdt GmbH W. L. Gore & Associates, Inc. Intermark (USA) Inc. Ja-bar Silicone Corporation Kemtron Ltd. P&P Technology Ltd. Precision Manufacturing Group Spira Manufacturing Corp. Tech-Etch, Inc. TWP Inc. Universal Shielding Corp.

## RS03 > 200 V / METER TESTING

D.L.S. Electronic Systems, Inc. DNB Engineering, Inc.

Electronics Test Centre (Kanata) Elite Electronic Engineering Co. National Technical Systems Radiometrics Midwest Corp. **Retlif Testing Laboratories** TUV SUD America Inc.

#### RTCA DO-160 TESTING

D.L.S. Electronic Systems, Inc. DNB Engineering, Inc. Electronics Test Centre (Kanata) Elite Electronic Engineering Co. National Technical Systems Radiometrics Midwest Corp. **Retlif Testing Laboratories** TUV SUD America Inc.

#### SCIF DESIGN CONSTRUCTION & MAINTENANCE

ETS-Lindgren

#### SHIELDED AIR FILTERS

ETS-Lindaren Ja-bar Silicone Corporation Kemtron Ltd. P&P Technology Ltd. Spira Manufacturing Corp. Tech-Etch, Inc.

#### SHIELDED BUILDINGS

ETS-Lindgren

#### **SHIELDED CABINETS & HARDWARE**

MµShield Company, Inc. Swift Textile Metalizing LLC

#### SHIELDED CABLE ASSEMBLIES & HARNESSES

Brim Electronics, Inc. Captor Corp. Federal-Mogul Corporation **Systems Protection** Fischer Connectors Inc. Fotofab W. L. Gore & Associates, Inc. Lapp USA MegaPhase LLC Swift Textile Metalizing LLC

#### SHIELDED COMPONENTS

Federal-Mogul Corporation Systems Protection Ja-bar Silicone Corporation Kensington Electronics Inc. Schurter Inc.

Spira Manufacturing Corp. VTI Vacuum Technologies, Inc.

#### SHIELDED CONDUITS

ANAMET Electrical, Inc. **Electri-Flex Company** Federal-Mogul Corporation Systems Protection Zero Ground LLC

#### SHIELDED CONNECTORS

Binder-USA Fischer Connectors Inc. Ja-bar Silicone Corporation Kensington Electronics Inc. Kycon Lutze Inc. PennEngineering Schurter Inc. Southwest Microwave, Inc.

#### SHIELDED DOORS

Dontech, Inc. ETS-Lindgren Swift Textile Metalizing LLC

#### SHIELDED ENCLOSURES

ClickFold Plastics **Electrorack Enclosure Products** EMP-tronic AB IMS Engineered Products Modpak, Inc. MµShield Company, Inc. Select Fabricators, Inc. VTI Vacuum Technologies, Inc.

#### SHIELDED FANS

ETS-Lindgren Spira Manufacturing Corp.

#### SHIELDED FUSE HOLDERS

Schurter Inc.

#### SHIELDED ROOM FILTERS

Captor Corp. Dontech, Inc. ETS-Lindgren **Fotofab** TDK-EPC Corp.

#### SHIELDED ROOMS

Comtest Engineering by ETS-Lindgren Holland Shielding Systems BV I. Thomas GmbH R. A. Mayes Company, Inc.

For more information on these and other EMI/EMC companies, visit the new and improved Interference Technology EMC Buyers' Guide at www.interferencetechnology.com

Select Fabricators, Inc.

#### SHIELDED ROOMS. **ACCESSORIES**

Ad-Vance Magnetics, Inc. Dontech, Inc. ETS-Lindgren Gaven Industries Inc. Leader Tech, Inc. National Technical Systems Shielding Resources Group, Inc. Swift Textile Metalizing LLC

#### **SHIELDED ROOMS & ENCLOSURES**

Alco Technologies, Inc. Allied Moulded Products, Inc. AR Tech **Braden Shielding Systems Bud Industries** Captor Corp. Comtest Engineering by E&C Anechoic Chambers Asia Ltd. EMI Technologies, Inc. EMP-tronic AB ETS-Lindgren Fotofab Frankonia EMC Global EMC Ltd. Holland Shielding Systems BV **IMS Engineered Products** Instruments for Industry (IFI) K-Form, Inc. Modpak, Inc. Noise Laboratory Co., Ltd. ORBIT Advanced Electromagnetics, Inc. (AEMI) R. A. Mayes Company, Inc. Rainford EMC Systems Ltd. Select Fabricators, Inc. Source1 Solutions Spira Manufacturing Corp. Stahlin Enclosures Swift Textile Metalizing LLC Videon Central Inc. VTI Vacuum Technologies, Inc.

#### SHIELDED ROOMS, LEAK DETECTORS / MONITORS

ETS-Lindgren

#### SHIELDED SCANS, **MONITORS & CRTS**

**Dontech Incorporated** 

#### SHIELDED SWITCHES

Schurter Inc.

#### SHIELDED TRANSPARENT **WINDOWS**

Dontech, Inc. Instrument Plastics Ltd. Kemtron Ltd. P&P Technology Ltd. Tempest Security Systems Inc.

#### SHIELDED TUBING

Federal-Mogul Corporation Systems Protection Ja-bar Silicone Corporation Kemtron Ltd. MuShield Company, Inc. Zippertubing Company

SHIELDING 3M Electronics Markets **Materials Division** A&R Tarpaulins, Inc. Alco Technologies, Inc. Amuneal Manufacturing Corp. ANAMET Electrical, Inc. ARC Technologies, Inc. Autosplice, Inc. Axonics, Inc. Bal Seal Engineering, Inc. Calmont Wire & Cable, Inc. **Central Coating Company** Chomerics, Div. of Parker Hannifin Corp. Cima NanoTech, Inc. **Connors Company Dexmet Corporation** Dontech, Inc. East Coast Shielding Ed Fagan Inc. **Emerson & Cuming Microwave** Products, Inc. ETS-Lindgren Fabritech, Inc. Federal-Mogul Corporation **Systems Protection** Feuerherdt GmbH Field Management Services Fotofab W. L. Gore & Associates, Inc. HFC Shielding Prod. Co. Ltd. Insulfab Intermark (USA) Inc. Ja-bar Silicone Corporation **JEMIC Shielding Technologies** JRE Test, LLC Kemtron Ltd. Magnetic Radiation Laboratories Magnetic Shield Corporation MAJR Products Corp. Mekoprint A/S Chemigraphics MH&W International Corp. MuShield Company, Inc. Nolato Silikonteknik Orbel Corp. P&P Technology Ltd. Plastic-Metals Technologies, Precision Manufacturing Group **RFI Controls Company** Roxtec

**Products** Spira Manufacturing Corp. Swift Textile Metalizing LLC Syscom Advanced Materials Tech-Etch, Inc. United Western Enterprises, Inc Universal Air Filter Universal Shielding Corp. Vanguard Products Corp. Vermillion, Inc. VitaTech Electromagnetics WaveZero, Inc. Zero Ground LLC

Spectrum Advanced Specialty

# VTI Vacuum Technologies, Inc. SHIELDING COMPONENTS

**Zippertubing Company** 

Tech-Etch, Inc.

Zuken

#### SHIELDING EFFECTIVENESS **TESTING**

D.A.R.E!! Calibrations D.L.S. Electronic Systems, Inc. DNB Engineering, Inc. Dontech, Inc. Electronics Test Centre (Kanata) Elite Electronic Engineering Co. ETS-Lindgren Federal-Mogul Corporation **Systems Protection** National Technical Systems Radiometrics Midwest Corp. **Retlif Testing Laboratories** TUV SUD America Inc.

# SHIELDING FOILS

Federal-Mogul Corporation Systems Protection Ja-bar Silicone Corporation Kemtron Ltd. MµShield Company, Inc. Tapecon, Inc.

#### SHIELDING MATERIAL. **MAGNETIC FIELD**

Federal-Mogul Corporation **Systems Protection** W. L. Gore & Associates, Inc. Ja-bar Silicone Corporation Kemtron Ltd. Less EMF Inc. Magnetic Shield Corporation MuShield Company, Inc. Spira Manufacturing Corp. Vacuum Schmelze GmbH & Co. VTI Vacuum Technologies, Inc.

#### **SIGNAL GENERATORS**

Agilent Technologies, Inc. AR RF/Microwave Instrumentation D.A.R.E!! Consultancy Praxsym, Inc. York EMC Services Ltd.

#### **SIGNAL LINE FILTERS**

Captor Corp. Curtis Industries / Filter Networks **EMI Filter Company** ETS-Lindgren Instec Filters Spectrum Advanced Specialty **Products** Syfer Technology Limited TDK-EPC Corp. **WEMS Electronics** 

#### SIGNAL LINE ISOLATION **TRANSFORMERS**

Kensington Electronics, Inc.

#### SIMULATION SOFTWARE

**EM Software & Systems EMS-Plus** 

#### SITE ATTENUATION TESTING

D.A.R.E!! Calibrations D.L.S. Electronic Systems, Inc. DNB Engineering, Inc. Electronics Test Centre (Kanata) ETS-Lindaren National Technical Systems Radiometrics Midwest Corp. **Retlif Testing Laboratories** 

#### SITE SURVEY SERVICES

D.A.R.E!! Calibrations D.L.S. Electronic Systems, Inc. DNB Engineering, Inc. Electronics Test Centre (Kanata) Elite Electronic Engineering Co. ETS-Lindgren Kimmel Gerke Associates, Ltd. **National Technical Systems** Radiometrics Midwest Corp. **Retlif Testing Laboratories** 

# SOLID STATE AMPLIFIERS

AE Techron, Inc. AR RF/Microwave Instrumentation Instruments for Industry (IFI)

# SPECTRUM ANALYZERS

Agilent Technologies, Inc. ValueTronics International, Inc.

#### SPREAD SPECTRUM **PRODUCTS**

Mercury United Electronics Inc. SiTime Corp.

#### STANDARDS TRANSLATIONS

Advanced Programs, Inc. **ANDRO Computational Solutions** Electronics Test Centre (Kanata) PGMC Ltd TUV SUD America Inc.

#### STATIC CONTROL MATERIALS & EQUIPMENT

Advanced Test Equipment Rentals

Rubbercraft

Schurter Inc.

Soliani EMC SRL

SAS Industries, Inc.

Seals

Saint-Gobain High Performance

**Specialty Silicone Products** 

Swift Textile Metalizing LLC

#### SUPPRESSORS

ARC Technologies, Inc. Captor Corp. Fair-Rite Products Corp. **Fischer Custom Communications** Kemtron Ltd.

#### **SURGE & TRANSIENTS**

**ACL Staticide** Advanced Test Equipment Rentals Alltec Corporation AMS ARC Technologies, Inc. Avalon Test Equipment Corp. CITEL Inc. **EM Test USA EMC Partner AG** Haefely EMC HV Technologies, Inc. Intermark (USA) Inc. Kikusui America Inc. L. Gordon Packaging Liberty Labs, Inc. MCG Surge Protection Nextek Noise Laboratory Co., Ltd. Okaya Electric America, Inc. Pearson Electronics, Inc. **Phoenix Contact** RTP Company Schurter Inc. Swift Textile Metalizing LLC Transtector Systems Inc.

#### **SURGE PROTECTION**

Alltec Corporation Bourns Inc. Captor Corp. MCG Surge Protection Metatech Corporation **Phoenix Contact** Schurter Inc.

#### **TELCORDIA TESTING**

D.L.S. Electronic Systems, Inc. DNB Engineering, Inc. Electronics Test Centre (Kanata) National Technical Systems Radiometrics Midwest Corp.

#### **TELECOMMUNICATIONS TEST NETWORKS**

Agilent Technologies, Inc. **EMC Partner AG** HV Technologies, Inc.

# TEM CELLS

ASR Technologies Inc. ETS-Lindgren Fischer Custom Communications Instruments for Industry (IFI) Noise Laboratory Co., Ltd.

#### TEMPEST FILTERS

Captor Corp.

Curtis Industries / Filter Networks Dontech, Inc. Syfer Technology Limited Spectrum Advanced Specialty **Products** 

#### **TEMPEST SUPPRESSED PRODUCTS**

**Dontech Incorporated** 

#### TEMPEST TEST EQUIPMENT

A.H. Systems, Inc. **Fischer Custom Communications** 

#### **TEMPEST TESTING**

National Technical Systems

#### **TEST ACCESSORIES**

AR RF/Microwave Instrumentation CST of America, Inc. **EM Test USA EMC Partner AG** EMCO Elektronik GmbH ETS-Lindgren **Fischer Custom Communications** Instruments for Industry (IFI) TDK-Lambda Americas

#### **TEST ANTENNAS**

**Advanced Test Equipment Rentals** A.H. Systems, Inc. AR RF/Microwave Instrumentation Electro-Metrics Corp. Instruments for Industry (IFI) Teseq

#### TEST CAPACITORS

Captor Corp.

# TEST EQUIPMENT, LEASING & RENTAL

A.H. Systems, Inc. Advanced Test Equipment Rentals AR RF/Microwave Instrumentation Instruments for Industry (IFI)

# TEST EQUIPMENT, REPAIR & CALIBRATION

A.H. Systems, Inc. Adler Instrumentos SL Agilent Technologies, Inc. D.A.R.E!! Consultancy **Electronic Instrument Associates** Embassy Global, LLC **EMC Partner AG EMSCAN** ETS-Lindgren Fischer Custom Communications Instruments for Industry (IFI) Seibersdorf Labor GmbH

# TEST INSTRUMENTATION

A.H. Systems, Inc. Aaronia AG Accurate Controls Ltd. Adler Instrumentos SL **Advanced Test Equipment Rentals** 

Aeroflex Agilent Technologies, Inc. All-Spec Industries Alltest Instrument, Inc. Amstat Industries, Inc. Anritsu Company Apogee Labs Inc. **APREL** Laboratories AR RF/Microwave Instrumentation ASR Technologies Inc. **AWR** Corporation Barth Electronics, Inc. Bird Technologies Group / TX RX **Systems** Circuit Insights LLC Combinova AB Compliance West, USA CST of America, Inc. D.A.R.E!! Consultancy D.A.R.E!! Instruments Ecliptek Corp. EM Software & Systems **EM Test USA** Embassy Global, LLC EMC Partner AG **EMSCAN** emscreen GmbH EMSS Consulting Pty (Ltd.) emv - Elektronische Meßgeräte Vertriebs GmbH Ergonomics, Inc. ETS-Lindgren Fischer Custom Communications

**Fotofab GAUSS Instruments** Haefely EMC

HV Technologies, Inc. Inceleris Instruments for Industry (IFI)

Langer EMV-Technik GmbH Laplace Instruments Ltd. Liberty Labs, Inc.

Macton

Michigan Scientific Corp. Micronor Inc.

Mihailo Pupin Institute-EMC Lab Montena Technology sa MPB Srl

Narda Safety Test Solutions S.r.l. **NEDC Fabricating Solutions** Noise Laboratory Co., Ltd. Pearson Electronics, Inc. Potomac Instruments Inc.

PPM (Pulse Power & Measurement) Ltd.

Praxsym, Inc. Protek Test and Measurement Ramsey Electronics Rohde & Schwarz USA, Inc.

Saelig Company Safe Engineering Services & Technologies, Ltd. Safety Test Technology Co., Ltd

Seibersdorf Labor GmbH Sensor Products Inc. Shanghai Empek

Electromagnetic Technology Ltd.

SILENT Solutions

SimLab Software GmbH Solar Electronics Co. Suzhou 3CTEST Electronic Co., Ltd. TE Connection Asia TESE0 Teseq Thermo Fisher Scientific TREK, INC. ValueTronics International, Inc. Wavecontrol

#### **TEST SOFTWARE**

Averna D.A.R.E!! Consultancy **NEXIO** CST of America, Inc.

TESTING 3C Test Ltd. - EMC Testing A.H. Systems, Inc. A2LA Acme Testing Company Advanced Compliance Solutions, Advanced Testing Services **AERO NAV Laboratories** AHD EMC Lab / Amber Helm Development L.C. Alion Science and Technology American Environments Co., Inc. Applied Physical Electronics, L.C. ATLAS Compliance & Engineering BEC Inc. Blackwood Labs Blue Guide EMC Lab Braco Compliance Ltd. Bureau Veritas (formerly Curtis-Straus) Cascade TEK CertifiGroup CETECOM Inc. CKC Laboratories, Inc. **Communication Certification** Laboratory Compatible Electronics, Inc. Compliance Certification Services Compliance Engineering Ireland Ltd. Compliance Management Group Compliance Testing LLC Compliance Worldwide Core Compliance Testing Services

Cranage EMC Testing Ltd. Criterion Technology, Inc. **CSA** International Custom Assembly LLC D.A.R.E!! Calibrations D.L.S. Electronic Systems, Inc. Dayton T. Brown, Inc. dBi Corp. Diversified T.E.S.T. Technologies

DNB Engineering, Inc. **Don HEIRMAN Consultants** E.F. Electronics Co.

E-Labs Inc. ElectroMagnetic Investigations, Electro Magnetic Test, Inc. **Electro Rent Corporation** Elite Electronic Engineering Co. EM Software & Systems **EMC** Compliance EMC Integrity, Inc. EMC Technologies Pty Ltd. **EMC Tempest Engineering** EMC Testing Laboratories. Inc. EMCC Dr. Rasek **EMCMCC EMF Testing USA EMField EMITECH** Enerdoor Inc. **Engineered Testing Systems Environ Laboratories, LLC** ETS-Lindgren Fabreeka International, Inc. Federal-Mogul Corporation Systems Protection Global Advantage Global Certification Laboratories, Ltd. **Global Testing** Green Mountain Electromagnetics, Inc. GTN GmbH & Co. KG H.B. Compliance Solutions Harris Corp (GCSD) Hermon Laboratories iNARTE, Inc. Ingenium Testing, LLC International Certification Services, Inc. International Compliance Laboratories, LLC Intertek Testing Services IQS, a Div. of The Compliance Management Group ITC Engineering Services, Inc. Jacobs Technology Inc. JS TOYO Corporation (Shenzhen) Ltd. **Keystone Compliance** Kimmel Gerke Associates, Ltd. L.S. Research L-3 Communications Cincinnati Electronics Laboratory Testing Inc. Langer EMV-Technik GmbH L F Research EMC Liberty Labs, Inc. Little Mountain Test Facility Mesago Messe Frankfurt GmbH MIRA Ltd. National Technical Systems Naval Air Systems Command Naval Air Warfare Center **NCEE Labs** Nemko USA Northwest EMC, Inc. **NU Laboratories** 

Pearson Electronics, Inc. Percept Technology Labs, Inc. Philips Applied Technologies -EMC Center Philips Innovation Services-EMC Center Pioneer Automotive Technologies, Inc. - EMC Lab Power-Electronics Consulting Product Safety Engineering Inc. Protocol Data Systems Inc. Pulver Laboratories Inc. QinetiQ Qualtest Inc. Radiometrics Midwest Corp. Remcom Inc. Restor Metrology Retlif Testing Laboratories RF Exposure Lab, LLC RFI Global Services Ltd. **RFTEK** Rhein Tech Laboratories, Inc. Rogers Labs, Inc. Rubicom Systems, A division of ACS SAE Power Seven Mountains Scientific, Inc. (ENR) SGS SIEMIC Southwest Research Institute SPAWAR Systems Center Atlantic Swift Textile Metalizing LLC Sypris Test and Measurement TÉMPEST Inc. Teseq Test Site Services Inc. The Compliance Management Group Timco Engineering, Inc. TRaC Global Trialon Corp. TUV Rheinland Of North America TUV SUD America Inc. TÜV SÜD Product Service Ltd. TÜV SÜD SENTON GmbH Ultratech Group of Labs Underwriter's Laboratories Inc. Walshire Labs, LLC Washington Laboratories, Ltd. White Sands Missile Range Willow Run Test Labs, LLC Wyle Yazaki Testing Center

#### TESTING LABORATORIES

D.A.R.E!! Instruments

Alion Science and Technology AT4 Wireless Blue Guide EMC Lab Compliance Testing LLC Compliance Worldwide D.A.R.E!! Instruments D.L.S. Electronic Systems, Inc. Diversified T.E.S.T. Technologies DNB Engineering, Inc. **Don HEIRMAN Consultants** 

Electro Magnetic Test, Inc. Electronics Test Centre (Kanata) Elite Electronic Engineering Co. EMC Integrity, Inc. EMC Technologies Pty Ltd. H.B. Compliance Solutions International Compliance Laboratories, LLC **Keystone Compliance** Langer EMV-Technik GmbH Liberty Labs, Inc. National Technical Systems Partnership for Defense Innovation Professional Testing (EMI), Inc. Qualtest Inc. Radiometrics Midwest Corp. **Retlif Testing Laboratories** RMV Technology Group, LLC SDP Engineering Inc. SIEMIC **Sprinkler Innovations** Stork Garwood Laboratories Inc. Test Site Services Inc. Tranzeo EMC Labs Inc. TÜV SÜD America Inc. TÜV SÜD Product Service Ltd. TÜV SÜD SENTON GmbH World Cal. Inc.

#### TRAINING, SEMINARS & WORKSHOPS

#### A2I A

Andre Consulting, Inc. Cherry Clough Consultants Ltd CST of America, Inc. D.L.S. Electronic Systems, Inc. Don HEIRMAN Consultants **EM Software & Systems EMC** Engineering and Safety EMC Goggles Ltd. Euro EMC Service (EES) Fotofab **Gaddon Consultants Henry Ott Consultants** Hoolihan EMC Consulting Integrated Engineering Software Jastech EMC Consulting, LLC Kimmel Gerke Associates, Ltd. M.MARDIGUIAN, EMC Consulting Montrose Compliance Service National Technical Systems QEMC - Engenharia, Qualidade e Compatibilidade

Eletromagnética Ltda. **Retlif Testing Laboratories** Simberian Inc.

Spec-Hardened Systems Stephen Halperin & Associates Tesea TUV SUD America Inc.

#### TRANSIENT DETECTION & **MEASURING EQUIPMENT**

Advanced Test Equipment Rentals Circuit Insights LLC Pearson Electronics. Inc. Rohde & Schwarz USA, Inc.

#### TRANSIENT GENERATORS

Advanced Test Equipment Rentals **EM Test USA EMC Partner AG Fischer Custom Communications** Haefely EMC HV Technologies, Inc. Noise Laboratory Co., Ltd. Teseq Transient Specialists, Inc.

#### TRANSIENT SUPPRESSORS

Captor Corp. Littlefuse Inc. TDK-EPC Corp.

#### TRAVELING WAVE TUBE (TWT) **AMPLIFIERS**

Applied Systems Engineering, Inc. AR RF/Microwave Instrumentation CPI (Communications & Power Industries) Instruments for Industry (IFI) Quarterwave Corporation TMD Technologies Ltd.

#### TURNTABLES

ETS-Lindgren Macton

#### UNINTERRUPTED POWER **SYSTEM**

APC by Schneider Electric

#### **VOLTAGE PROBES**

**Fischer Custom Communications** Haefely EMC

# WIRE & CABLE FILTERS

Captor Corp. Spectrum Advanced Specialty Products

For more information on these and other EMI/EMC companies, visit the new and improved Interference Technology EMC Buyers' Guide at www.interferencetechnology.com

Paladin EMC

Parker EMC Engineering

Peak Electromagnetics Ltd.

Manufacturers, consultants, and service organizations

active in the electromagnetic interference field are listed in this directory. To learn how to be included in this directory, e-mail info@interferencetechnology.com.

# 0-9

3C Test Ltd. - EMC Testing

Silverstone Technology Park, Silverstone Circuit, Tow-cester, Northampton NN12 8GX, United Kingdom; +44 (0) 1327 857500; Fax: +44 (0) 1327 857747; sales@3ctest. co.uk; www.3ctest.co.uk

#### 3Gmetalworx World

101 Planchet Road, Concord L4K 2C6, Canada; 905-738-7973; MGomez@3gmetalworx.com; www.3gmetalworx.com

# **3M Electronics Markets Materials Division**

6801 River Place Blvd., Austin, TX 78726-9000, USA; 800-245-0329; Alex.Gwin@kolarmail.com; www.3M.com/electrical



CRI

FCU

ELS

FRA

IDN

IND

ISR

IΤΑ

.IPN

KNR

Alianza S.E.T...

Alianza S.E.T.

GUA Alianza S.E.T......

HND Alianza S.E.T....

LUX EEMCCoimex ..

Gennevilliers, AR France.....

TTL Technologies Pvt. Ltd. .....

Druento, Teseo S.p.A.....

Kfar-Saba, Wave Technologies.....

Segrate, Narda Safety Test Solutions ......

Seoul, Taehung Trading Inc.....

#### A&R Tarpaulins, Inc.

16246 Valley Blvd., Fontana, CA 92335 USA; 909-829-4444; jessica@artech2000.com; www.artarps.com



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9710 Cozycroft Ave., Chatsworth, CA 91311 USA; 818-998-0223; Fax: 818-998-6892; sales@ahsystems.com; www.AHSystems.com; Arthur C. Cohen, Pres.; Travis

| Sam | iuels, Ops. Dir.                           |                 |
|-----|--|-----------------|
| AL  | T & M Solutions                            |                 |
| AR  | Southwest Electronic Ind., Inc             | 972-523-0017    |
| GA  | T & M Solutions                            | 770-973-7492    |
| LA  | Southwest Electronic Ind., Inc             | 972-523-0017    |
| OK  | Southwest Electronic Ind., Inc             | 972-523-0017    |
| TN  | T & M Solutions                            | 770-973-7492    |
| TX  | Richardson, Southwest Electronics Ind      | 972-523-0017    |
|     | INTERNATIONAL                              |                 |
| AUS | Sydney, Test & Measurement Australia PT    | Y Limited       |
|     |  | 61-2-4739-9523  |
| AUT | Ludwigsburg, ProNova Elektronik GmbH       | 49-7141-2858-20 |
| BEL | Lelystad, EEMCCoimex                       | 31-320-295-395  |
| BGR | Sofia, Test Solutions                      | 359 2 970 1990  |
| BOL | Alianza S.E.T                              | 305-767-4000    |
| CHE | Ludwigsburg, ProNova Elektronik GmbH       | 49-7141-285820  |
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#### CAPLINQ Corp.

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**Caprock Mfg.** 2303 120th St., Lubbock, TX 79423 USA; 806-745-6454; Fax: 806-745-5963; caprock@caprock-mfg.com; www.caprock-mfg.com

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| ESP        | ALAVA Ingenieros, S.A                     |                   |
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| IJΤ       | AZTEC Enterprises, Inc.                 | 800-304-3565          |
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| WΙ        | Test Midwest                            | 262-521-3056          |
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| J1114     | Hong Kong, Quatronix, Inc.              |                       |
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|    |    | Ltda.                                 |                     |
|    |    |                                       | +55-11-2842-6842    |
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|    |    | Brampton, E-Cubed Components, Inc/M   | lichael Wheeler     |
|    |    |                                       | 905-791-0812        |
| M  | ΕX | Kruvand de Mexico                     | 01152-33-3671-4159  |

#### **Schlegel Electronic Materials**

806 Linden Ave., Rochester, NY 14602 USA; 905-893-3241; Fax: 905-893-5623; lee.masucci@schlegelemi. com; www.schlegelemi.com

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**Schurter, Inc.**447 Aviation Blvd., Santa Rosa, CA 95403 USA; 707-636-3000; Fax: 707-636-3033; Marjorie Tibbs, info@ schurterinc.com; www.schurterinc.com

#### SDP Engineering Inc.

17 Spectrum Pointe, P.O. Box #508, Lake Forest, CA 92630 USA; 949-588-7568; Fax: 949-588-8871; don@ sdpengineering.com; www.sdpengineering.com

#### Seal Science

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#### **Select Fabricators Inc.**

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#### Sensor Products Inc.

300 Madison Ave., Madison, NJ 07940 USA; 973-884-1755; 800-755-2201; Fax: 973-884-1699; dlandau@sensorprod.com; www.sensorprod.com

#### Seven Mountains Scientific, Inc. (ENR) ...... 81 913 Tressler St., P.O. Box 650, Boalsburg, PA 16827 USA; 814-466-6559; Fax: 814-466-2777; tom@7ms.com

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#### **SPAWAR Systems Center Atlantic**

P.O. Box 190022, North Charleston, SC 29419-9022 USA; 843-218-5723; Fax: 843-218-4238; www.public.navy. mil/spawar/Atlantic/Pages/AboutUs.aspx

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#### Spectrum Advanced Specialty Products .... 71

8061 Avonia Road, Fairview, PA 16415 USA; 814-474-1571; Fax: 814-474-3110; Kerri Fabin, Director of Sales & Marketing - EMI, Filt susan@altman-hall.com; www.specemc.com

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|     | Queen Creek, W. Reg. Sales Office/Jim Dever   | e              |
|     | -   | 866-281-0903   |
| CA  | Anaheim, Westrep                              | 714-527-2822   |
|     | Los Altos, Recht                              | 650-964-6321   |
| CO  | Centennial, W. Howard Associates              | 303-766-5755   |
| FL  | Hutchinson Island, FLA Technology Sales       | 954-802-2385   |
|     | Lake Mary, SE Reg Sales/Jason Russolese       | 866-565-6226   |
| IA  | Cedar Rapids, MidTech                         | 219-395-0028   |
| IN  | Indianapolis, Dytec, Inc.                     | 317-578-0474   |
|     | Indianapolis, Alliance Mfg. (Automotive)      | 317-575-4600   |
| MA  | Woburn, Kitchen & Kutchin                     | 781-782-0700   |
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|     |   | 919-847-8800   |
| NJ  | Fairfield, TAM (Technical Applications & Marl | keting)        |
|     |   | 973-575-4130   |
| NY  | E. Syracuse, Leonard D. Allen                 | 315-431-1001   |
| PA  | Elizabethtown, NE Reg Sales/Jeff Showers      | 866-281-0988   |
| TX  | Richardson, Pro-Comp SIs.                     | 817-912-3750   |
|     | El Paso, World Class Marketing                | 915-585-3228   |
| WA  | Redmond, Haleo, Inc                           | 425-497-8500   |
|     | INTERNATIONAL                                 |                |
| CAN | ON, Canadian Source Corp                      | 905-415-1951   |
| DEU | Schwabach, European Sales                     | 49-9122-7950   |
| MEX | Guadalajara, Marfil                           | 011-52-33-3670 |
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12721 Saticoy St. South, Ñ. Hollywood, CA 91605 USA; 818 764-8222; Fax: 818-764-9880; Wendy Kunkel, wendy@spira-emi.com; www.spira-emi.com

| ΑZ | Tucson, Synergistic Technology Group | 520-760-0291 |
|----|--------------------------------------|--------------|
| CA | RC Products                          | 510-440-0500 |
| CA | San Diego, Altamont Tech. Serv       | 858-733-0618 |
| DC | Carwithen Associates                 | 410-549-3335 |
| MD | Mt. Airy, Carwithen Associates Inc   | 410-549-3335 |
| NM | Synergistic Technology Group         | 520-760-0291 |
| NV | North, RC Products                   | 510-440-0500 |
| NV | South, Synergistic Technology Group  | 520-760-0291 |
| VA | Carwithen Associates                 | 410-549-3335 |
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| CHE | Tricom Mikrowellen GMBH           | 49-8161-86066   |
| CHN | USA Contact, IES Technologies Inc | 630-632-5941    |
| DEU | Tricom Mikrowellen GMBH           | 49-8161-86066   |
| FRA | Getelec                           | 33-146-44-68-91 |
| ISR | Silram Ltd                        | 972-9-767-1332  |
| JPN | Intermark Co., Ltd                | 81-587-34-3761  |
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TDK Corp.

1221 Business Center Drive, Mount Prospect, IL 60056 USA; 847-803-6100; Fax: 847-803-1125; sreynoso@tdktca.com; www.tdk.com



# TDK-EPC Corp.

485B Route 1 South, Suite 200, Iselin, NJ 08830 USA; 800-888-7729; Fax: 732-603-5978; Joe Pulomena, Director of Marketing/ferrites/inductors, Joseph.Pulomena@epcos.com; www.epcos.com/emc

#### TDK-Lambda Americas

High Power Division, 405 Essex Road, Neptune, NJ 07783 USA; 732-922-9300; Fax: 732-922-9334; www.us.tdk-lambda.com/hp

#### **TDK RF Solutions, Inc.**

1101 Cypress Creek Road, Cedar Park, TX 78613 USA; 512-258-9478; Fax: 512-258-0740; Chris Whalen, info@ tdkrf.com; www.tdkrfsolutions.com

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45 Aldrin Road, Plymouth, MA 02360 USA; 508-747-0300, ext. 3050; Fax: 508-746-9639; Bruce McAllister,

| bmcallister@tech-etch.com; www.tech-etch.com |  |              |  |
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| CA   | Brea, Motion Components                    | 714-255-1080 |  |
|  | Mountain View, Ross Marketing              | 650-691-0119 |  |
| CO   | Lakewood, Moss Marketing                   | 800-980-8812 |  |
| DC   | Ellicott City, Eastern Tech Corp           | 410-715-2100 |  |
| FL   | Oviedo, Cornerstone Sales, LLC             | 321-765-4862 |  |
|  | Palm Harbor, Cornerstone Sales, LLC        | 727-789-4802 |  |
| GA   | Duluth, Cornerstone Sales, LLC             | 770-638-8998 |  |
| IL   | Barrington, EMT Engineering Sales          | 847-481-7403 |  |
| KS   | Lenexa, Midtec Associates, Inc             | 913-541-0505 |  |
| MA   | Carver, Connors Co., Inc.                  | 508-866-5392 |  |
| MD   | Ellicott City, Eastern Tech Corp           | 410-715-2100 |  |
| ME   | Carver, MA Connors Co., Inc.               | 508-866-5392 |  |
|  |  |              |  |
| MI   | Kettering, OH, Frederic Ohmer & Associates |              |  |
|  |  | 937-434-1454 |  |
| MN   | Burnsville, EMT Engineering Sls            | 952-888-1020 |  |
| M0   | Florissant, Midtec Associates, Inc         | 314 839-3600 |  |
| NC   | Raleigh, Cornerstone Sales, LLC            | 919-834-2677 |  |
| NH   | Carver, MA, Connors Co., Inc.              | 508-866-5392 |  |
| NJ   | Holgate, Brandon Associates, Inc.          | 610-738-8500 |  |

| NY   | Canandaigua, Brandon Associates, Inc          | 610-738-8500   |
|------|---|----------------|
|      | Central Square, Brandon Associates, Inc       | 610-738-8500   |
|      | Commack, Brandon Associates, Inc              | 610-738-8500   |
| OH   | Kettering, Frederic Ohmer & Assoc             | 937-434-1454   |
| OR   | Beaverton, Technical Marketing, Inc           | 503-627-9000   |
| PA   | West Chester, Brandon Associates, Inc         | 610-738-8500   |
|      | Bellefonte, Brandon Associates, Inc.          | 610-738-8500   |
| SC   | Raleigh, NC, Cornerstone Sales, LLC           | 919-834-2677   |
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|      |   |                |
|      | Western, Huntsville, AL Cornerstone Sales, L  |                |
|      | ,   |                |
| TX   | Collevville. Centramark                       |                |
| .,,  | Garland, Centramark                           |                |
|      | Austin, Centramark                            |                |
|      | Bellaire, Centramark                          |                |
| UT   | Salt Lake City, Moss Marketing                |                |
| VA   | Ellicott City, MD, Eastern Tech Corp          |                |
| WA   | Kirkland, Technical Marketing, Inc.           |                |
| VVA  | Spokane, Technical Marketing, Inc.            |                |
| WI   | Meguon, EMT Engineering Sales                 |                |
| WY   | Lakewood, CO, Moss Marketing                  |                |
| VVI  | INTERNATIONAL                                 | 000-300-0012   |
| BFI  | HF Technology                                 | 2175 6202717   |
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| ITA  | Sirces/Italy                                  |                |
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| PRK  | Eretec  |                |
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| SAF  | Linbro Park, Actum Electronics                | 27 11 608 3001 |
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| NY  | L-MAR Associates              | 585-899-3920    |
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